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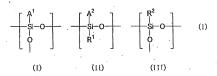
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- (54) Polysiloxane, method of manufacturing same, silicon-containing alicyclic compound, and radiation-sensitive resin compounds
- (57) A novel polysiloxane having the following structural units (I) and/or (II) and the structural unit (III),



wherein A¹ and A² are an acid-dissociable monovalent organic group, R¹ is hydrogen, monovalent (halogenated) hydrocarbon, halogen, a remitted of preparing such a polysiloxane, a silicon-containing alicyclic compound providing this polysiloxane, a a silicon-containing alicyclic compound providing this polysiloxane is useful as a resist resist composition comprising this polysiloxane are also provided. The polysiloxane is useful as a resist component for a resist material, effectively senses radiation with a short wavelength, exhibits high transparency to radiation and superior dry atching properties, and excels in basic resist properties required for resist materials such as high sensitivity, resolution, developability, etc.

#### Description

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### BACKGROUND OF THE INVENTION

#### Field of the Invention

[0001] The present invention relates to a polysiloxane and a method of preparing the same, a silicon-containing alloyclic compound, and a radiation-sensitive resin composition containing the polysiloxane suitable for use ininicrofebrication utilizing radiation.

### Description of the Background Art

[0002] A recent strong demand for high density and highly integrated LSIs accelerates miniaturization of wiring pat-

[0003] Using short wave rays in a lithographic process is one method for miniaturizing wifing patterns. In recent years, deep ultraviolet rays typified by a KrF excimer laser (wavelength: 248 nm) or an ArF excimer laser (wavelength: 193 nm), electron beams, X rays, and the like are being used in place of ultraviolet rays such as g-line (wavelength: 486 nm), l-line (wavelength: 365 nm), etc. Use of an F2 excimer laser (wavelength: 157 nm) is also being studied.

[0004] Novolac resins, poly (vinylphenol), and the like have been used as resin components for conventional resist compositions. However, because these resins exhibit strong absorbance at a wavelength of 193 nm due to inclusion of aromatic rings in the structure, a lithographic process by an ArF excimer laser, for example, using these resins cannot provide high accuracy corresponding to high photosensitivity, high resolution, and a high aspect ratio:

[0005] Therefore, a resin for use in a resist, transparent to a wavelength of 193mm or less, particularly to a wavelength of 157 mm, and exhibiting excellent dry etching resistance equivalent to or better than aromatic rings has been desired. A polysiloxane is one such a polymer. R. R. Kunz at al. of the MIT have reported their research results showing excellent transparency of a polysiloxane at a wavelength of 193 mm or less, particularly at 157 mm, commenting on superforty of this polymer as a resist in a lithographic process using radiation with a wavelength of 193 mm or less (J. Photopolym. Sci. Technol., Vol. 12, No.4, 1999). Moreover, polysiloxanes are known to exhibit excellent dry etching properties. In particular, a resist containing polyorganosilsesquioxane having a ladder structure is known to possess high plasma resistance.

[006] Several resist materials using a siloxane polymer have also been reported. For example, Japanese Patent Publication No. 323811/1993 discloses a radiation-ensitive resin composition comprising a polysiloxane having an acid-dissociable group such as a carboxylic acid group, phenol ether group, etc., on the side chain, bonded to a silicon atom via one or more carbon atoms. Japanese Patent Application Laid-open No. 150 623/1996 discloses a positive tione resist using polytic-arborysethylsiloxane) in which the quaboxyl group is protected with an acid-dissociable group such as a t-butyl group. Japanese Patent Application Laid-open No. 60733/1999 discloses a resist resin composition in which a polytogenosialesequioxane providing an acid-dissociable group is used. However, resist materials using these conventional siloxane polymers containing an acid-dissociable group have not been satisfactory in producing basic properties in a resist such as transparency to rediation, resolution, developability, and the like.

[0007] Japanese Patent Publication No. 302382/1999 discloses a siloxane polymer having a non-aromatic monocyclic or polycyclic hydrocarbon group or a bridged cyclic hydrocarbon group containing a carboxyl group on the side chain, at least part of the carboxyl group being replaced by a group unstable to an acid, and a resist material containing such a polymer. This resist material exhibits small absorbance of a K/F exciter leaser (wavelength: 248 nm) or an ArF exciterer leaser (wavelength: 193 nm), produces line pattern configuration, and excels in properties such as sensitivity, resolution, die alching resistance, etc. However, even if the above-mentioned slicyane polymer is considered, there are few elioxane polymer useful as a resin component of a resist material. Anew elioxane polymer which can provide a resist material effectively sensity gradiation with a short wavelength, exhibiting high transparency to radiation and superior anti-dyetching properties, and excelling in basic resist properties, and a elioxo compound which can produce such a siloxane polymer are important subjects of development in view of the fast advance in microprocessing technologies for semiconductors.

[0008] Therefore, an object of the present invention is to provide a novel polysiloxane useful as a resin component for a resist material effectively sensing radiation with a short wavelength; bypifled by a KrF excimer laser (wavelength: 198 mm), and an F2 excimer laser (wavelength: 197 mm), exhibiting high trainsparency to radiation and superior dry etching properties, and excelling in basic resist properties required for resist materials such as high ensitivity, resolution, developability, etc.; a method of preparing such a polysiloxane; a silicon-containing alicyclic compound providing this polysiloxane; and a radiation-sensitive resin composition comprision this polysiloxane.

[0009] Therefore, an object of the present invention is to provide a novel polysiloxane useful as a resin component

for a resist material effectively sensing radiation with a short wavelength, typified by a KrF excimer laser (wavelength: 183 nm), and an ArF excimer laser (wavelength: 193 nm), and an ArF excimer laser (wavelength: 157nm), exhibiting high transparency to radiation and superior of yetching properties, and excalling in basic resist properties required for resist materials such as high sensitivity, resolution, developability, etc.; a method of preparing such a polysiloxane; a silicon-containing alleyclic compound providing this polysiloxane; and a radiation-sensitive resin composition comprisation this polysiloxane.

### SUMMARY OF THE INVENTION

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[0010] The present invention provides a polysiloxane having the structural unit (i) and/or structural unit (ii) and structural unit (iii), shown in the following formula (1), and having a polysityrene-reduced weight average molecular weight determined by gel permeation chromatography (GPC) in the range of 500-1,000,000 (this polysiloxane is hereinafter referred to as "polysiloxane (1)").

wherein A¹ and A² Individually represent a monovalent organic group having an acid-dissociable group which dissociates by an action of an acid; R¹ represents a hydrogen atom, a monovalent hydrocarbon group having 1-20 carbon atoms, a monovalent halogenated hydrocarbon group having 1-20 carbon atoms, a halogen atom, or a primary, secondary, or tertiary amino group; and R² represents a monovalent hydrocarbon group having 1-20 carbon atoms, a monovalent halogenated hydrocarbon group having 1-20 carbon atoms, a halogen atom, or a primary, secondary, or tertiary amino group.

[0011] The present invention further provides a radiation-sensitive resin composition comprising; (a) a resin which comprises, an alkalis alsoluble or alkali low soluble polysiloxane copolymer, having the above structural unit (i) and/or structural unit (ii), and/or structural unit (iii), and structural unit (iii), and/or structural unit (iii) and/or structural unit (iii), and/or structural unit (iii) and/or structural unit (ii) and/or structural unit (iii) and/or struct

[0012] The present invention further provides a silicon-containing alloydic compound represented by the following formula (2-A) or (2-B) (hereinafter referred to as "silicon-containing alloydic compound (2)"),

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wherein R individually represents a hydrogen atom or a methyl group; R¹ individually represents a hydrogen atom, a monovalent hydrocarbon group having 1-20 carbon atoms, a monovalent halogenated hydrocarbon group having 1-20 carbon atoms, a halogen atom, or a primary, secondary, or terliary amino group; and R⁵ individually represents a monovalent hydrocarbon group having 1-20 carbon atoms, a monovalent halogenated hydrocarbon group having 1-20 carbon atoms, or the droup of the following formula (f).

$$\frac{X}{\left(\begin{array}{c} X \\ Si \\ X \end{array}\right)_{a}} X \qquad (i)$$

wherein X individually represents a hydrogen atom, a monovalent hydrocarbon group having 1-20 carbon atoms, a monovalent halogenated hydrocarbon group having 1-20 carbon atoms, or a linear, branched, or cyclic alkoxyl group having 1-20 carbon atoms, and a indicates an integer of 1-10, or, when m is 0 or 1, two RPs may form a ring together with two oxygen atoms and the silicon atom; Y individually represents a hydrogen atom, a monovalent hydrocarbon group having 1-20 carbon atoms, a monovalent halogenated hydrocarbon group having 1-20 carbon atoms, a halogen atom, a primary, secondary, or teritary armino group, or a group -OR3 (wherein R3 is the same as defined above); m is an integer of 0-3; p is an integer of 0-3-10; and n is an integer of 0-3; the silicon atom binding with the 2 or 3 position of the upoermost biovical(2.2.1 hieraten fine).

[0013] The present invention further provides a polysiloxane having the structural unit (I-1) and/or structural unit (II-1), shown by the following formulas, and having a polystyrene-reduced weight average molecular weight determined by get permeation chromatography (GPC) in the range of 500-1,000,000 (this polysiloxane is hereinafter referred to as "polysiloxane (3)").

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wherein R individually represents a hydrogen atom or a methyl group, R¹ represents a hydrogen atom, a monovalent hydrocarbon group having 1-20 carbon atoms, a monovalent halogenated hydrocarbon group having 1-20 carbon atoms, a halogen atom, or a primary, secondary, or tertiary amino group, and n is an integer from 1-3, the silicon atom binding with the 2 or 3 position of the uppermost bicyclo[2.2.1]heptane ring.

[0014] The present invention further provides a silicon-containing alicyclic compound represented by the following formula (4-A) or (4-B) (hereinafter referred to as "silicon-containing alicyclic compound (4)"),

wherein R individually represents a hydrogen atom or a methyl group; R¹ individually represents a hydrogen atom, a monovalent hydrocarbon group having 1-20 carbon atoms, a monovalent halogenated hydrocarbon group having 1-20 carbon atoms, a phalogen atom, a carbon atoms, a halogen atom, or a primary, secondary, or tertiary amino group; R³ individually represents amonovalent

hydrocarbon group having 1-20 carbon atoms, a monovalent halogenated hydrocarbon group having 1-20 carbon atoms, or the group of the following formula (f).

$$\frac{X}{\left(\begin{array}{c} X \\ Si \\ X \end{array}\right)_{a}} X \qquad (i)$$

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wherein X individually represents a hydrogen atom, a monovalent hydrocarbon group having 1-20 carbon atoms, a monovalent halogenated hydrocarbon group having 1-20 carbon atoms, or a linear, branched, or cyclic alkoxyl group having 1-20 carbon atoms, and a indicates an integer of 1-10, or, when m is 0 or 1, two R<sup>5</sup>s may form a ring together with two oxygen atoms and the silicon atom; Y individually represents a hydrogen atom, a monovalent hydrocarbon group having 1-20 carbon atoms, a monovalent halogenated hydrocarbon group having 1-20 carbon atoms, a lailogen atom, a primary, secondary, or terliary amino group, or a group =0R<sup>3</sup> (wherein R<sup>3</sup> is the same as defined above); m is an integer of 0-3; p is an integer of 3-10; and n is an integer of 0-3; the silicon atom binding with the 2 or 3 position of the uncermost bioxicial 2; litherate into.

[0015] The present invention further provides a polysiloxane having the structural unit (I-2) and/or structural unit (II-2), shown by the following formulas, and having a polystyrene-reduced weight average molecular weight determined by gel permeation chromatography (GPC) in the range of 500-1,000,000 (this polysiloxane is hereinafter referred to as "polysiloxane (5)").

wherein R individually represent a hydrogen atom or a methyl group, R¹ represents a hydrogen atom, a monovalent hydrocarbon group having 1-20 carbon atoms, a monovalent halogenated hydrocarbon group having 1-20 carbon atoms, a halogen atom, or a primary, secondary, of tertilary amino group, R¹ represents a hydrogen atom, methyl group, or trifluoromethyl group, Z represents a hydrogen atom or a monovalent organic group dissociating hydrogen atoms with an action of an acid, and n is an integer of 0-3, the silicon atom binding with the 2 or 3 position of the uppermost bicvolc2.2 theotare ring.

[0016] The present invention further provides a radiation-sensitive resin composition comprising:

(a) an alkali soluble or alkali low soluble polysiloxane comprising at least one structural unit selected from the

structural unit (I-1') and the structural unit (II-1'), shown by the following formulas,

wherein R Individually represents a hydrogen atom or a methyl group, R1 represents a hydrogen atom, a monovalent halogenated hydrocarbon group having 1-20 carbon atoms, a monovalent halogenated hydrocarbon group having 1-20 carbon atoms, a secondary, or bertiary amino group, Z1 represents a monovalent organic group dissociating by the action of oxygen to produce hydrogen atoms, and and r1 is an integer from 1-3, the silicon atom binding with the 2 or 3 position of the uppermost bicyclo[2.2.1] hepizane ring; and having a polystyrene-reduced weight average molecular weight determined by gel permeation chromatography (GPC) in the range of 500-1,000,000 (hereinafter referred to as "Polysloxane (3'')"), and an alkali soluble or lakel low soluble polysloxane comprising at least one structural unit selected from the structural unit (II-2), shown above, and having a polystyrene-reduced weight average molecular weight determined by gel permeation chromatography (GPC) in the range of 500-1,000,000, the resin becomins obluble in alkali when the acid-discoscible or round issociates; and

# (b) a photoacid generator.

[0017] The present invention further provides a method of preparing a polysiloxane having the structural unit (I) and or structural unit (II) and structural unit (III), shown above, and having a polystyrene-reduced weight average molecular weight determined by gel permeation chromatography (GPC) in the range of 500-1, 000, 000, the method comprising a step of polycondensing at least one component selected from the group consisting of a compound shown by the following formula (6) or a linear of cyclicoligomer prepared by partial condensation of this compound and/or at least one component selected from the group consisting of a compound shown by the following formula (7) or a linear of cyclic oligomer prepared by partial condensation of this compound, and at least one component selected from the group consisting of a compound shown by the following formula (8) or a linear of cyclic oligomer prepared by partial condensation of this compound, and at least one component selected from the group consisting of a compound shown by the following formula (8) or a linear of cyclic oligomer prepared by partial condensation of this compound in the presence of an addic catalyst,

$$R^{3}O - SI - OR^{3}$$
  $R^{3}O - SI - OR^{3}$   $R^{1}$   $R^{1}$   $R^{2}$ 

$$R^2$$
 $R^3O$ — $Si$ — $OR^3$  (8)
 $OR^3$ 

wherein A¹ and A² Individually represent a monovalent organic group having an acid-dissociable group which dissociates by an action of an acid. R¹ represents a hydrogen atom, a monovalent hydrocarbon group having 1-20 carbon atoms, a monovalent halogenated hydrocarbon group having 1-20 carbon atoms, ahalogen atom, or a primary, secondary, or tertiary amino group, R² represents a monovalent hydrocarbon group having 1-20 carbon atoms, a monovalent halogenated hydrocarbon group having 1-20 carbon atoms, a halogen atom, or a primary, secondary, or tertiary amino group, and R² individually represents a monovalent hydrocarbon group having 1-20 carbon atoms, a halogenated hydrocarbon group having 1-20 carbon atoms, or the group of the following formula (i),

$$\frac{X}{\left( \begin{array}{c} X \\ Si \\ X \end{array} \right)_{a}} X \qquad (i)$$

- 5 wherein X individually represents a hydrogen atom, a monovelent hydrocarbon group having 1-20 carbon atoms, a monovelent halogenated hydrocarbon group having 1-20 carbon atoms, or a linear, branched, or cyclic alkoxyl group having 1-20 carbon atoms, and a indicates an integer of 1-10.
- [0018] The present invention further provides a method of preparing a polysiloxane having the structural unit (I-1) and/or structural unit (I-1), shown above, and having a polystyrene-reduced weight everage molecular weight determined by gel permeation chromatography (GPC) in the range of 500-1,000,000, the method comprising a step of polycondensing at least one component selected from the group consisting of the silicon-containing alloydic compounds having the above-described formulas (2-A) or (2-B) or a linear or cyclic oligomer prepared by partial condensation of this silicon-containing alloydic compound in the presence of an addice atativst.
- [0019] The present invention further provides a method of preparing a polysiloxane having the structural unit (I-2) and/or structural unit (I-2), shown above, and having a polystyrene-reduced weight average molecular weight determined by gel permeation chromatography (GPC) in the range of 500-1,000,000, the method comprising a step of polycondensing at least one component selected from the group consisting of the silicon-containing alloyclic compounds having the above-described formulas (4-A) or 4-B) or a linear or cyclic oligomer prepared by partial condensation of this silicon-containing alloyclic propound in the presence of an acidic catalyst.
- [0020] Other objects, features and advantages of the invention will hereinafter become more readily apparent from the following description.

### DETAILED DESCRIPTION OF THE INVENTION AND PREFERRED EMBODIMENTS

55 [0021] The present invention will be described in more detail below.

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### Polysiloxane (1)

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[0022] Polysiloxane (1) has the structural unit (I) and/or structural unit (II) and structural unit (III), each having a formula shown above.

[9023] As the monovalent organic group having an acid-dissociable group dissociable by the action of an acid, represented by  $\Lambda^1$  and  $\Lambda^2$  in the structural unit (t) and/or structural unit (t), groups which dissociate in the presence of an acid to produce a carboxyl group, phenolic hydroxyl group, or alcoholic hydroxyl group, and are stable under the reaction conditions for preparing the polysiloxane (1) can be given. As preferable specific examples, the groups shown by the following formula (6) (thereinafter referred to as "an acid-dissociable group ( $\alpha$ )", the following formula (10) (thereinafter referred to as "an acid-dissociable group ( $\alpha$ )", the following formula (10) (the preparation of the like can be given.

wherein p indicates a single bond, methylene group, diffuoromethylene group, alkylene group having 2-20 carbon atoms, fluoroalkylene group having 2-20 carbon atoms, divalent aromatic group having 6-20 carbon atoms, or divalent alloyclic group having 3-20 carbon atoms, Q represents a group -O- or -COO-, and Z represents a monovalent organic group dissociating by the action of oxygen to produce hydrogen atoms.

wherein R individually represents a hydrogen atom or a methyl group and n is an integer of 0-3, the free bonding hands binding with the 2 or 3 position of the uppermost bicyclo[2.2.1]heptane ring.

R

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an

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wherein R Individually represents a hydrogen atom or a methyl group, RI represents a hydrogen atom, methyl group, or trifluoromethyl group, ZI represents a monovalent organic group dissociating by the action of oxygen to produce hydrogen atoms, and n is an integer of 0-3, the free bonding hands binding with the 2 or 3 position of the uppermost bloyolo [2.2.1] heptane ring.

[0024] As examples of the alkylene group having 2-20 carbon atoms represented by P in the acid-dissociable group (α), ethylene group, n-propylene group, i-propylene group, n-butylene group, and the like can be given.

[0025] As examples of the fluoroalkylene group having 2-20 carbon atoms represented by P, a tetrafluoroethylene group, hexafluoro-n-propylene group, octafluoro-n-butylene group, and the like can be given.

[0026] As examples of the divalent aromatic group having 6-20 carbon atoms represented by P, a phenylene group, nabithylene group, perfluoronaphthylene group, and the like can be given.

30 [0027] As examples of the divalent alicyclic group having 3-20 carbon atoms represented by P, a divalent hydrocarbon group having a norbomene skeleton, tricyclodecane skeleton, or adamantane skeleton and a halide of such a hydrocarbon group can be diven.

[0028] As the group P. In the acid-dissociable group ( $\omega$ ), a single bond, methylene group, diffuoromethylene group, a divalent hydrocarbon group having a norbornene skeleton, its hallide derivative, a divalent hydrocarbon group having an adamantine skeleton, its hallide derivative, and the like are prefeable.

[0029] As examples of the monovalent organic group dissociating a hydrogen atom by the action of an acid represented by Z' in the acid-dissociable group (α) and acid-dissociable group (γ), a tentiary alkyl group, a group forming an acetal group together with the coxygen atom with which the group Z' binds (hereinafter referred to as an "acetal-forming group"), a substituted methyl group, 1-substituted ethyl group, 1-branched alkyl group (excluding tertiary alkyl groups), allyl group, germyl group, alkoxycarbonyl group, acyl group, cyclic acid-dissociable group, and the like can be alven.

[0030] As examples of the tertiary alkyl group, a t-butyl group, 1,1-dimethylpropyl group, 1,-methyl-1-ethylpropyl group, 1,1-dimethylbutyl group, 1,1-dimethylpentyl group, 1,1-dimethylpentyl group, 1,1-dimethylpentyl group, 1,1-dimethylpentyl group, 1,1-dimethylpentyl group, 1,1-dimethylpentyl group, and the like can be given.

[0031] As examples of the acetal-forming group, a methoxymethyl group, ethoxymethyl group, n-propoxymethyl group, p-propoxymethyl group, p-propoxymethyl group, p-propoxymethyl group, n-propoxymethyl group, n-hexyloxymethyl group, y-quoleymethyl group, 1-methoxyethyl group, 1-methoxyethyl group, 1-propoxyethyl group, 1-propoxymethyl group, 0-propoxymethyl group, 0-propoxymet

group, (cyclohexyl) (i-propoxy)methyl group, (cyclohexyl)(cyclohexyloxy)methyl group, and the like can be given. [0032] As exemples of the substituted methyl group, a phenacyl group, p-bromophenacyl group, p-methoxyphenacyl group, p-methylthiophenacyl group, c-methylphenacyl group, cyclopropylmethyl group, proup, diphenylmethyl group, bromobenzyl group, p-nitrobenzyl group, p-methylthiobenzyl group, p-methylthiobenzyl group, p-methylthiobenzyl group, p-methylthiobenzyl

group, p-ethoxybenzyl group, p-ethylthiobenzyl group, piperonyl group, methoxycarbonylmethyl group, ethoxycarbonylmethyl group, n-propoxycarbonylmethyl group, n-butoxycarbonylmethyl group, and the like can be given.

[0033] As examples of the 1-substituted ethyl group, a 1-cyclopropylethyl group, 1-phenylethyl group, 1,1-diphenyle-

- thyl group, 1-methoxycarbonylethyl group, 1-ethoxycarbonylethyl group, 1-n-propoxycarbonylethyl group, 1-i-propox-ycarbonylethyl group, 1-n-butoxycarbonylethyl group, 1-n-butoxycarbonylethyl group, 1-n-butoxycarbonylethyl group, and the like can be given.
- [0034] As examples of the 1-branched alkyl group, i-propyl group, see-butyl group, 1-methylbutyl group, and the like can be given.
- [0035] As examples of the silyl group, a trimethylsilyl group, ethyldimethylsilyl group, methyldiethylsilyl group, tiethylsilyl group, i-propyldimethylsilyl group, methyldi-i-propylsilyl group, ti-i-propylsilyl group, t-butyldimethylsilyl group, methyldi-i-butylsilyl group, ti-i-butylsilyl group, phenyldimethylsilyl group, methyldiphenylsilyl group, triphenylsilyl group, ti-butylsilyl group, ti-butylsil
- [0036] As examples of the germyl group, a trimethylgermyl group, ethyldimethylgermyl group, methyldiethylgermyl group, triethylgermyl group, methyldinethylgermyl group, methyldinethylgermyl group, triethylgermyl group, methyldinethylgermyl group, triethylgermyl group, methyldinethylgermyl group, triethylgermyl group, triethylger
- youthersysteming group, a proposition your proposition of the alkoxycarbonyl group, a methoxycarbonyl group, ethoxycarbonyl group, i-propoxycarbonyl group, thotoxycarbonyl group, and the like can be given.
- [0038] As examples of the acyl group, an acetyl group, propionyl group, butynyl group, heptanoyl group, hexanoyl group, valeryl group, pivaloyl group, isovaleryl group, alumyloyl group, myristoyl group, palmitoyl group, stearoyl group, oxaly group, malonyl group, scubroyl group, azelacyl group, asbacoyl group, scubroyl group, azelacyl group, sebacoyl group, acyloyl group, propioloyl group, methacryloyl group, protonoyl group, cleoyl group, malonyl group, scharoyl group, gro
- group, turnarryl group, messaconovy group, campiniousy group, tentery group, mulajoy group, postarryl group, turnarryl group, tenteryl group, turnarryl group,
  - [0039] As exemples of the cyclic acid-dissociable group, an 3-oxocyclohexyl group, tetrahydropyranyl group, tetrahydroturanyl group, tetrahydroturanyl group, a 5-bromotetrahydropyranyl group, tetrahydroturanyl group, 5-bromotetrahydropyranyl group, 4-methoxytetrahydropyranyl group, 6-washing from the first group, 4-methoxytetrahydropyranyl group, 6-washing from the first group, 6-washing from the first group from the first gr
  - 3-tetrahydrothiophene-1,1-dioxide group, and the like can be given.

    [0040] As the monovalent organic group dissociating a hydrogen atom by the action of an acid represented by Z' in the acid-dissociable group (o) and acid-dissociable group (n), at-butyl group, t-butoxycarbonyl group, tetrahydropyranyl group, tetrahydrotruranyl group, methoxymethyl group, ethoxymethyl group, 1-ethoxyethyl group, 1-ethoxye
  - group, t-buy/dimethylsilyl group, and the like are preferable.

    [0041] As the group R in the acid-dissociable group (B) and acid-dissociable group (y), both the hydrogen atom and methyl group are preferable. In is preferably 0 or 1.
    - [0042] As the group Rf in the acid-dissociable group (γ), any of the hydrogen atom, methyl group, and trifluoromethyl group are preferable.
- 35 [0043] In polysiloxane (1), an acid-dissociable group (β) is particularly preferable as the group A1, with an acid-dissociable group (β) in which n is 1-3 being ideal. As the group A2, an acid-dissociable group (γ) is particularly preferable.
  - [0044] In the group R1 in the structural unit (II) and the group R2 in the structural unit (III), given as examples of the monovalent hydrocarbon groups having 1-20 carbon atoms are a linear or branched alkyl groups such as a method group, ethyl group, n-propyl group, p-propyl group, betwyl group, 2-methylgroup/ group, 1-methylgroup, betwyl group, p-pentyl group, n-epentyl group, n-hesyd group, n-betyl group, n-decadedyl group, n-decadedyl group, n-decadedyl group, n-decadedyl group, and the like; cycloalkyl groups such as a cyclobutyl group, cyclopentyl group, cyclopentyl group, benzyl group, p-hendthyl group, 1-naph-group group, 1-naph-group group, 1-naph-group, 1
- 45 thyl group, 2-naphthyl group, and the like; and bridged hydrocarbon groups such as norbornyl group, tricyclodecanyl group, tetracyclodecanyl group, adamantyl group, and the like.
  - [0045] Of these monovalent hydrocarbon groups, a methyl group and ethyl group are preferable.
- [0046] As examples of the monovalent halogenated hydrocarbon group having 1-20 carbon atoms, a monovalent halogenated hydrocarbon group having 1-20 carbon atoms in which one or more hydrogen atoms are replaced by one or more halogen atoms, preferably a fluorine atom, can be given. Specific examples include a trifluoromethy group, pentalluorocothyl group, 3,3,3,2,2-pentafluoro-n-propyl group, perfluoro-n-propyl group, pentalluoro-propyl group, and the group shown by the following formula (ii).

$$Rf'$$
 $Rf'$ 
 $Rf'$ 
 $Rf'$ 
 $Rf'$ 

wherein Rf' individually represents a hydrogen atoms or fluorine atom, with at least one of the Rf's being a fluorine atom, and b is an integer of 0-4.

2-(pentafluorophenyl) hexafluoro-n-propyl group.

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3-(pentafluorophenyl) hexafluoro-n- propyl group, perfluoronorbornyl group, and the like can be given.

[0047] Among these monovalent halogenated hydrocarbon groups, a trifluoromethyl group, a gentafluoroethyl group, a group of the formula (ii) in which 5 Rf's are fluorine atoms and b is 0, a group of the formula (ii) in which 5 Rf's are fluorine atoms and b is 1, a group of the formula (ii) in which 5 Rf's are fluorine atoms and b is 2, 3-(pentafluorophenyl) hexafluoro-propovl group, and the like are preferable.

[0048] As examples of halogen atoms, a fluonne atom, chlorine atom, and bromine atom can be given, with a chlorine atom being particularly preferable.

[0049] Given as examples of secondary or tertiary amino groups are methylamino group, ethylamino group, n-propylamino group, i-propylamino group, n-butylamino group, cyclopentylamino group, cyclohexylamino group, phenylamino group, benzylamino group, dimethylamino group, diethylamino group, di-propylamino group, diclopentylamino group, dicyclohexylamino group, diphenylamino group, dibenzylamino group, and the like.

[0050] As the amino groups for R1 and R2, an amino group, dimethylamino group, diethylamino group, dicyclopentylamino group, dicyclohexylamino group, diphenylamino group, and the like are preferable.

[0051] As R1 in the structural unit (I) and R2 in the structural unit (III), a methyl group, ethyl group, cyclohexyl group, trifluoromethyl group, pentafluoroethyl group, perfluorophenethyl group, 3-(pentafluorophenyl)hexafluoro-n-propyl group, chlorine atom, dimethylamino group, and the like are preferable.

[0052] The structural unit (I), structural unit (II), and structural unit (III) may be used in the polysiloxane (1) either individually or in combination of two or more.

[0053] The specific content of these structural units in the polysiloxane (1) may vary according to the types and combinations of the structural units, the application of the polysiloxane (1), and the life. A preferable specific content of each unit may be suitably determined by experiments and the like. The amount of the structural unit (1) is usually 1-95 mol%, preferably 5-80 mol%, and particularly preferably 6-90 mol% of the total amount of the structural units. The amount of the structural unit (1) is usually 95mol% or less, preferably 0-90 mol% and particularly preferably 0-90 mol% and particularly preferably 0-90 mol% and particularly preferably 0-90 mol% of the total amount of the structural unit (1) is usually 5-95 mol%, preferably 0-90 mol% of the total amount of the structural unit (1) is usually 1-95 mol%, preferably 5-90 mol%, and particularly preferably 10-60 mol% of the total amount of the structural unit (1) is usually 1-95 mol%, preferably 5-90 mol%, and particularly preferably 10-60 mol% of the total amount of the structural unit (1) is usually 1-95 mol%, preferably 5-90 mol%, and particularly preferably 10-60 mol% of the total amount of the structural unit (1) is usually 1-95 mol%, preferably 5-90 mol%, and particularly preferably 10-60 mol% of the total amount of the structural unit (1) is usually 1-95 mol%, preferably 5-90 mol%, and particularly preferably 10-60 mol% of the total amount of the structural unit (1) is usually 1-95 mol%, preferably 5-90 mol%, and particularly preferably 10-60 mol% of the total amount of the structural unit (1) is usually 1-95 mol%, preferably 5-90 mol%, and particularly preferably 10-60 mol% of the total amount of the structural unit (1) is usually 1-95 mol%, preferably 5-90 mol%, and particularly preferably 10-60 mol% of the total amount of the structural unit (1) is usually 1-95 mol%, preferably 5-90 mol%, and particularly preferably 10-60 mol% of the total amount of the structural unit (1) is usually 1-95 mol%, preferably 5-90 mol%, and particularly prefera

[0054] If the amount of the structural unit (f) is less than 1 mol%, resolution of the radiation-sensitive resin composition tends to decrease. If the amount exceeds 95 mol%, transparency tends to decrease. If the amount of the structural unit (f) is more than 95 mol%, the glass transition temperature and transparency of the resulting polymer tends to decrease. If the amount of the recurring unit (III) is less than 5 mol, transparency tends to decrease. If the amount exceeds 95 mol%, on the other hand, resolution of the radiation-sensitive resin composition tends to decrease. If the total amount of the structural unit

(1) and the structural unit (II) is less than 1 mol%, solubility of the resulting resin composition in an alkaline developer tends to decrease. If the amount exceeds 95 mol%, solubility of the resulting resin composition in an alkaline developer tends to increase. In either case, it may become difficult for the resulting radiation-sensitive resin composition to form a highly accurate resist pattern shape.

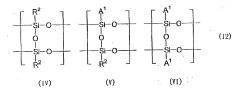
[0055] The amount of the structural units other than structural units (I)-(III) is usually 90 mol% or less, and preferably 95 mol% or less of the total amount of all structural units.

[0056] The total amount of bi-functional structural units in the polycondensation reaction is usually 0-100 mol%, and preferably 1-100 mol%. The total amount of tri-functional structural units in the polycondensation reaction is usually 1-100 mol%, and preferably 2-100 mol%. The total amount of tetra-functional structural units in the polycondensation reaction is usually 90 mol% or less, and preferably 50 mol% or less.

[0057] Usually, polysiloxane (1) has a ladder structure as part of the molecular structure. The ladder structure is

principally introduced by a raw material having tri- or greater functional structure with respect to the polycondensation

[0058] A typical ladder structure in polysiloxane (1) has a structural unit in which two or more of the recurring units (IV) to (VI) shown in the following formula (12) are combined together.



wherein  $A^1$  and  $B^2$  are the same as previously defined in the above formula (1).

[0059] The polystyrene-reduced weight average molecular weight thereinafter referred to as "Mw") of the polysiloxane (1) determined by gel permeation chromatography (GPC)s 500-1,000,000, preferably 500-500,000, and perticularly preferably 1,000-100,000. If the Mw is less than 500, the glass transition temperature of the resulting polymer tends to decrease. If the Mw exceeds 1,000,000, on the other hand, solubility of the resulting polymer in solvents tends to decrease.

[0060] The glass transition temperature (Tg) of polysiloxane (1) is usually from -50 to 500°C, and preferably from 0 to 300°C. If the glass transition temperature (Tg) of polysiloxane (1) is less than -50°C, pattern formation using the resulting radiation-sensitive resin composition tends to be difficult. If more than 500°C, solubility of the polymer in solvents tends to decrease.

[0061] Polysiloxane (1) is usually insoluble or scarcely soluble in alkali, but becomes alkali-soluble when the aciddissociable group dissociates. Thus, the polymer is particularly useful as an acid-dissociable group-containing resin component in radiation-sensitive resin compositions for microprocessing using various types of radiation such as deep ultrayloler radiation, electron beams, and X-rays.

[0062] Polysiloxane (1) is also useful as a material for fabricating formed articles and films, and as laminating materials, components for coating compositions, and the like.

Silicon-containing alleyelic compound (2)

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[0063] In the silicon-containing allcyclic compound (2), as examples of the monovalent hydrocarbon group having 1-20 carbon atoms, monovalent halogenated hydrocarbon group having 1-20 carbon atoms, halogen atom, or primary, secondary, or tertiary amino group represented by R1, the corresponding groups previously mentioned in connection with the group R1 in the structural unit (ii) of the polysiloxane (1) can be given.

[0064] Amethyl group, ethyl group, cyclopentyl group, cyclohexyl group, norbornyl group, tetracyclodecanyl group, and the like can be given as preferable monovalent hydrocarbon groups having 1-20 carbon attoms represented by R1. Glven as examples of preferable monovalent hydrocarbon groups having 1-20 carbon attoms represented by R1 are a trifluoromethyl group, pentafluorophenyl group, c-fluorophenyl group, pentafluorophenyl group, c-fluorophenyl group, 2,3-difluorophenyl group, 3-difluorophenyl group, 2,3-difluorophenyl group, 2,3-difluorophenyl group, 3-difluorophenyl group,

cionicxylamino group, upinenty auto group, and et lieu are protectioned or containing alleyelic compound (2) are a methyl group, ethyl group, cyclohexyl group, phenyl group, pentafluorophenyl group, chlorine atom, dimethylamino group, and the like.

(1066) As examples of the monovalent hydrocarbon group having 1-20 carbon atoms and monovalent halogenated hydrocarbon group having 1-20 carbon atoms represented by R3 he corresponding groups previously mentioned in connection with the group R1 in the structural unit (II) of the polysitoxane (1) can be given. [0067] A methyl group, ethyl group, n-propyl group, I-propyl group, and the like can be given as pricerable monovalent hat-bydrocarbon groups having 1-20 carbon atoms represented by R<sup>2</sup>. Given as examples of preferable monovalent hat-ogenated hydrocarbon groups having 1-20 carbon atoms represented by R<sup>2</sup> are a trifluoromethyl group, pentafilioroc-thyl group, 3,3,2,2-pentafiluoro-n-propyl group,pentafiluorophenylgroup, 0-fluorophenyl group, p.-fluorophenyl group, gr

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[0069] As examples of the linear, branched, or cyclic alkoxyl groups having 1-20 carbon atoms represented by X, a methoxy group, ethoxy group, n-propoxy group, i-bropoxy group, between young roup, sec-butoxy group, between young roup, cyclopentyloxy group, cyclope

[0070] Particularly preferable groups for the group X in the formula (i) are a methyl group, phenyl group, methoxy group, and the like, a in the formula (i) is preferably 1-5.

[0071] As examples of the hydrocarbon group having 1-20 carbon atoms, halogenated hydrocarbon group having 1-20 carbon atoms, halogen atom, or primary, secondary, or tertiary amino group represented by Y, the corresponding groups previously mentioned in connection with the group R¹ in the structural unit (II) of the polysiloxane (1) can be given

[0072] Particularly preferable groups represented by R3 in the silicon-containing alloydic compound (2) are a methyl group, ethyl group, t-butyl group, trimethylsilyl group, and the like.

[0073] As the group R in the silicon-containing alicyclic compound (2), both the hydrogen atom and methyl group
are preferable. A preferable integer for m and n is 0 or 1.

[0074] The compounds shown by the following formulas (2-1) to (2-92) (wherein Me indicates a methyl group) can be given as preferable examples of the silicon-containing alloyclic compound (2):

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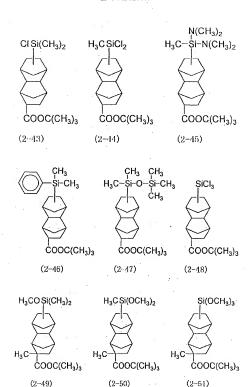
(2-17)

(2-16)

(2-18)

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 $COOC(CH_3)_3$   $COOC(CH_3)_3$   $COOC(CH_3)_3$  (2-40) (2-41) (2-42)



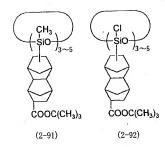
CISi(CH<sub>3</sub>)<sub>2</sub> 
$$H_3$$
CSiCl<sub>2</sub>  $H_3$ C-Si-N(CH<sub>3</sub>)<sub>2</sub>

$$H_3$$
CCOOC(CH<sub>3</sub>)<sub>3</sub>  $H_3$ CCOOC(CH<sub>3</sub>)<sub>3</sub>  $H_3$ CCOOC(CH<sub>3</sub>)<sub>3</sub>

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[0075] Of the above silicon-containing alicyclic compound (2), compounds shown by the formulas (2-2), (2-3), (2-5), (2-6), (2-8), (2-9), (2-10), (2-11), and (2-12) are particularly preferable.

[0076] The silicon-containingalicycliccompound (2) oftheabove formula (2-A) is very useful as a raw material for producing the polyelloxane (3) having an actd-dissociable group, when the total number of the halogen atom for R1 and the group -OR³ in the formula (2-A) is two or three, or when m in the formula (2-A) is 0 or 1. The other silicon-containing alloyclic compounds (2), i.e. those having the formula (2-A) wherein the total number of the halogen atom or R1 and the group -OR³ is one, or mile 2, or those having the above the formula (2-B), or their hydrolysis products, may also be used in the polycondensation reaction to adjust the molecular weight or molecular structure of polysiloxane

10077 The silicon-containing alicyclic compound (2) is also useful as a raw material for producing common polysiloxane resins and other silicon-containing alicyclic compounds having similar norbornane-type cyclic structure.

### Polysiloxane (3)

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[0078] Polysiloxane (3) has the above structural unit (i-1) or structural unit (i-1), or both.

[0079] As examples of the monovalent hydrocarbon group having 1-20 carbon atoms, monovalent halogenated hydrocarbon group having 1-20 carbon atoms, halogen atom, or secondary or tertiary amino group represented by R<sup>1</sup> in the structural until (II-1), the corresponding groups previously mentioned in connection with the group R<sup>1</sup> in the structural unit (II) of the polysilloxane (1) can be given.

[0800] Amethyl group, ethyl group, cyclopentyl group, cyclohexyl group, norbornyl group, tetracyclodecanyl group, and the like can be given as preferable monovalent hydrocarbon groups having 1-20 carbon atoms represented by R¹ in the structural unit (III-1). Given as examples of preferable halogenated hydrocarbon groups having 1-20 carbon atoms represented by R¹ are a trifluoromethyl group, pentafluorothyl group, 3.3.2.2-pentafluoroth-propyl group, pentafluorophenyl group, c-fluorophenyl group, m-fluorophenyl group, pentafluorophenyl group, 2,5-difluorophenyl group, 2,5-difluoroph

group, 3.4-firtillorophenyl group, 2.3,5-firtillorophenyl group; 2.3,6-firtillorophenyl group; 2.4,6-firtillorophenyl group, 3.4,5-firtillorophenyl group, pertainterplanel group, pertainterplanel group, a group of the formula (ii) in which 5 fifs are fluorine atoms and bis 1, a group of the formula (ii) in which 5 fifs are fluorine atoms and bis 2, and the like. A chlorine atom is a preferable halogen represented by Fif, and an amino group, dientlylamino group, dient

[0081] Particularly preferable groups represented by R1 in the structural unit (II-1) are a methyl group, ethyl group, cyclopentyl group, cyclohexyl group, phenyl group, pentafluorophenyl group, chlorine atom, dimethylamino group, and the like.

[0082] As the group R in the structural unit (I-1) and structural unit (II-1) of the polyeiloxane (3), both the hydrogen atom and methyl group are preferable. One is a preferable integer for n'. The n' in the structural unit (I-1) and n or different.

[0083] The structural unit shown by the following formula (1-1-1) can be given as a specific example of the structural unit (1-1).

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[0084] The structural units shown by the following formulas (II-1-1) to (II-1-4) can be given as specific examples of the structural unit (II-1).

[0085] In the polysiloxane (3), the t-butoxycarbonyl group in the structural units (I-1) and (II-1) is an acid-dissociable group which dissociates in the presence of an acid and produces a carboxyl group.

[0086] The structural unit (I-1) and the structural unit (II-1) may be used in the polysiloxane (3) either individually or in combination of two or more.

[0087] The content of these structural units in the polysiloxane (3) may vary according to the types and combinations of the structural units, the application of the polysiloxane (3), and the like. A preferable specific content of each unit may be suitably determined by experiments. The amount of the structural unit (I-1) is usually 1-100 mo%, preferably 2-100 mo%, and particularly preferably 5-100 mo% of the total amount of the structural units. The amount of the structural units (I-1) and (II-1) is usually 0-100 mo% of the total amount of the structural units. The total of the structural units (I-1) and (II-1) is usually 1-100 mo%, preferably 2-100 mo%, and particularly preferably 5-100 mo% of the total amount of the structural units.

[0088] If the amount of the structural unit (I-1) is less than 1 mol's, resolution of the resulting radiation-sensitive resin composition rends to decrease. If the total amount of the structural unit (I-1) and structural unit (II-1) is less than 1 mol's, the resulting radiation-sensitive resin composition may have poor solubility in an alikaline developer.

[0089] The amount of the structural units other than structural units (I-1) and (II-1) is usually 99 mol% or less, and preferably 95 mol% or less, of the total amount of structural units.

[0090] The total amount of bi-functional structural units in the polycondensation reaction is usually 0-100 mol%, and preferably 1-100 mol%. The total amount of tri-functional structural units in the polycondensation reaction is usually 1-100 mol%, and preferably 2-100 mol%. The total amount of tetra-functional structural units in the polycondensation reaction is usually 98 mol% or less, and oreferably 95 mol% or less.

[0091] Usually, polysiloxane (3) has a ladder structure as part of the molecular structure. The ladder structure is

principally introduced by a raw material having tri- or greater functional structure with respect to the polycondensation reaction.

[0092] Mw of Polysiloxane (3) is usually 500-1,000,000, preferably 500-500,000, and particularly preferably 1,000-100,000, if the Mw is less than 500, the glass transition temperature of the resulting polymer tends to decrease. If the Mw exceeds 1,000,000, solubility of the polymer in solvents tends to decrease.

[0093] The glass transition temperature (Tg) of polysiloxane (3) is usually from -50 to 500°C, and preferably from 0 to 300°C. If the glass transition temperature (Tg) of polysiloxane (3) less than -50°C, pattern formation using the resulting radiation-sensitive resin composition may be difficult. If more than 500°C, solubility of the polymer in solvents tends to decrease.

[0044] Polysiloxane (3) is usually insoluble or scarcely soluble in alkali, but becomes alkali-soluble when the aciddissociable group dissociates in the presence of an acid. Thus, the polymer is particularly useful as an acid-dissociable group-containing resin component in radiation-sensitive resin compositions for microprocessing using various types of radiation such as deep ultraviolet radiation, electron beams, and X-rays.

[0095] Polysiloxane (3) is also useful as a material for fabricating formed articles and films, and as laminating materials, components for coating compositions, and the like.

### Silicon-containing alicyclic compound (4)

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[0096] In the silicon-containing alloyolic compound (4), as examples of the monovalent hydrocarbon group having 1-20 carbon atoms, monovalent halogenated hydrocarbon group having 1-20 carbon atoms, halogen atom, or secondary or tertiary amino group represented by R1, the corresponding groups previously mentioned in connection with the group R1 in the structural unit (II) of the polysiloxane (1) can be given.

[0097] Amethyl group, ethyl group, cyclopentyl group, cyclohexyl group, norbornyl group, letracyclodecanyl group, and the like can be given as preferable monovalent hydrocarbon groups having 1-20 carbon atoms represented by R1. Given as examples of preferable halogenated hydrocarbon groups having 1-20 carbon atoms represented by R1 are a trifluoromethyl group, pentafluoroethylgroup, 3,3,3,2,2-pentafluoro-n-gropyl group, pentafluorophenyl group, cycliuorophenyl group, p. g.d-difluorophenyl group, 2,6-difluorophenyl group, 2,6-difluorophenyl group, 2,6-difluorophenyl group, 2,3,4-trifluorophenyl group, 2,3,4-trifluorophenyl group, 2,4,5-trifluorophenyl group, 2,5-trifluorophenyl group, 2,5-trifluorophenyl group, 2,4,5-trifluorophenyl group, 2,4,5-trifluorophenyl group, 2,4,5-trifluorophenyl group, 2,5-trifluorophenyl group, 2,5-

[0098] Particularly preferable groups represented by R¹ in the silicon containing alloyolic compound (4) are a methyl group, ethyl group, cyclohexyl group, pentafluorophenyl group, chlorine atom, dimethylamino group, and

[0099] As examples of the monovalent hydrocarbon group having 1-20 carbon atoms and monovalent halogenated hydrocarbon group having 1-20 carbon atoms represented by R<sup>3</sup> the corresponding groups previously mentioned in connection with the group R<sup>1</sup> in the structural unit (II) of the polysitoxane (1) can be given.

(0100] A methyl group, ethyl group, n-propyl group, i-propyl group, and the like can be given as preferable monovalient hydrocarbon groups having 1-20 carbon atoms represented by FR3 Given as examples of preferable halogenated hydrocarbon groups having 1-20 carbon atoms represented by FR3 are a trifluoromethyl group,pentafluoroethylgroup, 3,3,3,2,2-pentafluoro-n-propyl group, pentafluorophenyl group, p-fluorophenylgroup,2-fluorophenylgroup

45 3,4-diffuoro phenyl group, 3,5-diffuorophenyl group, 2,3-4-trifluorophenyl group, 2,3,5-trifluorophenyl group, 2,3,6-trifluorophenyl group, 3,5-diffuorophenyl group, 3,4,5-trifluorophenyl group, 3,7-diffuorophenyl group, 3,7-diffuorophenyl group, 3,7-diffuorophenyl group, 3,6-trifluorophenyl group, 3,6-trifluorophenyl group, 3,6-trifluorophenyl group, 3,6-trifluorophenyl group, 3,6-trifluorophenyl group, 2,3-6-trifluorophenyl group, 2,3-6-tr

[0101] As the group represented by the formula (i) in R<sup>3</sup>, the corresponding groups given as examples relating t R<sup>3</sup> of the silicon-containing alicyclic compound (2) can be given.

[0102] Particularly preferable groups as the group X in the formula (I) are a methyl group, phenyl group, methoxy group, and the like. The integer represented by a in the formula (I) is preferably 1 to 5.

[0103] Particularly preferable groups represented by R<sup>3</sup> in the silicon containing alicyclic compound (4) are a methyl group, ethyl group, t-butyl group, timethylsilyl group, and the like.

[0104] As the group R in the silicon containing alicyclic compound (4), both the hydrogen atom and methyl group are preferable. As the group Rf, a hydrogen atom, methyl group, and trifluoromethyl group are preferable. A preferable integer form and h is 0 or 1.

[0105] As examples of the hydrocarbon group having 1-20 carbon atoms, halogenated hydrocarbon group having 1-20 carbon atoms, halogen atom, or primary, secondary, or tertiary amino group represented by Y, the corresponding

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groups previously mentioned in connection with the group  $\mathbf{R}^1$  in the structural unit (II) of the polysiloxane (1) can be given.

[0106] As preferable examples of silicon containing alicyclic compound (4) in which Z is a hydrogen atom, compounds shown by the following formulas (4-1) to (4-100) can be given. In the following formulas, Rf represents a hydrogen atom, methyl group, or trifluoromethyl group, and Me indicates a methyl group.

(4-20)

(4-31) (4-32)

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-Ç−OH Rf

(4-58)

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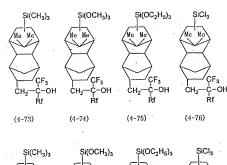
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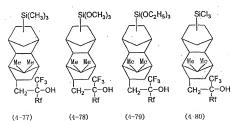
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(4-59)

(4-60)





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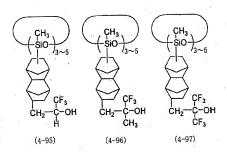
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(4-90)

(4-91)

(4-89)



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[0107] Of the above silicon containing alicyclic compound (4), compounds shown by the formulas (4-2), (4-5), (4-5), (4-6), (4-8), (4-9), (4-10), (4-11), and (4-12) are particularly preferable (provided that Rf in these formulas represents a trifluorometryl group).

[0108] The following compounds can be given as preferable examples of the silicon containing alloyclic compound (4), wherein Z is a monovalent organic group dissociating hydrogen atoms by the action of an acid.

[0109] Compounds derived from the compound shown by the above formulas (4-1) to (4-100) (provided that Rf in these formulas is a hydrogen atom) by replacing the hydrogen atom in the hydroxyl group with a t-butyl group, t-butoxycarbonyl group, tetrahydropyranyl group, tetrahydrofuranyl group, methoxymethyl group, ethoxymethyl group, 1-methoxyethyl group, -1-methoxyethyl group, -1-ethoxyethyl group.

30 [0110] Compounds derived from the compound shown by the above formulas (4-1) to (4-100) (provided that Rf in these formulas is a methyl group) by replacing the hydrogen atom in the hydroxyl group with a t-butyl group, t-butox-yearbonyl group, tetrahydropyranyl group, tetrahydrofuranyl group, methoxymethyl group, ethoxymethyl group, 1-methoxyethyl group, or 1-ethoxyethyl group.

[0111] Compounds derived from the compound shown by the above formulas (4-1) to (4-100) (provided that Rf in these formulas is a trifluoromethyl group) by replacing the hydrogen atom in the hydroxyl group with a t-butyl group, t-butoxycarbonyl group, terthydropyranyl group, tethydrofuranyl group, methoxymethyl group, ethoxymethyl group, terthydrofuranyl group, methoxymethyl group, or t-ethoxyethyl group.

[0112] Of the above silicon containing allcyclic compound (4), wherein Z is a monovalent organic group dissociating hydrogen atoms by the action of an acid, particularly preferable compounds are the compounds derived from the compound shown by the above formulas (4-2), (4-3), (4-5), (4-6), (4-9), (4-9), (4-10), (4-11), or (4-12) (provided that RI in these formulas represents a trifluoromethyl group)) by replacing the hydrogen atom in the hydroxyl group with a 1-buly group, inclusive and the property group, tetrahydroyranyl group, tetrahydrofuranyl group, methoxymethyl group, the property group the property group that group gro

[0113] The silicon containing alisyclic compound (4) having a hydrogen atom for the group Z is particularly useful as a raw material for synthesizing the silicon containing alloydic compound (4), wherein Z is a monovalent organic group dissociation hydrogen atoms by the action of an acid.

[0114] The silicon containing alicyclic compound (4), in which Z is a hydrogen atom and the total number of the halogen atom for R1 and the group -OR8 is two or three, or the silicon containing alicyclic compound (4), in which m is 0 or 1, is very useful as a raw material for producing the alkali-soluble polysitoxane (5). The silicon containing allcyclic compounds (4), in which Z is a hydrogen atom and the total number of the halogen atom for R1 and the group -OR3 is one, or the silicon containing allcyclic compounds (4), in which Z is a hydrogen atom and m is 2, or the products obtained by previous hydrolysis of these compounds (4), in which Z is a hydrogen atom and m is 2, or the products obtained by previous hydrolysis of these compounds may also be used in the polycondensation reaction to adjust the molecular weight or molecular subsylint or molecular subsy

[0115] In addition, the silicon-containing alicyclic compound (4) in which Z is a hydrogen atom is also useful as a raw material for producing common polysiloxane resins and other silicon-containing alicyclic compounds having similar norbomane-type cyclic structure.

[0116] The silicon-containing alloyclic compound (4) in which Z is a monovalent organic group dissociating hydrogen atoms by the action of an acid and m is 0 or 1 is very useful as a raw material for producing the polysiloxane (5) resins

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having an acid-dissociable group. The silicon-containing alloyelic compound (4) in which Z is a monovalent organic group dissociating hydrogen atoms by the action of an acid andm is 2, or its hydrolysis products may also be used in the polycondensation reaction to adjust the molecular weight or molecular structure of polysiloxane (5).

[0117] In addition, the silicon-containing alloydic compound (4) in which Z is a monovalent organic group dissociating hydrogen atoms by the action of an acid is also useful as a raw material for producing common oplysilioxane resins and other silicon-containing alloydic compounds having similar northornane-type cyclic structure.

# Polysiloxane (5)

- [0118] Polysiloxane (5) has the above structural unit (1-2) and/or structural unit (11-2) shown in the above formula (5).
  [0119] As examples of the monovalent organic group discocating hydrogen atoms by the action of an act represented by Z in the structural unit (10-2) extructural unit (11-2), a tertiary alkyl group, a group forming an acetal group together with the oxygen atom with which the group Z binds (hereinafter referred to as an "acetal-forming group"), a substituted methyl group, 1-substituted eithyl group, 1-branched alkyl group (excluding tertiary alkyl group, group), alkyl group, alkovycarbovyl group, avel group, cycle acid-dissociating group, and the like can be given.
- [0120] As examples of the tertiary alkyl group, acetal-forming group, substituted methyl group, 1-substituted ethyl group, 1-branched alkyl group, silyl group, germyl group, alkoxycarbonyl group, acyl group, and cyclic acid-dissociating group, the corresponding groups previously given as examples of Z in the acid-dissociable group (y) of polysiloxane (1) can be given.
- 20 [0121] As the group Z in the structural unit (I-2) or structural unit (I-2), a hydrogen atom, t-butyl group, t-butoxycar-bonyl group, tetrahydropyranyl group, tetrahydrofuranyl group, methoxymethyl group, ethoxymethyl group, 1-methoxyethyl group. 1-methox
  - [0122] The Z in the structural unit (I-2) and Z in the structural unit (II-2) may be either the same or different.
    [0123] As examples of the monovalent hydrocarbon group having 1-20 carbon atoms, monovalent halogenated hy-
- 28 examples of the minorwalent inyaducation igroup having 1-20 and author, involvem narrogenized by R1 in the structural unit (II-2), the corresponding groups previously mentioned in connection with the group R1 in the structural unit (II) of the polysiloxane (1) can be given.
  [10.2] A methyl arous, eithyl croup, exclopentlyl group, evolothexyl group, norbornyl group, tetracyclodecarryl group,
- and the like can be given as preferable monovalent hydrocarbon groups having 1-20 carbon atoms represented by 30 R1. Given as examples of preferable monovalent hydrocarbon groups having 1-20 carbon atoms represented by 81 are a trifluoromethyl group, pentafluorophenyl gr
- dicyclohexylamino group, diphenylamino group, and the like are preferable amino groups represented by Rf. [0125] -Particularly preferable groups represented by Rf in the structural unit (II-2) are a methyl group, explopently group, cyclohexyl group, pentafluoroethyl group, chlorine atom, dimethylamino group, and the like.
- [0126] As the group R in the structural unit (1-2) and structural unit (1-2) of the polysiloxane (5), both the hydrogen atom and methyl group are preferable. As the group RI, any one of the hydrogen atom, methyl group, and trifluoromethyl group is preferable. O or 1 is preferable as the integer n. The RI in the structural unit (1-2) and RI in the structural unit (1-2) may be either the same or different. Also, n in the structural unit (1-2) and n in the structural unit (1-2) may be either the same or different.
  - [0127] The structural units shown by the following formulas (I-2-1) to (I-2-24) can be given as specific examples of the structural unit (I-2).

(1-2-17)

(1 2-16)

[0128] Of the above examples of structural unit (I-2), the structural units shown by the formulas (I-2-2), (I-2-3), (I-2-5), (I-2-8), (I-2-9), (I-2-16), (I-2-17), (I-2-18), (I-2-20), and (I-2-21) are particularly preferable. [0129] The structural units shown by the following formulas (II-2-1) to (II-2-96) can be given as specific examples of the structural unit (II-2).

(11-2-11)

(11-2-10)

(11 2 12) ...

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(11-2-20)

(11-2-21)

(11-2-19)

(11-2-38)

(11-2-37)

(11-2-39)

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(11 2-46)

(11-2-17)

(11-2-48)

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(11-2-65)

(11-2-64)

(11-2-66)

[0130] Of the above examples of structural unit (ii), the structural units shown by the formulas (II-2-14), (II-2-15), (II-2-17), (II-2-18), (I

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In combination of two or more.

[0132] Usually, polysiloxane (5) has a ladder structure as part of the molecular structure. The ladder structure is principally introduced by a raw material having tri- or greater functional structure with respect to the polycondensation or the polycondensation of the polycondensation of the polycondensation or the polycondensation of the polycondensation

reaction.
[0133] The content of these structural units in the polysiloxane (5) may vary according to the types and combinations of the structural units, the application of the polysiloxane (5), and the like. A preferable specific content of each unit may be suitably determined by experiments. The amount of the structural unit (4:2) is usually 1-100 mol%, preferably 5-100 mol%s of the total amount of the structural units. The amount of the structural units (1:4) is usually 0-100 mol%, preferably 1-100 mol%, and particularly preferably 2-100 mol%s of the total amount of the structural units. The total of the structural units (1:2) and (1:2) is usually 1-100 mol%, preferably 2-100 mol%s of the structural units.

mol%, and particularly preferably 5-100 mol% of the total amount of the structural units.

[1014] If the amount of the structural unit (I-2) is less than 1 mol%, resolution of the resulting radiation-sensitive resin composition tends to decrease. If the total amount of the structural unit (I-2) and structural unit (II-2) is less than 1 mol%, the resulting radiation-sensitive resin composition may have poor solubility in an alkaline developer.

35 [0135] The amount of the structural units other than structural units (I-1) and (II-1) is usually 99 mol% or less, and preferably 95 mol% or less, of the total amount of structural units.

[0136] The total amount of bi-functional structural units in the polycondensation reaction is usually 0-100 mol%, and preferably 1-100 mol%. The total amount of tri-functional structural units in the polycondensation reaction is usually 1-100 mol%, and preferably 2-100 mol%. The total amount of tetra-functional structural units in the polycondensation reaction is usually 98 mol% or less, and preferably 95 mol% or less.

reaction is usually set finding in sea, and periodical 25 on honorous preferably 500-500,000, and particularly preferably 500-1,000,000, preferably 500-500,000, and particularly preferably 500-100,000. If the Mw is less than 500, the glass transition temperature of the resulting polymer tends to decrease. If the Mw exceeds 1,000,000, solubility of the polymer in solvents tends to decrease.

[0138] The glass transition temperature (Tg) of polysiloxane (5) is usually from -50 to 500°C, and preferably from 0 to 300°C. If the glass transition temperature (Tg) of polysiloxane (5) less than -50°C, pattern formation using the resulting radiation-sensitive resin composition may be difficult. If more than 500°C, solubility of the polymer in solvents tends to decrease.

[0139] The polysiloxane (5) having a hydrogen atom for Z is usually soluble in alkali and very useful as an alkalisoluble component in radiation-sensitive resin compositions for microprocessing using various types of radiation such as deep uttraviolet radiation, electron beams, and X-rays.

as deep ultraviolet radiation, election beants, and Arays.

[10140] The polysiloxane (5) having a hydrogen atom for the group Z is also useful as a raw material for synthesizing the polysiloxane (5), wherein Z is a monovalent organic group dissociating hydrogen atoms by the action of an acid. [10141] Polysiloxane (5), in which Z is a monovalent organic group dissociating hydrogen atoms by the action of an acid. (is usually insoluble or scarcely soluble in alkali, but becomes atkalis-oluble when the acid-dissociable group dissociates. Thus, the polymer is particularly useful as an acid-dissociable group-containing resin component in radiation-sensitive resin compositions for microprocessing using various types of radiation such as deep ultraviolet radiation, electron beams, and X-rays.

[0142] The polysiloxane (5) is also useful as a material for fabricating formed articles and films, and as laminating

materials, components for coating compositions, and the like.

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[0143] Synthesis of silicon-containing alicyclic compound (2) and silicon-containing alicyclic compound (4)

[0144] . The silicon-containing alloydic compound (2) and silicon-containing alloydic compound (4) can be synthesized by the following method, for example.

[0145] OA method of reacting a corresponding norbomene derivative and corresponding hydrostlane compound in accordance with a conventional hydrosityl-formation reaction using a hydrosityl-formation catalyst in the presence or absence of a sulfable solvent.

[0146] This reaction is shown by the following reaction formula in the case of the silicon-containing alloyolic compound (2) having the above-described formula (2-A).

wherein R, R<sup>1</sup>, R<sup>3</sup>, m, and n have the same meanings as defined for the corresponding symbols in the formula (2-A). As examples of the hydrosliyt-forming catalyst, a transition metal catalyst, radical reaction initiator, and the like can be given

Examples of a transition metal catalyst used as the hydrosily-forming catalyst include the following compounds: plainium catalysis such as H<sub>2</sub>PCl<sub>6</sub>, K<sub>2</sub>PCl<sub>6</sub>, N<sub>2</sub>PCl<sub>6</sub>, N<sub>4</sub>PCl<sub>6</sub>, N<sub>5</sub>PCl<sub>6</sub>, N<sub>5</sub>PCl<sub>6</sub>,

trans-PICI<sub>2</sub>(NI- $\frac{1}{2}$ ), cis-PICI<sub>2</sub>(PIC- $\frac{1}{2}$ - $\frac{1}{2}$ ), cis-PICI<sub>2</sub>(PIC- $\frac{1}{2}$ - $\frac{1}{2}$ - $\frac{1}{2}$ -PICI<sub>2</sub>(n- $\frac{1}{2}$ - $\frac{1}{2}$ -PICI<sub>3</sub>(n- $\frac{1}{2}$ - $\frac{1}{2}$ - $\frac{1}{2}$ - $\frac{1}{2}$ -PICI<sub>4</sub>(n- $\frac{1}{2}$ - $\frac{1}{2}$ - $\frac{1}{2}$ - $\frac{1}{2}$ - $\frac{1}{2}$ -PICI<sub>4</sub>(n- $\frac{1}{2}$ - $\frac{1}{2}$ - $\frac{1}{2}$ - $\frac{1}{2}$ - $\frac{1}{2}$ -PICI<sub>4</sub>(n- $\frac{1}{2}$ - $\frac{1}{2}$ -PICI<sub>4</sub>(n- $\frac{1}{2}$ - $\frac{1}{2}$ - $\frac{1}{2}$ -PICI<sub>4</sub>(n- $\frac{1}{2}$ -PICI<sub>4</sub>-PICI<sub>4</sub>-PICI<sub>4</sub>-PICI<sub>4</sub>-PICI<sub>4</sub>-PICI<sub>4</sub>-PICI<sub>4</sub>-PICI<sub>4</sub>-PICI<sub>4</sub>-PICI<sub>4</sub>-PICI<sub>4</sub>-PICI<sub>4</sub>-PICI<sub>4</sub>-PICI<sub>4</sub>-PICI<sub>4</sub>-PICI<sub>4</sub>-PICI<sub>4</sub>-PICI<sub>4</sub>-PICI<sub>4</sub>-PICI<sub>4</sub>-PICI<sub>4</sub>-PICI<sub>4</sub>-PICI<sub>4</sub>-PICI<sub>4</sub>-PICI<sub>4</sub>-PICI<sub>4</sub>-PICI<sub>4</sub>-PICI<sub>4</sub>-PICI<sub>4</sub>-PICI<sub>4</sub>-PICI<sub>4</sub>-PICI<sub>4</sub>-PICI<sub>4</sub>-PICI<sub>4</sub>-PICI<sub>4</sub>-PICI<sub>4</sub>-PICI<sub>4</sub>-PICI<sub>4</sub>-PICI<sub>4</sub>-PICI<sub>4</sub>-PICI<sub>4</sub>-PICI<sub>4</sub>-PICI<sub>4</sub>-PICI<sub>4</sub>-

as RuCl<sub>3</sub>, etc.; cobalt catalysts such as Co<sub>2</sub>(CO)<sub>8</sub>, etc.; nickel catalysts such as NiCl<sub>2</sub>, NiBr<sub>2</sub>, Ni(CN)<sub>2</sub>, etc.; and copper catalysts such as CuCl<sub>2</sub>, CuBr<sub>2</sub>, CuCl, CuBr, CuCN, etc.

[0147] Of these transition metal catalysts, platinum catalysts such as H<sub>2</sub>PtCl<sub>6</sub>, K<sub>2</sub>PtCl<sub>6</sub>, Na<sub>2</sub>PtCl<sub>6</sub>, K<sub>2</sub>PtCl<sub>4</sub>, Na<sub>2</sub>PtCl<sub>4</sub>, PtCl<sub>2</sub>, H<sub>2</sub>PtBr<sub>6</sub>, K<sub>2</sub>PtBr<sub>6</sub>, Na<sub>2</sub>PtBr<sub>6</sub>, K<sub>2</sub>PtBr<sub>4</sub>, and platinum-activated carbon are preferable.

[0148] These transition metal catalysts may be used either individually or in combination of two or more.

[0149] The transition metal catalysts may be added as a solution in an organic solvent such as i-propyl alcohol. [0150] These transition metal catalysts are usually used in the amount of 0.00001-1,000 parts by weight for 100

parts by weight of the hydrosilane compound.

[0151] As examples of the above-mentioned radical reaction initiator, benzoylperoxide, lauroylperoxide, diisopropylperoxydicarbonate, t-butylhydroperoxide, curnenehydroperoxide, di-t-butylperoxide, dicumylperoxide, azobisisobutyronitrile, azobis(2,4-dimethylvaleronitrile), azobis(4-methoxy-2,4-dimethylvaleronitrile), and the like can be given.

[0152] These radical reaction initiators may be used either individually or in combinations of two or more.

[0153] The radical reaction initiators are usually used in the amount of 0.01-1,000 parts by weight for 100 parts by

weight of the hydrosilane compound.

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[0154] The following solvents can be given as the solvent used in the hydrosityl-forming reaction: aromatic hydrocarbons such as benzene, toluene, and xylene; aliphatic hydrocarbons such as n-hexane, n-heptane, and n-octane; ethers such as benzyl ethyl ether, di-n-hexyl ether, and tetrahydrofuran; halogenated hydrocarbons such as dichloromethane, chloroform, and 1,2-dichloroethane; linear or branched ketones such as 2-butanone, 2-pentanone, 3-methyl-2-butanone, 2-hexanone, 4-methyl-2-pentanone, 3-methyl-2-pentanone, 3,3-dimethyl-2-butanone, 2-heptanone, and 2-octanone; cyclic ketones such as cyclopentanone, 3-methylcyclopentanone, cyclohexanone, 2-methylcyclohexanone, 2,6-dimethylcyclohexanone, and isophorone; propylene glycol monoalkyl ether acetates such as propylene glycol monomethyl ether acetate, propylene glycol monoethyl ether acetate, propylene glycol mono-n-propyl ether acetate, propylene glycol mono-i-propyl ether acetate, propylene glycol mono-n-butyl ether acetate, propylene glycol mono-i-butyl ether acetate, propylene glycol mono-sec-butyl ether acetate, and propylene glycol mono-t-butyl ether acetate; alkyl 2-hydroxypropionates such as methyl 2-hydroxypropionate, ethyl 2-hydroxypropionate, n-propyl 2-hydroxypropionate, i-propyl 2-hydroxypropionate, n-butyl 2-hydroxypropionate, i-butyl 2-hydroxypropionate, sec-butyl 2-hydroxypropionate, and t-butyl 2-hydroxypropionate; alkyl 3-alkoxypropionates such as methyl 3-methoxypropionate, ethyl 3-methoxypropionate, methyl 3-ethoxypropionate, and ethyl 3-ethoxypropionate; alcohols suchas n-propylalcohol, i-propylalcohol, n-butylalcohol, t-butylalcohol, 1-octanol, 1-nonanol, benzyl alcohol, cyclohexanol, ethylene glycol monomethyl ether, ethylene glycol monoethyl ether, ethylene glycol mono-n-propyl ether, ethylene glycol monon-butyl ether, propylene glycol monomethyl ether, propylene glycol monoethyl ether, and propylene glycol mono-npropyl ether, dialkylene glycol dialkyl ethers such as diethylene glycol dimethyl ether, diethylene glycol diethyl ether, diethylene glycol di-n-propyl ether, diethylene glycol di-n-butyl ether, ethylene glycol monoalkyl ether acetates such as ethylene glycol monomethyl ether acetate, ethylene glycol monoethyl ether acetate, and ethylene glycol mono-npropyl ether acetate; other esters such as ethyl 2-hydroxy-2-methylpropionate, ethyl ethoxyacetate, ethyl hydroxyacetate, methyl 2-hydroxy-3-methylbutyrate, 3-methoxybutylacetate, 3-methyl-3-methoxybutylacetate, 3-methyl-3-met oxybutylpropionate, 3-methyl-3-methoxybutyrate, ethyl acetate, n-propyl acetate, n-butyl acetate, methyl acetateate, ethyl acetoacetate, methyl pyruvate, ethyl pyruvate; N-methylpyrrolidone, N,N-dimethylformamide, N,N-dimethylacetamide, diethylene glycol monomethyl ether, diethylene glycol monoethyl ether, caproic acid, caprylic acid, benzyl acetate, ethyl benzoate, diethyl oxalate, diethyl maleate, y-butyrolactone, ethylene carbonate, propylene carbonate; and the like.

[0155] These solvents may be used either individually or in combination of two or more. [0156] These solvents are usually used in the amount of 2,000 parts by weight or less for 100 parts by weight of the hydrosilane compound.

[0157] The hydrosilyl-forming reaction is preferably carried out in the absence of a solvent or in the presence of a solvent such as toluene, xylene, n-hexane, tetrahydrofuran, dichloro methane, or the like.

[0158] The hydrosilyl-forming reaction is also preferably carried out in a nitrogen or argon stream and under anhydrous conditions.

[0159] The hydrosilyl-forming reaction is camed out at a temperature of usually -50 to 300°C, and preferably 0 to 200°C for usually five minutes to 1,000 hours.

[0160] Although a common hydrosityl-forming reaction is thought to be preferably carried out usually under normal pressure or under pressure, the hydrosityl-forming reaction for synthesizing the silicon-containing alloyclic compound (2) or silicon-containing alicyclic compound (4) can be carried out at a pressure less than the normal pressure, without requiring a special reaction vessel. This is an advantage of this reaction.

[0161] In this hydrosilyl-forming reaction, the compounds in which the silicon atom, shown in formulas (2-A), (2-B), (4-A), or (4-B), binds at the 2 or 3 position of the uppermost bicyclo[2.2.1]heptane ring are produced at the same time. The mixture can be used as is as a raw material for producing the polysiloxane (3) and polysiloxane (6), for example. As required, the two compounds may be separated by a suitable means such as distillation, recrystallization, liquid chromatography, gas chromatography, and the like.

- [0162] The compound (2) of the above formula (2-B) or (4-B) can be synthesized by a conventional condensation reaction of a compound derived from the compound having the total number of the group P1 as a halogen atom and the group OR3 in the formula (2-A) or (4-A) or two or three, by introducing a silanot group by hydrolyzing the helogen atom or at least part of the group OR3 in the processor of an acid catalyst or alkaline calabast.
- [0163] The silicon-containing alloyclic compound (4) in which Z is a monovalent organic group dissociating hydrogen atoms by the action of an acid can be synthesized from the silicon-containing alloyclic compound (4) in which Z is a hydrogen atom by replacing the hydrogen atom of the hydroxyl group of this compound with a monovalent organic group dissociating hydrogen atoms by the action of an acid.
- [0164] More particularly, the above method can be carried out as follows, for example.
- [0165] @When Z is a t-butoxycarbonyl group, a method of esterifying the hydroxyl group in the raw material with dit-butyl carbonate in the presence of a catalytic amount of 4-dimethylaminopyridine.
  - [0166] ③When Z is a tetrahydropyranyl group, a method of effecting an addition reaction to the hydroxyl group in the raw material with 2, 3-dihydro-4H-oyrane according to a conventional method.
- [0167] (4) When Z is an acetal group such as a 1-alkoxyethyl group, a method of effecting an addition reaction to the hydroxyl group in the raw material with a corresponding alkylvinyl ether according to a conventional method.
  - [0168] The above methods @to @can be carried out either using a sultable solvent or without using a solvent. The solvents previously given in the description relating to the method @can be given as examples of the solvent used here. The reaction conditions, such as a reaction temperature and reaction time, are appropriately determined according to the method employed, types of reagents used, and the like.
- [0169] In particular, the method @can efficiently produce the silicon-containing alicyclic compound (4) in which the group Z is a monovalent organic group dissociating hydrogen atoms by the action of an acid. On the other hand, it is difficult to obtain the target compound by using a sodium hydride catalyst which is used to replace a hydroxyl group in common organic compounds with a t-butoxycarbonyl group.
- 25 Preparation of polysiloxane (1)
- [0170] Polysiloxane (1) can be prepared by a method comprising a step of polycondensing at least one component selected from the group consisting of a compound shown by the above-described formula (6) (hereinatter referred to as "silane compound (8)") or a linear of cyclic oligomer prepared by partial condensation of the silane compound (8) and/or at least one component selected from the group consisting of a compound shown by the above-described formula (7)" or elinear of cyclic oligomer prepared by partial condensation of the silane compound (7)" or all inear of cyclic oligomer prepared by partial condensation of the silane compound (8)" or a linear of cyclic oligomer prepared by partial condensation of the silane compound (8)" or a linear of cyclic oligomer prepared by partial condensation of the silane compound (8)" or a nacidic catalyst, according to a conventional method, using or without using a solvent, in the presence of an acidic catalyst or a basic catalyst. The process preferably includes a polycondensation rescribed responses to the catalyst or a basic catalyst.
  - [0171] Here, "the linear of cyclic oligomer prepared by partial condensation of the silane compound (6)", "the linear of cyclic oligomer prepared by partial condensation of the silane compound (7)", and "the linear of cyclic oligomer prepared by partial condensation of the silane compound (8)" denote oligomers of usually 2-10 molecules, preferably 2-5 molecules, in the case of linear oligomers, and usually 3-10 molecules, preferably 3-5 molecules, in the case of the cyclic oligomers, each oligomer by the condensation of the Si-OR3 groups in the eliane compounds. [0172] In the formula (6), A¹ is the same as defined for the above formula (1). As examples of the monovalent hydrocarbon group having 1-20 carbon atoms represented by 18", the corresponding groups previously mentioned in connection with the group R¹ into structural unit (II) of the polysiloxane (1) can be given. As the group represented by the formula (1), the groups corresponding to 80 of the silicon-contribing allevolic compound (2) can be given. As the group represented by the formula (1), the groups corresponding to 80 of the silicon-contribing allevolic compound (2) can be given. The preparation of the property of the formula (1), the groups corresponding to 80 of the silicon-contribing allevolic compound (2) can be given, for example.
    - [0173] In the formula (7), A<sup>2</sup> and R<sup>1</sup> are respectively the same as those defined in the above formula (1).
  - [0174] As examples of the monovalent hydrocarbon group having 1-20 carbon atoms and monovalent halogenated hydrocarbon group provide the monovalent halogenated hydrocarbon group previously mentioned in connection with the group R<sup>1</sup> in the structural unit (II) of the polysiloxana (1) can be given. As the group represented by the formula (i), the groups corresponding to R<sup>3</sup> of the silicon-containing alicyclic compound (2) can be given, for example.
  - [0175] In the formula (8), R2 is the same as defined for the above formula (1). As examples of the monovalent hydrocarbon group having 1-20 carbon atoms and monovalent halogenated hydrocarbon group having 1-20 carbon atoms represented by R3, the corresponding groups previously mentioned in connection with the group R1 into structural unit (II) of the polyalloxane (1) can be given. As the group represented by the formula (I), the groups corresponding to R3 of the silicon-containing alloyelic corpound (2) can be given, for example.
    - [0176] In the formulas (6) to (8), given as examples of preferable monovalent hydrocarbon groups having 1-20 carbon

atoms represented by R³ are a methyl group, ethyl group, n-propyl group, i-propyl group, and the like; and as examples of preferable halogenated hydrocarbon groups having 1-20 carbon atoms represented by R³ are a trifluoromethyl group, pentalhurocentyl group, 3,3,3,2,2-pentalhurocentyl group, pentalhurophenyl group, group,

[0177] As examples of the linear, branched, or cyclic alkoxyl groups having 1-20 carbon atoms represented by X in the formula (i), which represents the group F/a in enthoxy group, enhoxy group, n-propoxy group, 1-propoxy group, n-butoxy group, b-butoxy group, b-butoxy group, cyclopentyloxy group, cyclohexyloxy group, and the like can be given. Particularly preferable groups are a methyl group, phenyl group, methoxy group, and the like. a is oreferably an integer of 1-5.

[0178] Particularly preferable groups represented by R<sup>3</sup> in the formulas (6), (7), and (8) are a methyl group, ethyl group, the fixe.

[0179] In preparing the polysiloxane (1), the silane compounds (6), (7), and (8) may be used either individually or in combination of two or more.

[0180] As examples of the inorganic acids among the above-mentioned acidic catalysts, hydrochoird cacid, silfuric acid, littric acid, boric acid, properties acid, silfuric acid, nitric acid, properties acid, silfuric acid, properties acid, silfuric acid, silfuric acid, service acid service acid, service acid service acid, service acid service acid, service acid se

[0181] Of these acidic catalysts, hydrochloric acid, sulfuric acid, acetic acid, oxalic acid, malonic acid, maleic acid, furnaric acid, acetic anhydride, and maleic anhydride are particularly preferable.

25 [0182] These acidic catalysts may be used either individually or in combination of two or more.

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[0183] The acidic catalysts are usually used in the amount of 0.01-10,000 parts by weight, preferably 0.1~10, for 100 parts by weight of the silane compound.

[0184] As examples of inorganic bases among the above basic catalysts, lithium hydroxide, sodium hydroxide, potassium hydroxide, calcium hydroxide, barium hydroxide, sodium hydrogencarbonate, potassium arbonate, and po

[0185] The following compounds can be given as examples of organic bases: linear, branched, or cyclic monoalkylamines such as n-hexylamine, n-heptylamine, n-octylamine, n-nonyamine, n-decylamine, and cyclohexylamine; linear, branched, or cyclic dialkylamines such as di-n-butylamine, di-n-pentylamine, di-n-hexylamine, di-n-heptylamine, di-n-octylamine, di-n-nonylamine, di-n-decylamine, cyclohexylmethylamine, and dicyclohexylamine, linear, branched, or cyclic trialkylamines such as triethylamine, tri-n-propylamine, tri-n-butylamine, tri-n-pentylamine, tri-nhexylamine, tri-n-heptylamine, tri-N-octylamine, tri-n-nonylamine, tri-n-decylamine, cyclohexyldimethylamine, dicyclohexylmethylamine, and tricyclohexylamine; aromatic amines such as aniline, N-methylaniline, N,N-dimethylaniline, 2-methylaniline, 3-methylaniline, 4-methylaniline, 4-nitroaniline, diphenylamine, triphenylamine, and naphthylamine: aromatic diamines such as N,N,N',N'-tetramethylethylenediamine, tetramethylenediamine, hexamethylenediamine, 4,4'-diaminodiphenylmethane, 4,4'-diaminodiphenyl ether, 4,4'-diaminobenzophenone, 4,4'-diaminodiphenylamine, 2.2-bis(4-aminophenyl)propane, 2-(3-aminophenyl)-2-(4-aminophenyl)propane, 2-(4-aminophenyl)-2-(3-hydroxyphenyl)propane, 2-(4-aminophenyl)-2-(4-hydroxyphenyl)propane, 1,4-bis[1-(4-aminophenyl)-1-methylethyl]benzene, and 1,3-bis[1-(4-aminophenyl)-1-methylethyl]benzene; imidazoles such as imidazole, benzimidazole, 4-methylimidazole, and 4-methyl-2-phenylimidazole; pyridines such as pyridine, 2-methylpyridine, 4-methylpyridine, 2-ethylpyridine, 4-ethylpyridine, 2-phenylpyridine, 4-phenylpyridine, 2-methyl-4-phenylpyridine, nicotine, nicotinic acid, nicotinamide, quinoline, 8-oxyquinoline, and acridine; piperazines such as piperazine and 1-(2-hydroxyethyl)piperazine; as well as other nitrogen-containing heterocyclic compounds such as pyrazine, pyrazole, pyridazine, quinoxaline, purine, pyrrolidine, piperidine, morpholine, 4-methylmorpholine, 1,4-dimethylpiperazine, and 1,4-diazabicyclo[2.2.2]octane.

[0186] Of these basic catalysts, triethylamine, tri-n-propylamine, tri-n-butylamine, pyridine, and the like are prefera-

[0187] These basic catalysts may be used either individually or in combination of two or more. The basic catalysts are usually used in the amount of 0.01-10,000 parts by weight, preferably 0.1~10, for 100 parts by weight of the silane compound.

[0188] The use of an acidic catalyst in the preparation of polysiloxane (1) ensures a uniform and rapid polycondensation reaction accompanying hydrolysis, reducing the amount of hydrolysable groups in the raw material left unreacted in the resulting polymer, thereby minimizing absorption of radiation by the hydrolysable groups. Therefore, polycondensation under acidic conditions is more advantageous than polycondensation under basic conditions also with regard to the radiation transmittance in the wavelength range less than 193 nm.

[D189] Another advantage of carrying out the polycondensetion under acidic conditions is that the resulting polysicioxane (1) has a narrow molecular weight distribution. The radiation-sensitive resin composition prepared from such a polysiloxane (1) is less susceptible to a negative-tone reaction when exposed to radiation having a wavelength less than the deep ultraviolet region, whereby the resin composition exhibits improved achiesion properties to resist pattern substrates. Furthermore, resist patterns with a fine and excellent configuration can be obtained also in the case where the resist is developed using a common developer due to homogeneous dissolution of resist films. This is a feature manifestly observed when the resist is exposed to radiation with a wavelength of 193 mn or less.

[0190] Moreover, the polycondensation of a raw material silane compound under acidic conditions, followed by the addition of a basic catalyst to continue the reaction under basic conditions increases the degree of polymerization of the resulting polysiloxane (1). Such a polysiloxane has a higher Tg and exhibits more excellent characteristics as a result of increased crosslinking. However, when the polysiloxane (1) is used as a material for the radiation-sensitive resin composition, which is discussed later in this specification, it should be noted that the problem as to which type of polysiloxane (1), i.e. the polysiloxane (1) obtained only by the polycondensation under acidic conditions and the polysiloxane (1) obtained by the polycondensation under acidic conditions is preferred depends on the type of the radiation-sensitive resin composition.

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[0191] The polycondensation reaction under acidic conditions or basic conditions is preferably carried out in an inert gas atmosphere such as nitrogen or argon, whereby an advantage of a resist less susceptible to a negative-tone reaction can be ensured when forming a resist pattern using the radiation-sensitive resin composition.

[0192] - The following solvents can be given as the solvent used in the polycondensation reaction: linear or branched ketones such as 2-butanone, 2-pentanone, 3-methyl-2-butanone, 2-hexanone, 4-methyl-2-pentanone, 3-methyl-2-pentanone, 3,3-dimethyl-2-butanone, 2-heptanone, and 2-octanone; cyclic ketones such as cyclopentanone, 3-methylcyclopentanone, cyclohexanone, 2-methylcyclohexanone, 2,6-dimethylcyclohexanone, and isophorone; propylene glycol monoalkyl ether acetates such as propylene glycol monomethyl ether acetate, propylene glycol monoethyl ether acetate, propylene glycol mono-n-propyl ether acetate, propylene glycol mono-i-propyl ether acetate, propylene glycol mono-n-butyl ether acetate, propylene glycol mono-i-butyl ether acetate, propylene glycol mono-sec-butyl ether acetate, and propylene glycol mono-t-butyl ether acetate; alkyl 2-hydroxypropionates such as methyl 2-hydroxypropionate. ethyl 2-hydroxypropionate, n-propyl-2-hydroxypropionate, i-propyl 2-hydroxypropionate, n-butyl 2-hydroxypropionate, i-butyl 2-hydroxypropionate, sec-butyl 2-hydroxypropionate, and t-butyl 2-hydroxypropionate; alkyl 3-alkoxypropionates such as methyl 3-methoxypropionate, ethyl 3-methoxypropionate, methyl 3-ethoxypropionate, and ethyl 3-ethoxypropionate; alcohols suchas n-propylalcohol, i-propylalcohol, n-butylalcohol, t-butylalcohol, cyclohexanol, ethylene glycol monomethyl ether, ethylene glycol monoethyl ether, ethylene glycol mono-n-propyl ether, ethylene glycol monon-butyl ether, propylene glycol monomethyl ether, propylene glycol monoethyl ether, and propylene glycol mono-npropyl ether, dialkylene glycol dialkyl ethers such as diethylene glycol dimethyl ether, diethylene glycol diethyl ether. diethylene glycol di-n-propyl ether, diethylene glycol di-n-butyl ether, ethylene glycol monoalkyl ether acetates such as ethylene glycol monomethyl ether acetate, ethylene glycol monoethyl ether acetate, and ethylene glycol mono-npropyl ether acetate; aromatic hydrocarbons such as toluene and xylene; other esters such as ethyl 2-hydroxy-2-methylpropionate, ethyl ethoxyacetate, ethyl hydroxyacetate, methyl 2-hydroxy-3-methylbutyrate, butyl 3-methoxyacetate, butyl 3-methyl-3-methoxyacetate, butyl 3-methyl-3-methoxypropionate, butyl 3-methyl-3-methoxybutyrate, ethyl acetate, n-propyl acetate, n-butyl acetate, methyl acetoacetate, ethyl acetoacetate, methyl pyruvate, ethyl pyruvate; Nmethylpyrrolidone, N,N-dimethylformamide, N,N-dimethylacetamide, benzyl ethyl ether, dl-n-hexyl ether, diethylene glycol monomethyl ether, diethylene glycol monoethyl ether, caproic acid, caprylic acid, 1-octanol, 1-nonanol, benzylalcohol, benzyl acetate, ethyl benzoate, diethyl oxalate, diethyl maleate, γ-butyrolactone, ethylene carbonate, propylene carbonate; and the like.

[0193] These solvents may be used either individually or in combination of two or more.

45 [0194] These solvents are usually used in the amount of 2,000 parts by weight or less for 100 parts by weight of all of the silane compounds.

[0195] In addition, water may be added to the reaction mixture of the polycondensation reaction. The amount of water to be added is usually 10,000 parts by weight or less for 100 parts by weight of all of the silane compounds.

[0196] Furthermore, hexamethyldisiloxane may be added to the reaction mixture of the polycondensation reaction to control the molecular weight of the polysiloxane (1) and to increase stability.

[0197] The amount of hexamethyldisiloxane added is usually 500 parts by weight or less, and preferably 50 parts by weight criess, for 100 parts by weight of all of the slane compounds. If the amount of hexamethyldisiloxane exceeds 500 parts by weight, the resulting polymer tens to have a small molecular weight and a low glass transition temperature (Tr.)

[0198] The polycondensation reaction is carried out at a temperature of usually -50 to 300°C, and preferably 20 to 100°C, usually for a period of one minute to 100 hours.

[0199] In preparing the polysiloxane (1), one or more other silane compounds may be used together with the abovedescribed silane compounds (6), (7), and (8), or their partial condensates. [0200] As examples of the other silane compounds, a silane compound of the following formula (12) (hereinafter referred to as "silane compound (12")), a silane compound of the following formula (13) (hereinafter refer red to as "silane compound (13)"), a silane compound of the following formula (14) (hereinafter referred to as "silane compound (14"), and partial condensates of these silane compounds can be given.

[0201] "Partial condensate" herein indicates a linear oligomer formed from 2-10, preferably 2-5, silane molecules, or a cyclic oligomer formed from 3-10, preferably 3-5, silane molecules.

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[0202] In the formulas (12)-(14), B<sup>1</sup>, B<sup>2</sup>, and B<sup>3</sup> Individually represent a hydrogen atom, hydroxyl group, helogen atom, a substituted or unsubstituted alkyl group having 1-10 carbon atoms, a substituted or unsubstituted accessive group, substituted or unsubstituted accessive group, substituted or unsubstituted are unsubstituted accessive group, substituted or unsubstituted are likely group having 7-20 carbon atoms, or other monovalent organic groups having an oxygen atom; and P<sup>4</sup> and P<sup>5</sup> individually represent an alkyl group having 1-10 carbon atoms or halogenated alkyl group having 1-10 carbon atoms; provided that B<sup>1</sup>, B<sup>2</sup>, and B<sup>3</sup> do not include A<sup>1</sup> in the formula (6) or A<sup>2</sup> in the formula (7).

[0203] As examples of the halogen atom shown by B<sup>1</sup>, B<sup>2</sup>, and B<sup>3</sup> in the formulas (12) to (14), chlorine atom, bromine atom, and lodine atom can be given.

[0204] The following groups can be given as examples of the substituted or unsubstituted alkyl group having 1-10 carbon atoms represented by the group B³, B², or B³: methyl group, eithyl group, n-propyl group, p-propyl group, n-butyl group, n-butyl group, n-betyl group, n-heptyl group,

[0205] As examples of the substituted or unsubstituted alkoxyl group having 1-10 carbon atoms represented by Bt, Bt, or Bt, methoxy group, ethoxy group, p-tropoxy group, t-propoxy group, b-tutoxy group, chlohoxylory group, alto property group, alto property group, But property group, 2-chlorosethoxy group, 2-chlorosethoxy group, 2-chlorosethoxy group, 2-chlorosethoxy group, 2-chlorosethoxy group, 2-chlorosethoxy group, 3-chlorosethoxy group, 3-chlorosethoxy group, 3-chlorosethoxy group, 3-chlorosethoxy group, 3-chlorosethoxy group, 3-chlorosethoxy group, alto group, and 3-chlorosethoxyloy group can be given.

[0206] As examples of the substituted or unsubstituted accoxy group represented by B1, B2, or B3, acetoxy group,

trifluoroacetoxy group, chloroacetoxy group, and bromoacetoxy group can be given.

[0207] As examples of the as substituted or unsubstituted any group having 6-15 carbon atoms represented by B1, B2, or B3, pheny; group, o-tolyt group, m-tolyt group, α-naphthy group, β-thurophenyl group, 3-fluorophenyl group, 4-fluorophenyl group, 4-fluorophenyl

[0208] As examples of the as substituted or unsubstituted arallyl group having 7-20 carbon atoms represented by 81, B2, or 83, benzyl group, phenethyl group, 2-fluorobenzyl group, 3-fluorobenzyl group, 4-fluorobenzyl group, 4-brobenzyl group, 4-brobenzyl group, 4-brobenzyl group, 4-brobenzyl group, 4-brobenzyl group, 4-brobenzyl group, 5-methoxybenzyl group, 3-methoxybenzyl group, 2-methoxybenzyl group, 3-methoxybenzyl group, 3-methoxybenzyl group, 3-frimedtyslichysbenzyl group, 3-methoxybenzyl group, 3-methoxybenzyl group, 3-frimedtyslichysbenzyl group, 3-frimedtyslichysbenzyl group, 3-frimedtyslichysbenzyl group, 5-frimedtyslichysbenzyl group, 5-frimedtyslichyslichysbenzyl group, 5-frimedtyslichysbenzyl group, 5-frimedtyslichysbenzy

zyl group can be given.

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[0209] As examples of the other oxygén-containing monovalent groups represented by B<sup>1</sup>, B<sup>2</sup>, and B<sup>3</sup>, the groups shown by the formulas (15) and (16) can be given.

wherein P' indicates a methylene group, diffuoromethylene group, fluoroalkylene group having 2-20 carbon atoms, divalent aromatic group having 3-20 carbon atoms, or other divalent alloyclic groups having 3-20 carbon atoms.

[2210] As examples of the fluoroalkylone groups having 2-20 carbon atoms, divalent aromatic groups having 6-20 carbon atoms, and other divalent alloyable groups having 3-20 carbon atoms represented by P in the formulas (15) and (16), the same corresponding groups previously given as examples of the group P in the formula (9) can be given. [0211]

As the group P in the formulas (15) and (16), a diffuoromethylene group, a divalent hydrocarbon group having an adamantine skeleton, its halide derivative, and the like are preferable. The group corresponded to the following formula (17) is particularly treferable. The group corresponded to the following formula (17) is articularly treferable.

wherein R individually represents a hydrogen atom or a methyl group, Rf represents a hydrogen atom, methyl group, or trifluoromethyl group, and n is an integer of 0-3.

[0212] As examples of the alkyl group or halogeniated alkyl groups having 1-10 carbon atoms represented by R<sup>4</sup> or , R<sup>5</sup> in the formulas (12) to (14), a methyl group, ethyl group, n-popyl group, i-propyl group, n-butyl group, b-butyl group, sec-butyl group, t-butyl group, n-betyl group, n-betyl group, n-betyl group, n-decyl group, cyclopentyl group, group, group, m-decyl group, and trifluctoremethyl group, group be given.

[0213] If at least one compound selected from the group consisting of the silane compounds (12)- (14) and their partial condensates is condensed together with the silane compound (6) and/or silane compound (7), or their patial condensates, the molecular weight and glass transition temperature (1g) of the resulting polysiloxane (1) can be adequately controlled so that transparency at the wavelength of 193 nm, particularly preferable 157 nm, can be further improved.

[0214] The total amount of the silane compound (12), silane compound (13), and silane compound (14) is usually 80 wt% or less, preferably ~50 wt%, and particularly preferably ~ wt%, for 100 wt% of all silane compounds. If this total amount exceeds 80 wt%, resolution of the resulting radiation-sensitive resin composition tends to be impaired.

#### Preparation of polysiloxane (3)

[0215] Polysiloxane (3) can be prepared by the polycondensation of at least one component selected from the group consisting of the silicon-containing alicyclic compound (2) having m = 0 or 1 and n = 1.3 in the formula (2-A) [hereinatier referred to as "silicon-containing alicyclic compound (2"), in the presence of an acidic catalyst or a basic catalyst using

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- or without using a solvent in the same manner as in the case of polysiloxane (1). The process preferably includes a polycondensation reaction step using an acidic catalyst.
- [0216] Here, "the linear of cyclic oligomer prepared by partial condensation of the silicon-containing allicyclic compound (2")" indicates oligomers of usually 2-10 molecules, preferably 2-5 molecules, in the case of linear oligomers, and usually 3-10 molecules, preferably 3-5 molecules in the case of the cyclic oligomers, each oligomer being formed by the condensation of the Si-OR3 groups in the silicon-containing allevelic compounds.
- [0217] In preparing the polysiloxane (3), silicon containing alicyclic compound (2') may be used either individually or in combination of two or more.
- [02:18] The use of an acidic catalyst in the preparation of polysiloxane (3) ensures a uniform and rapid polycondensation reaction accompanying hydrolysis, reducing the amount of hydrolysable groups in the raw material left unreacted in the resulting polymer, thereby minimizing absorption of radiation by the hydrolysable groups. Therefore, polycondensation under acidic conditions is more advantageous than polycondensation under basic conditions also with regard to the radiation transmittance in the wavelength range less than 193 mr.
  - 10219] Another advantage of carrying out the polycondensation under acidic conditions is that the resulting polysiticxane (3) has a narrow molecular weight distribution. The radiation-sensitive realn composition prepared from such a polysitioxane (3) is less susceptible to a negative-tone reaction when exposed to radiation having a wavelength less than the deep ultraviolet region, whereby the resin composition exhibits improved adhesion properties to resist patters with a fine and excellent configuration can be obtained also in the case where the resist is developed using a common developer due to homogeneous dissolution of resist films: This is a feature manifestly observed when the resist is exposed to radiation with a wavelength of 198 nm or less.
  - [IZ20] Moreover, in the preparation of polysiloxane (3), the polycondensation of a raw material compound under acidic conditions, followed by the addition of a basic catalyst to continue the reaction under acidic conditions increases the degree of polymerization of the resulting polysiloxane (3). Such a polysiloxane has a higher Tg and exhibits more excellent characteristics as a result of increased crosslinking. However, when the polysiloxane (3) is used as a material for the radiation-sensitive resin composition, which is discussed later in this specification, it should be noted that the problem as to which type of polysiloxane (3), i.e. the polysiloxane (3) obtained only by the polycondensation under acidic conditions and the polysiloxane (3) obtained by the polycondensation under acidic conditions followed by basic conditions is preferred decended on the type of the radiation-sensitive resin composition.
- [0221] In preparing the polysiloxane (3), one or more other silane compounds may be used together with the silicon containing alicyclic compound (2') or their partial condensates.
  - [0222] As above-described other silane compounds, the silicon-containing alicyclic compound (2) having m = 0 or 1 and n = 0 in the formula (2-A), silicon-containing alicyclic compound (2) having m = 2 in the formula (2-A), silicon-containing alicyclic compound (4), silane compound (4), silane compound (13), and silane compound (14), and their partial condensates can be given.
- 10223] Use of these other silane compounds, particularly the silane compound (12) or its partial condensates, in the polycondensation reaction ensures adequate control of the molecular weight and glass transition temperature (7g) of the resulting polysiloxane (3), whereby transparency at the wavelength of 198 mm, particularly preferable 167 mm, can be further improved. The total amount of the other silane compounds is usually 80 vt% or less, preferably 50 vt% or less, and particularly preferable 20 vt% or less of the total amount of the silicon-containing alicyclic compound (2) and the other silane compounds. If this total amount exceeds 80 vt%, resolution of the resulting radiation-sensitive resin

# composition tends to be impaired. Preparation of polysiloxane (5)

- 45 [0224] Polysiloxane (5) can be prepared by the polycondensation of at least one component selected from the group consisting of the silicon-containing alloyclic compound (4) having m = 0 or 1 in the formula (4) reinerinater released to as "silicon-containing alloyclic compound (4)") and a linear or cyclic oligomer prepared by partial condensation of the silicon-containing alloyclic compound (2), in the presence of an acidic catalyst or a basic catalyst using or without using a solvent in the same manner as in the case of polysiloxane (1). The process preferably includes a polycondensation reaction step using an acidic catalyst.
  - [0225] Here, "the linear of cyclic oligomer prepared by partial condensation of the silicon-containing alicyclic compound (4)" indicates oligomers of usually 2-10 molecules, preferably 2-5 molecules, in the case of linear oligomers, and usually 3-10 molecules, preferably 3-5 molecules, in the case of the cyclic oligomers, each oligomer being formed by the condensation of the Si-OR3 groups in the silicon-containing alicyclic compounds.
- 55 [0226] In preparing the polysiloxane (5), silicon containing allcyclic compound (4') may be used either individually or in combination of two or more.
  - [0227] The use of an acidic catalyst in the preparation of polysiloxane (5) ensures a uniform and rapid polycondensation reaction accompanying hydrolysis, reducing the amount of hydrolysable groups in the raw material left unreacted

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in the resulting polymer, thereby minimizing absorption of radiation by the hydrolysable groups. Therefore, polycondensation under acidic conditions is more advantageous than polycondensation under basic conditions also with regard to the radiation transmittance in the wavelength range less than 193 nm.

[0228] Another advantage of carrying out the polycondensation under acidic conditions is that the resulting polysiloxane (5) has a narrow molecular wieight distribution. The radiation-sensitive resin demoposition prepared from such a polysiloxane (5) is less susceptible to a negative-tone reaction when exposed to radiation having a wavelength less than the deep ultraviolar region, whereby the resin composition exhibits improved adhesion properties to resist pattern substrates. Furthermore, resist patterns with a fine and excellent configuration can be obtained also in the case where the resist is developed using a common developer due to homogeneous dissolution of resist films. This is a feature manifestly observed when the resist is exposed to maliation with a wavelength of 198 run or less.

[0229] Moreover, in the preparation of polysiloxane (5), the polycondensation of a raw material compound under acidic conditions, followed by the addition of a basic catalyst to continue the reaction under acidic conditions increases the degree of polymerization of the resulting polysiloxane (5). Such a polysiloxane has a higher T gand exhibits more excellent characteristics as a result of increased crosslinking. However, when the polysiloxane (5) is used as a material for the radiation-sensitive resin composition, which is discussed later in this specification, it should be noted that the problem as to which type of polysiloxane (5), i.e. the polysiloxane (5) obtained only by the polycondensation under acidic conditions and the polysiloxane (3) obtained by the polycondensation under acidic conditions followed by basic conditions is preferred deponds on the type of the radiation-sensitive resin composition.

[0230] In preparing the polysiloxane (5), one or more other silane compounds may be used together with the silicon containing alloyelic compound (4') or their partial condensates.

[0231] As the above-described other silane compounds, the silicon-containing alicyclic compound (2), the siliconcontaining alicyclic compound (4) having m = 2 in the formula (4-A), silane compound (8), silane compound (12), silane compound (13), and silane compound (14), and their partial condensates can be given.

[0232] Use of these other silane compounds, particularly the silane compound (12) or its partial condensates, in the polycondensation reaction ensures adequate control of the molecular weight and glass transition temperature (Tg) of the resulting polysiloxane (5), whereby transparency at the wavelength of 193 nm, particularly preferable 157 nm, can be further improved. The total amount of the other silane compounds is usually 80 wt% or less, preferably 50 wt% or less and particularly preferably 20 wt% or less of the total amount of the siltcont-containing alloyclic compound (4) and the other silane compounds. If this total amount exceeds 80 wt%, resolution as a resist tends to be impaired.

10 [0233] The silicon-containing alicyclic compound (5) in which Z is a monovalent organic group dissociating hydrogen atoms by the action of an acid can be synthesized from polysiloxane (5) in which Z is a hydrogen atom by replacing the hydrogen atom of the hydroxyl group of this compound with a monovalent organic group dissociating hydrogen atoms by the action of an acid.

[0234] More particularly, the above method can be carried out as follows, for example.

[0235] (When Z is a t-butoxycarbonyl group, a method of esterifying the hydroxyl group in the raw polymer with dit-butyl carbonate in the presence of a catalytic amount of 4-dimethylaminopyridine.

[0236] ((iii)) When Z is a tetrahydropyranyl group, a method of effecting an addition reaction to the hydroxyl group in the raw polymer with 2,3-dihydro-4H-pyrane according to a conventional method.

[0237] (7)When Z Is an acetal group such as a 1-elkoxyethyl group, a method of effecting an addition reaction to the hydroxyl group in the raw polymer with a corresponding alkylvinyl ether according to a conventional method.

[D238] The above methods (b) o(\$\infty\$ can be carried out usually using a suitable solvent. The solvents previously given in the description relating to the method(\$\infty\$) for the preparation of the silicon containing allcyclic compound (2) and silicon containing allcyclic compound (4) can be given as examples of the solvent used here. The reaction conditions, such as a reaction temperature and reaction time, are appropriately determined according to the method employed, types of reacents used, and the like 1.

[0239] In particular, the method ⑤can efficiently produce the polysiloxane (4) in which the group Z is a monovalent organic group dissociating hydrogen atoms by the action of an acid. On the other hand, it is difficult to obtain the target compound by using a sodium hydride catalyst which is used to replace a hydroxyl group in common organic compounds with a 1-butoxycarbonyl group.

## Radiation-sensitive resin composition

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[0240] The following compositions can be given as examples of the preferable radiation-sensitive resin composition of the present invention.

(1) A radiation-sensitive resin composition containing (a) a resin comprising an alkali insoluble or alkali low soluble polysiloxane (1), which becomes soluble in alkali when an acid-dissociable group dissociates, and (b) a photoacid generator (heroinafter referred to as "radiation-sensitive resin composition (1)"). (2) A radiation-sensitive resin composition containing (a) a resin comprising an alkali insoluble or alkali low soluble polysiloxane (5') and/or an alkali insoluble or alkali low soluble polysiloxane (5), which becomes soluble in alkali when an acid-dissociable group dissociates, and (b) a photoacid generator (hereinafter referred to as \*radiationsensitive resin composition (2)").

[0241] The component (a) in the radiation-sensitive resin composition (1) preferably comprises a polysiloxane which comprises at least one of the structural units (i-1) and (i-2) and/or a polysiloxane which comprises at least one of the structural units (i-1) and (i-2) and (i

[0242] The polysilloxane (3') in the radiation-sensitive resin composition (3') comprises the structural unit (I-1') and/ or the structural unit (I-2') and has a Mw of 500-1,000,000. The group shown by the following formula (iii) can be given as an example of the monovalent organic group dissociating hydrogen atoms by the action of an acid represented by 7' in the formula (3').

wherein R¹ individually represents a linear or branched alkyl group having 1-4 carbon atoms or a monovalent alkyolic hydrocarbon group having 3-20 carbon atoms or a derivative thereof, or any two of R¹s form in combination a divisient alkyolic hydrocarbon group having 3-20 carbon atoms or a derivative thereof, with the remaining R¹ being a linear or branched alkyl group having 1-4 carbon atoms or a monovalent alkyolic hydrocarbon group having 3-20 carbon atoms or a derivative thereof.

[0243] As examples of the linear or branched alkyl group having 1-4 carbon atoms represented by R' in the formula (iii), a methyl group, ethyl group, n-propyl group, h-propyl group, n-butyl group, 2-methylpropyl group, 1-methylpropyl group, and be given.

[0244] As examples of the monovalent alicyclic hydrocarbon group having 3-20 carbon atoms and the divalent alicyclic hydrocarbon group having 3-20 carbon atoms formed by two Ris in combination, alicyclic groups derived from a cycloelikane such as norbornane, tricyclodecane, tetracyclodedecane, adamantine, cyclopropane, cyclobutane, cyclopranane, cyclohextane, cyclobutane, groups obtained by replacing hydrogen atoms on these alicyclic groups with above-mentioned one or more alkyl groups having 1-4 carbon atoms can be given.

[0245] Of these groups of the formula (iii), the group having a methyl group for R' (corresponding to the recurring unit forming the polysiloxane (3)) is ideal.

# Acid generator (b)

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[0246] The acid generator (b) used in the radiation-sensitive resin composition (1) or the radiation-sensitive resin composition (2) is a component generating an acid by exposure to radiation. The acid causes an acid-dissociable group in the resin to dissociate. As a result, an exposed part of the resist film becomes readily soluble in an alkiline developer, thereby forming a positive-tone resist pattern.

[0247] As examples of the acid generator (b), onlum salts, halogen-containing compounds, diazoketone compounds, sulfone compounds, and sulfonate compounds can be given.

[0248] Examples of the acid generator (b) are given below.

# Onium salts:

[0249] As examples of onium salts, iodonium salts, sulfonium salts (including tetrahydrothiophenium salts), phosphonium salts, dazonium salts, and pyridinium salts can be given.

[0250] Specific examples of preferable onium salts include:

diphenyliodonium trifluoromethanesulfonate, diphenyliodonium nonafluoro-n-butanesulfonate, diphenyliodonium heptadecafluoro-n-octanesulfonate, diphenyliodonium pyrenesulfonate, diphenyliodonium n-dodecy/berrenesulfonate, diphenyliodonium hexafluoroantimonate, diphenyliodonium naphthalenesulfonate, bis(4-t-buty/phenyl)lodonium triluoromethanesulfonate, bis(4-t-buty/phenyl)lodonium nonafluoro-n-butanesulfonate, bis(4-t-buty/phenyl)lodonium heptadecafluoro-n-octanesulfonate, bis(4-t-buty/phenyl)-dodecy/benzenesulfonate, bis(4-t-buty/phenyl) odonium hexafluoroantimonate, bis(4-t-buty/phenyl) iodonium naphthalenesulfonate, triphenylisulfonium trifluoromethanesulfonate, triphenylisulfonium nonafluoro-n-butanesulfonate, triphenylisulfonium heptadecafluoro-n-octanesulfonate,

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triphenylsulfonium pyrenesulfonate, triphenylsulfonium n-dodecylbenzenesulfonate, triphenylsulfonium hexafluoroantimonate, triphenylsulfonium naphthalenesulfonate, triphenylsulfonium 10-camphorsulfonate, 4-hydroxyphenyl-phenyl-methylsulfonium, p-toluenesulfonate, cyclohexyl-2-oxocyclohexyl-methylsulfonium trifluoromethanesulfonate, cyclohexyl-2-oxocyclohexyl-methylsulfonium trifluoromethanesulfonium trifluoromethanesulfonium trifluoromethanesulfonium trifluoromethylsulfonium trifluoromethanesulfonium trifluoromethylsulfonium trifluor clohexyl-2-oxocyclohexyl-methylsulfonium nonafluoro-n-butanesulfonate, cyclohexyl-2-oxocyclohexyl-methylsulfonium nium heptadecafluoro-n-octanesulfonate, dicyclohexyl-2-oxocyclohexylsulfonium trifluoromethanesulfonate, dicyclohexyl-2-oxocyclohexylsulfonium nonafluoro-n-butanesulfonate, dicyclohexyl-2-oxocyclohexylsulfonium heptadecafluoro-n-octanesulfonate, 2-oxocyclohexyldimethylsulfonium trifluoromethanesulfonate, 2-oxocyclohexyldimethylsulfonium nonafluoro-n-butanesulfonate, 2-oxocyclohexyldimethylsulfonium heptadecafluoro-n-octanesulfonate, 4-hydroxyphenyl-benzyl-methylsulfonium p-toluenesulfonate, triphenylsulfonium perfluoro-n-octanesulfonate, 1-naphthyldimethylsulfonium trifluoromethanesulfonate, 1-naphthyldimethylsulfonium nonafluoro-n-butanesulfonate, 1-naphthyldimethylsulfonium nonafluoro-n-butanesulfonium nonafluoro-n-butanesulfoni thyldimethylsulfonium heptadecafluoro-n-octanesulfonate, 1-naphthyldiethylsulfonium trifluoromethanesulfonate, 1-naphthyldiethylsulfonium nonafluoro-n-butanesulfonate, 1-naphthyldiethylsulfonium heptadecafluoro-n-octanesulfonate, 4-cyano-1-naphthyldimethylsiulfonium trifluoromethanesulfonate, 4-cyano-1-naphthyldimethylsiulfonium nonafluoro-n-butanesulfonate, 4-cyano-1-naphthyldimethylsulfonium heptadecafluoro-n-octanesulfonate, 4-cyano-1-naphthyldiethylsulfonium trifluoromethanesulfonate, 4-cyano-1-naphthyldiethylsulfonium nonafluoro-n-butanesulfonate, 4-cyano-1-naphthyldiethylsulfonium heptadecafluoro-n-octanesulfonate, 4-nitro-1-naphthyldimethylsulfonium trifluoromethanesulfonate, 4-nitro-1-naphthyldimethylsulfonium nonafluoro-n-butanesulfonate, 4-nitro-1-naphthyldimethylsulfonium heptadecafluoro-n-octanesulfonate, 4-nitro-1-naphthyldiethylsulfonium trifluoromethanesulfonate 4-nitro-1-naphthyldiethylsulfonium nonafluoro-n-butanesulfonate, 4-nitro-1-naphthyldiethylsulfonium heptadecafluoro-20 n-octanesulfonate, 4-methyl-1-naphthyldimethylsulfonium trifluoromethanesulfonate, 4-methyl-1-naphthyldimethylsulfonium nonafluoro-n-butanesulfonate, 4-methyl-1-naphthyldimethylsulfonium heptadecafluoro-n-octanesulfonate, 4-methyl-1-naphthyldiethylsulfonium trifluoromethanesulfonate, 4-methyl-1-naphthyldiethylsulfonium nonafluoro-nbutanesulfonate, 4-methyl-1-naphthyldiethylsulfonium heptadecafluoro-n-octanesulfonate, 4-hydroxy-1-naphthyldiethylsulfonium imethylsulfonium trifluoromethanesulfonate, 4-hydroxy-1-naphthyldimethylsulfonium nonafiuoro-n-butanesulfonate, 4-hydroxy-1-naphthyldimethylsulfonium heptadecafluoro-n-octanesulfonate, 4-hydroxy-1-naphthyldiethylsulfonium trifluoromethanesulfonate, 4-hydroxy-1-naphthyldiethylsulfonium nonafluoro-n-butanesulfonate, 4-hydroxy-1-naphthyldiethylsulfonium heptadecafluoro-n-octanesulfonate, 4-hydroxy-1-naphthyltetrahydrothiophenium trifluoromethanesulfonate, 4-methoxy-1-naphthyltetrahydrothiophenium trifluoromethanesulfonate, 4-ethoxy-1-naphthyltetrahydrothiophenium trifluoromethanesulfonate, 4-methoxymethoxy-1-naphthyltetrahydrothiophenium trifluoromethanesulfonate, 4-ethoxymethoxy-1-naphthyltetrahydrothiophenium trifluoromethanesulfonate, 4-(1'-methoxyethoxy)-1-naphthyltetrahydrothiophenium trifluoromethanesulfonate, 4-(1'-methoxyetho thyltetrahydrothiophenium trifluoromethanesulfonate, 4-(2'-methoxyethoxy)-1-naphthyltetrahydrothiophenium trifluoromethanesulfonate, 4-methoxycarbonyloxy-1-naphthyltetrahydrothiophenium trifluoromethanesulfonate, 4-ethoxycar $bonyloxy-1-naphthyltetrahydrothlophenium\ trifluoromethan esulfonate, 4-n-propoxycarbonyloxy-1-naphthyltetrahydrothlophenium\ trifluoromethan esulfonate, 4-n-propoxycarbonyloxy-1-naphthyltetrahydr$ thiophenium triffuoromethanesulfonate, 4-l-propoxycarbonyloxy-1-naphthyltetrahydrothlophenium trifluoromethane-35 sulfonate, 4-n-butoxycarbonyloxy-1-naphthyltetrahydrothiophenium trifluoromethanesúlfonate, 4-t-butoxycarbony $loxy-1-naphthy/tetrahydrothiophenium\ trifluoromethanesulfonate,\ 4-(2'-tetrahydrofuranyloxy)-1-naphthy/tetrahydrothiophenium\ trifluoromethanesulfonate,\ 4-(2'-tetrahydrofuranyloxy)-1-naphthy/tetrahydrofuranyloxy)-1-naphthy/tetrahydrofuranyloxy-1-naphthy/tetrahydrofuranyloxy-1-naphthy/tetrahydrofuranyloxy-1-naphthy/tetrahydrofuranyloxy-1-naphthy/tetr$ ophenium trifluoromethanesulfonate, 4-(2'-tetrahydropyranyloxy)-1-naphthyltetrahydrothiophenium trifluoromethane sulfonate, 4-benzyl oxy-1-naphthyltetrahydrothiophenium trifluoromethanesulfonate, 1- (1' -naphthylacetomethyltet $rahydrothiophenium\,trifluoromethane\,sulfonate, 4-n-but oxy-1-naphthyl tetrahydrothiophenium\,nonafluoro-n-but ane sulfonate, 4-n-but oxy-1-naphthyl tetrahydrothiophenium nonafluoro-n-but ane sulfonate, 4-n-but oxy-1-naphthyl tetrahydrothiophenium nonafluoro-n-but ane sulfonate, 4-n-but oxy-1-naphthyl tetrahydrothiophenium nonafluoro-n-but ane sulfonate (1-n-but oxy-1-naphthyl tetrahydrothiophenium nonafluoro-n-but o$ fonate.

#### Halogen-containing compounds:

[0251] As examples of halogen-containing compounds, haloalkyl group-containing hydrocarbon compounds, haloalkyl group-containing heterocyclic compounds, and the like can be given.

[0252] As specific examples of preferable halogen-containing compounds, (trichloromethyl)-s-triazine derivatives such as phenylibia(trichloromethyl)-s-triazine, 4-methoxyphenylibia(trichloromethyl)-s-triazine, and 1-naphthylbia (trichloromethyl)-s-triazine, 1,1-bis(4'-chlorophenyl)-2,2,2-trichloroethane, and the like can be given.

# 50 Diazoketone compounds:

[0253] As examples of diazoketone compounds, 1,3-diketo-2-diazo compounds, diazobenzoquinone compounds, diazonaphthoquinone compounds, and the like can be given.

[0254] As specific examples of preferable diazoketone compounds, 1,2-naphthoquinonediazido-4-sulfonyi chloride, 1,2-naphthoquinonediazido-4-sulfonyi chloride, 1,2-naphthoquinonediazido-4-sulfonate or 1,2-naphthoquinonediazido-5-sulfonate or 1,2-naphthoquinonediazido-4-sulfonate or 1,2-naphthoquinonediazido-5-sulfonate or 1,2-naphthoquinonediazido-5-sulfonate or 1,1-1-tis(4-hydroxyphenyi)ethane, and the like can be given.

## Sulfone compounds:

[0255] As examples of sulfone compounds, β-ketosulfone, β-sulfonylsulfone, α-diazo compounds of these compounds, and the like can be given.

[0256] As specific examples of preferable sulfone compounds, 4-trisphenacylsulfone, mesitylphenacylsulfone, bis (phenylsulfony)methane, and the like can be given.

# Sulfonate compounds:

[0257] As examples of sulfonate compounds, alkyl sulfonate, alkylimide sulfonate, haloalkyl sulfonate, anyl sulfonate, limino sulfonate, and the like can be given.

imino suffonate, and the like can be given. 
[0258] As specific examples of suffonate compounds, benzolntosylate, pyrogallol tris (trifluoromethanesulfonate), 
nitrobenzyl-9,10-diethroxyanthracene-2-sulfonate, trifluoromethanesulfonybloydo[2,2,1]hepto-5-ene-2,3-dicar bodiminde, N-hydroxysucchimidetrifluoromethanesulfonate, and 1,8-naphthalenedicarboxylic acid imide trifluoromethaanesulfonate can be given. Of the above acid generators (b), the following compounds are preferable: diphenyliodomuntrifluoromethanesulfonate, bigl4-butylphenyliodonlum trifluoromethanesulfonate, bigl4-butylphenyliodonlum trifluoromethanesulfonate, bigl4-butylphenyliodonlum trifluoromethanesulfonate, triphenylsulfonium trifluoromethanesulfonate, bigl4-butylphenyliodonlum trifluoromethanesulfonate, acyclohacyl-acyclohacyclohacyl-acyclohacyl-acyclohacyl-acyclohacyl-acyclohacyl-acyclohacyl-acyclohacyl-acyclohacyl-acyclohacyl-acyclohacyl-acyclohacyl-acyclohacyl-acyclohacyl-acyclohacyclohacyl-acyclohacyclohacyl-acyclohacyclohacyclohacyl-acyclohacyclohacyl-acyclohacyclohacyclohacyclohacyclohacyl-acyclohacyclohacyclohac

[0259] The acid generator (b) may be used either individually or in combination of two or more.

[0260] The amount of the acid generator (b) to be used in the radiation-sensitive reain composition (1) and radiation-sensitive reain composition (2) is usually 0.1-10 parts by weight, and preferably 0.5-7 parts by weight for 100 parts by weight of the resin from the Viewpoint of ensuring sensitivity and developability as a resist. If the amount of the acid generator (b) is less than 0.1 part by weight, sensitivity and developability tend to decrease. If the amount exceeds 10 parts by weight, a rectangular resist pattern may not be obtained due to decreased radiation transmittance.

# Additives

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[0261] It is preferable to add an acid diffusion controller to the radiation-sensitive resin composition (1) and radiationsensitive resin composition (2). The eight diffusion controller controls diffusion of an acid generated from the acid generator (b)-upon exposure in the resist film to suppress unfavorable chemical reactions in the unexposed area.

(D262) The addition of such an add diffusion controller improves storage stability of the resulting composition and resolution as a resist. Moreover, the addition of the acid diffusion controller prevents the line width of the resist pattern from changing due to changes in the post-exposure delay (PED) between exposure or development, whereby a composition with remarkably superior process stability can be obtained. As the acid diffusion controller; organic compounds containing nitrogen of which the basicity does not change during exposure or heating for forming a resist pattern are preferable.

[0263] As examples of such nitrogen-containing organic compounds, a compound shown by the following formula (18) (hereinafter called "nitrogen-containing compound (17)).

wherein R<sup>6</sup> individually represents a hydrogen atom, a substituted or unsubstituted alxyl group, substituted or unsubstituted aryl group, or substituted or unsubstituted are layl group, a compound having two nitrogen atoms in the molecule (hereinafter referred to as "nitrogen-containing compound ②), a polymer having three or more nitrogen atoms in the molecule (hereinafter referred to as "nitrogen-containing compound ③), an arriide group-containing compound, urea compound, nitrogen-containing heterocyclic compound, and the like cen be given.

[0264] The following compounds can be given as examples of the nitrogen-containing compound linear, branched,

or cyclic monoalkylamines such as n-haxylamine, n-heptylamine, n-octylamine, n-nonyamine, n-decylamine, and cyclohexylamine; linear, branched, or cyclic dialkylamines such as di-n-butylamine, di-n-pentylamine, di-n-hexylamine, di-n-heptylamine, di-n-ocylamine, di-n-nonylamine, di-n-decylamine, cyclohexylmothylamine, and dicyclohexylamine; linear, branched, or cyclic trialkylamines such as triethylamine, tri-n-propylamine, tri-n-butylamine, tri-n-pentylamine, tri-n-hexylamine, tri-n-heptylamine, tri-n-ocylamine, tri-n-nonylamine, tri-n-decylamine, cyclohexyldmethylamine, dicyclohexylmethylamine, and tricyclohexylamine; aromatic amines such as aniline, N-methylamiline, N-idimethylaniline, 2-methylamine, 3-methylaniline, 4-methylaniline, 4-nitroaniline, diphenylamine, triphenylamine, and naphthylamine: and the like.

[0265] Examples of the nitrogen-containing compound @nclude eithylenediamine, N,N,N',N'-tetramethylenediamine, tetramethylenediamine, hexamethylenediamine, 4.4"-diaminodiphenylmethane, 4.4"-diaminodiphenyl either, 4.4"-diaminodiphenylmethane, 4.4"-diaminodiphenylmethane, 2.4"-diaminophenyl) 2-(4"-aminophenyl) 2-(4"-

[0266] Examples of the nitrogen-containing compounds @include polyethyleneimine, polyallylamine, a polymer of 2-dimethylaminoethylacrylamide, and the like.

[0267] Examples of compounds containing an amide group include formamide, N-methylformamide, N-methylacetamide, N-methylacetamide, N-methylacetamide, N-methylacetamide, N-methylacetamide, pyrolidone, N-methylyprolidone, and the like.

[0268] Examples of the urea compounds include urea, methylurea, 1,1-dimethylurea, 1,3-dimethylurea, 1,1,3,3-te-tramethylurea, 1,3-diphenylurea, 1-n-butylthiourea, and the like. Examples of the nitrogen-containing heterocyclic compounds include: Imidazoles such as imidazole, barnidazole, 4-methylimidazole, and 4-methyl-2-phenylimidazole, pyridines such as pyridine, 2-methylpyridine, 2-methylpyridine, 2-methylpyridine, 2-methylpyridine, 2-methylpyridine, 2-methyl-2-phenylpyridine, 2-methyl-2-phenylpyridine, 2-methyl-2-phenylpyridine, and acridine, piperazines such as piperazine, 1-(2-hydroxyethyl)piperazine, pyrazole, pyrazole, pyridazine, quinoxaline, purine, pyrrolidine, piperazine, 1,4-diamethylpiperazine, 1,4-

[0269] Of these nitrogen-containing organic compounds, the nitrogen-containing organic compounds () and the nitrogen-containing heterocyclic compounds are preferable. Among the nitrogen-containing organic compounds () tri (cyclo) alkylamines are particularly preferable. Among the nitrogen-containing heterocyclic compounds, pyridines and piperazines are particularly preferable.

[0270] The acid diffusion controller may be used either individually or in combination of two or more.

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[0271] The amount of the acid diffusion controller to be added to the radiation-sensitive resin composition (1) or the radiation-sensitive resin composition (2) is usually 15 parts by weight or less, preferably 10 parts by weight or less, and still more preferably 5 parts by weight or less, and still more preferably 5 parts by weight or less for 100 parts by weight of the resin. If the proportion of the acid diffusion controller exceeds 15 parts by weight, sensitivity as a resist and developability of the exposed area tend to decrease. If the amount is less than 0.001 part by weight, the pattern shape or dimensional accuracy as a resist may decrease depending on the processing conditions.

[0272] Surfactants which improve applicability, developability, or the like may be added to the radiation-sensitive resin composition (1) and the radiation-sensitive resin composition (2).

[0273] As examples of surfactants, nonionic surfactants such as polyoxyethylene lauryl ether, polyoxyethylene estearyl ether, polyoxyethylene oleyl ether, polyoxyethylene neotyl phenyl ether, polyoxyethylene neonyl phenyl ether, polyoxyethylene glycol dilaurate, polyethylene glycol distearate; commercially available products such as KP341 (manufactured by Shihr-Etsu Chemical Co., Ltd.), Polyllow No. 75, No. 95 (manufactured by Kyoeisha Chemical Co., Ltd.), FTOP EF301, EF303, EF303, EF305 (manufactured by TOHKEM PRODUCTS CORPORATION), MEGAFAC F171, F173 (manufactured by Dainippon Ink and Chemicals, Inc.), Fluorard Fc430, Fc431 (manufactured by Smintoms 3M Ltd.), Asahi Guard AG710, Surflon S-382, SC-101, SC-102, SC-104, SC-105, SC-106 (manufactured by Asahi Class Co., Ltd.); and the like can be given.

[0274] These surfactants may be used either individually or in combination of two or more.

[0275] The amount of the surfactant to be added to the radiation-sensitive resin composition (1) or the radiationsensitive resin composition (2) is usually 2 parts by weight or loss for 100 parts by weight of the total amount of resin and the acid generator (b).

[0276] As other additives, halation inhibitors, adhesion promoters, storage stabilizers, anti-foaming agents, and the like can be given.

[0277] The radiation-sensitive resin composition (1) and radiation-sensitive resin composition (2) excel in dry etching resistance and possess superior basic properties as a resist such as excellent transmittance, sensitivity, resolution, and developability.

# Preparation of composition solution

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[0278] The radiation-sensitive resin composition (1) and radiation-sensitive resin composition (2) can be prepared as a composition solution by dissolving the composition in a solvent so that the total solid content is 1-25 wt%, and preferably 2-15 wt%, and filtering the composition using a filter with a pore diameter of about 0.2 μm, for example. [0279] Examples of solvents used for the preparation of the composition solution include: linear or branched ketones such as 2-butanone, 2-pentanone, 3-methyl-2-butanone, 2-hexanone, 4-methyl-2-pentanone, 3-methyl-2-pentanone, 3,3-dimethyl-2-butanone, 2-heptanone, and 2-octanone, cyclic ketones such as cyclopentanone, 3-methylcyclopentanone, cyclohexanone, 2-methylcyclohexanone, 2,6-dimethylcyclohexanone, and isophorone; propylene giycol monoalkyl ether acetates such as propylene glycol monomethyl ether acetate, propylene glycol monoethyl ether acetate, propylene glycol mono-n-propyl ether acetate, propylene glycol mono-i-propyl ether acetate, propylene glycol mono-n-butyl ether acetate, propylene glycol mono-i-butyl ether acetate, propylene glycol mono-sec-butyl ether acetate, and propylene glycol mono-t-butyl ether acetate; alkyl 2-hydroxypropionates such as methyl 2-hydroxypropionate, ethyl 2-hydroxypropionate, n-propyl 2-hydroxypropionate, i-propyl 2-hydroxypropionate, n-butyl 2-hydroxypropionate, i-butyl 2-hydroxypropionate, sec-butyl 2-hydroxypropionate, and t-butyl 2-hydroxypropionate; alkyl 3-alkoxypropionates such as methyl 3-methoxypropionate, ethyl 3-methoxypropionate, methyl 3-ethoxypropionate, and ethyl 3-ethoxypropionate; as well as other solvents such as n-propyl alcohol, i-propyl alcohol, n-butyl alcohol, t-butyl alcohol, cyclohexanol, ethylene glycol monomethyl ether, ethylene glycol monoethyl ether, ethylene glycol mono-n-propyl ether, ethylene glycol mono-n-butyl ether, diethylene glycol dimethyl ether, diethylene glycol diethyl ether, diethylene glycol di-n-propyl ether, diethylene glycol di-n-butyl ether, ethylene glycol monomethyl ether acetate, ethylene glycol monoethyl ether acetate, ethylene glycol mono-n-propyl ether acetate, propylene glycol monomethyl ether, propylene glycol monoethyl ether, propylene glycol mono-n-propyl ether, toluene, xylene, 2-hydroxy-2-methylethyl propionate, ethoxyethyl acetate, ethyl hydroxyacetate, methyl 2-hydroxy-3-methylbutyrate, 3-methoxybutylacetate, 3-methyl-3-methoxybutylacetate, 3-methyl-3-methoxybutylpropionate, 3-methyl-3-methoxybutylbutyrate, ethyla cetate, n-propyl acetate, n-butylacetate, methyl acetoacetoate, ethyl acetoacetate, methyl pyruvate, ethyl pyruvate, N-methyl pyrrolidone, N,N-dimethylformamide, N,N-dimethylacetamide, benzyl ethyl ether, di-n-hexyl ether, diethylene glycol monomethyl ether, diethylene glycol monoethyl ether, caproic acid, caprylic acid, 1-octanol, 1-nonanol, benzyl alcohol, benzyl acetate, ethyl benzoate, diethyl oxalate, diethylmaleate, y-butyrolactone, ethylene carbonate, and propylene carbonate. [0280] These solvents may be used either individually or in combination of two or more. Among these solvents, linear or branched ketones, cyclic ketones, propylene glycol monoalkyl ether acetates, alkyl 2-hydroxypropionates, and alkyl 3-alkoxypropionates are preferable.

# Formation of resist patterns

- 35 [0281] A method of forming resist patterns using the radiation-sensitive resin composition (1) or the radiation-sensitive resin composition (2) will now be described.
  - [0282] In the radiation-sensitive resin composition (1) or radiation-sensitive resin composition (2), an acid is generated from the acid generator (b) upon exposure to radiation. The acid-dissociable group in the resin to dissociate by the action of the acid and generates a carboxyl group or hydroxyl group. As a result, solubility of the exposed part of the resist in an alkaline developer increases, whereby the exposed part is dissolved in an alkaline developer and removed to produce a positive-tone resist pattern.
  - (D283) A resist pattern is formed from the radiation-sensitive resin composition (1) or the radiation-sensitive resin composition (2) by applying the composition solution to, for example, substrates such as a silicon wafer or a wafer coated with suminum using an epropriate a epplication method such as rotational coating, cast coeting; and roil coating to form a resist film. The resist film is then optionally pre-baked (hereinartier called "PB") and exposed to form a pre-determined resist pattern. An F2 excimer laser (wavelength: 157 nm), ArF excimer laser (wavelength: 138 nm), and KrF excimer laser (wavelength: 248 nm) are preferable as radiation used for exposure.
  - [0284] In the present invention, it is preferable to perform post-exposure bake (hereinafter called "PEB") after exposure. The PEB ensures a smooth acid dissociation reaction from the resin (a). The heating temperature for PEB is usually 30-200°C, and preferably 50-170°C, although the heating conditions vary depending on the composition of the resist.
  - [0285] In order to fully bring out latent capability of the radiation-sensitive resin composition (1) and the radiation-sensitive resin composition (2), an organic or inorganic anti-reflection film may be formed on a substrate as disclosed in Japanese Patent Publication No. 12452/1994, for example. Moreover, a protection film may be formed on the resist film as disclosed in Japanese Patent Publication No. 188598/1993 or the like in order to prevent the effects of basic impurities or the like in an environmental atmosphere. These techniques may be employed in combination.
    - [0286] The exposed resist film is then developed to form a predetermined resist pattern.
      [0287] As examples of a developer used for development, it is preferable to use an alkaline aqueous solution prepared

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by dissolving at least one of alkaline compounds such as sodium hydroxide, potassium hydroxide, sodium carbonate, sodium silicate, sodium metasilicate, aqueous ammonia, ethylamine, propylamine, distylamine, dhydroxide, sodium metasilicate, aqueous ammonia, ethylamine, triethylamine, triethylamine, triethylamine, triethylamine, triethylamine, triethanolamine, tetramethylammonium hydroxide, pyrrole, plperidine, choline, 1,8-diazabicyclo-15.4.0.17-undscene, and 1,5-diazabicyclo-14.3.0.15-nonene.

5 [0288] The concentration of the alkaline aqueous solution is usually 10 wt% or less. If the concentration of the alkaline aqueous solution exceeds 10 wt%, an unexposed area may be dissolved in the developer.

[0289] Organic solvents or the like may be added to the developer containing an alkaline aqueous solution.

[0290] As examples of organic solvents, ketones such as acetone, 2-butanone, 4-methyl-2-pentanone, cyclohexanone, 3-methylscyclopentanone, and 2,6-dimethylscyclohexanone; alcohols such as methylalcohol, ethylalcohol, p-propylalcohol, p-butylalcohol, butylalcohol, cyclopentanol, cyclohexanol, 1,4-hexanediol, and 1,4-hexanediol, and 1,4-hexanediol, and extensional propylalcohol, ethers such as tetrahydrofuran and dioxane; esters such as ethyl acetate, n-butyl acetate, and l-amyl acetate; aromatic hydrocarbons such as toluene and xylene; phenol, acetonylacetone, dimethyl-formamidic, and the like can be given.

[0291] These organic solvents may be used either individually or in combination of two or more.

[0292] The amount of the organic solvents is preferably 100 vol% of the alkaline aqueous solution. If the amount of the organic solvents exceeds 100 vol%, an exposed area may remain undeveloped due to decreased developability. [0293] In addition, surfactants or the like may be added to the developer containing the alkaline aqueous solution in an appropriate amount.

[0294] The resist film is generally washed with water after development using a developer containing an alkaline aqueous solution.

# **EXAMPLES**

[0295] The present invention will be described in more detail by examples, which should not be construed as limiting the present invention.

[0296] In the examples, part(s) refers to part (s) by weight unless otherwise indicated. Measurement and evaluation were carried out as follows.

# Mw:

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[0297] Mw was measured by gel permeation chromatography (GPC) using GPC columns (manufactured by Tosoh Com., G2000HXL x 2, G3000HXL x 1, G4000HXL x 1) under the following conditions.

Flow rate: 1.0 ml/mlnute

Eluate: tetrahydrofuran

Column temperature: 40°C

Standard reference material: monodispersed polystyrene

# Radiation transmittance:

[0298] A solution with a solid content of 5 wt%, prepared by dissolving a polysiloxane in 2-heptanibe, was applied onto a magnesium fluoride substrate by spin coating. The coated material was heated on a hot plate at 140°C for 90 seconds to form a film with a thickness of 100 nm. The radiation transmittance of the film, calculated from absorbance of light with a wavelength of 157 nm and 193 nm, was used as a standard of transparency in the deep ultraviolet region.

### Synthesis Example 1

#### (Synthesis silane compound (6))

(0299) A three-necked flask equipped with a stirrer, a reflux condenser, and a thermometer was charged with 73.9 g of trinethoxysilane and 77.5 g of 1-butyl acrylate. The mixture was stirred at room temperature and 0.1 ml of a 0.1 ml or le 0.1 ml or

[0300] As shown by the following results of the measurement of NMR spectrum (chemical shift  $\sigma$ ) and IR spectrum, the reaction product was identified to be 2-t-butoxycarbonylethyltrimethoxysilane.

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- $\sigma$ : 3.6 ppm (methoxy group) , 2.4-2.0 ppm ( $\alpha$ -methylene group) , 1.4 ppm (t-butyl group), 1.3-0.9 ppm ( $\beta$ -methylene group)
- IR: 2847 cm<sup>-1</sup> (methoxy group), 1730 cm<sup>-1</sup> (ester group), 1153 cm<sup>-1</sup> (siloxane group), 1095 cm<sup>-1</sup> (siloxane group)

# Comparative Example 1

(Preparation of comparative polysiloxane)

[0301] A three-necked flask equipped with a stirrer, a reflux condenser, and a thermometer was charged with 40 g of 2±-butoxycarbonylethyltrimethoxysilane prepared in Synthesis Example 1, 120 g of 4-methyl-2-penianone, 8.6 g of distilled water, and 4.0 g of triethylamine. The mixture was reacted for two hours at 62°C white stirring. The flask was cooled with ice and a solution of 3.5 g of oxalic acid in 60 m lof lon-exchanged water was added, followed by continued stirring. The reaction mixture was poured into a separating funnel to remove the water layer. 100 m lof lon-exchanged water was additionally added to wash the organic layer. After removing the water layer, the solvent was evaporated under vacuum to obtain a comparative polysiloxane.

[0302] NMR spectrum (chemical shift σ), IR spectrum, and Mw of the comparative polysiloxane were measured. The results were as follows.

 $\sigma$ : 2.4-2.0 ppm ( $\alpha$  -methylene group), 1.4 ppm (t-butyl group) , 1.3-0.9 ppm ( $\beta$ -methylene group).

IR: 1730 cm<sup>-1</sup> (ester group), 1149 cm<sup>-1</sup> (siloxane group)

Mw: 19,500

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# Example 1

25 (Preparation of polysiloxane (1))

[0303] A three-necked flask equipped with a stirrer, a reflux condenser, and a thermometer was charged with 9.7 g of 2±0-butoxycarbonylethyltrimethoxysilane, prepared in Synthesis Example 1,5.3 g of methyltrimethoxysilane, 1.3 g of the examely fidelicities of the properties of the example 1,5.3 g of the example 1,5.3 g

- σ: 2.4-2.0 ppm (α-methylene group) , 1.4 ppm (t-butyl group) , 1.3-0.9 ppm (β-methylene group), 0.2 ppm (SiCH<sub>3</sub>
- IR: 1730 cm<sup>-1</sup> (ester group), 1149 cm<sup>-1</sup> (siloxane group)

Mw: 44,700

the following results:

#### Example 2

(Preparation of polysiloxane (1))

[0305] A three-necked flask equipped with a stirrer, a reflux condenser, and a thermometer was charged with 6.3 g of 2±-butoxycarbonylethyltrimethoxysilane prepared in Synthesis Example 1, 13.7 g of methyltrimethoxysilane, 4.1 g of hexamethyldialloxane, 100 g of 4-methylt-pentanone, 9.1 g of distilled water, and 12.7 g of triethylamine. The mixture was reacted for three hours at 62°C while stirring. The flask was cooled with ice and a solution of 1.7 g of oxalic acid in 200 ml of ion-exchanged water was added, followed by continued stirring. The reaction mixture was pound into a separating funnel to remove the water layer. 100 ml of ion-exchanged water was additionally added to wash the organic layer. After removing the water layer, the solvent was evaporated under vacuum to obtain polysiloxane (1).

[0306] NMR spectrum (chemical shift o) , IR spectrum, and Mw of the polysiloxane (1) were measured to confirm the following results.

σ: 2.4-2.0 ppm (α-methylene group), 1.4 ppm (t-butyl group), 1.3-0.9 ppm (β-methylene group), 0.2 ppm (SICH<sub>3</sub> group)

IR: 1730 cm<sup>-1</sup> (ester group), 1149 cm<sup>-1</sup> (siloxane group)

Mw: 22 400

## Example 3

(Synthesis of silicon-containing alicyclic compound (2))

[0307] A three-necked flask equipped with a stirre, a reflux condenser, and a thermometer was charged with 48.5 got frimethoxysialize and 77.1 got 57-butoxycarbonyblocyclo[2.2.1] hepto-2-ene. The mixture was stirred at room temperature and 1.0 ml of a 0.1 mol chloroplatinic acid solution in isopropyl alcohol was added to initiate the reaction. After heating at 140°C for 48 hours while refluxing, the reaction mixture was allowed to cool to room temperature, diluted with n-hexam, and filtered through celled by suction. The solvent was evaporated by distillation under vacuum to obtain a orude product. The crude product was purified by vacuum distillation at 0.2 mmHg and a temperature of 105°C to obtain 48 or 60 the reaction product.

(3038) This reaction product was identified to be the silicon containing alloyello compound (2) shown by the formula (2-3) by the measurement of "1+-NMR spectrum (chemical shift of H), "3C-NMR spectrum (chemical shift of C), 2SI-NMR spectrum (chemical shift of S), IR spectrum, and mass spectrum (FABMS), of which the results are shown below.

σ H: 3.6 ppm (methoxy group), 1.4 ppm (t-butyl group)

σ C: 175 ppm (carbonyl group), 80 ppm (t-butyl group)

σ: 51 ppm (methoxy group), 28 ppm (t-butyl group) σ Si: -45 ppm

IR:  $2847 \, \text{cm}^{-1}$  (methoxy group), 1730 cm $^{-1}$  (ester group), 1153 cm $^{-1}$  (siloxane group), 1095 cm $^{-1}$  (siloxane group) FABMS:  $m/z = 317 \, (M^+ + 1)$ 

## 25 Example 4

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(Preparation of polysiloxane (1))

[0309] A three-necked flask equipped with a stirrer, a reflux condenser, and a thermometer was charged with 7.35 g of the sillicon containing allicytic compound (2) prepared in Example 3, 12.65 g of trimethoxymethylsilane, 0.94 g of pexamethyldislioxane, 100 g of 4-methyl-2-pentanne, 11.0 g of distilled water, and 14.8 g of triethylamine. The mixture was reacted for eight hours at 75°C while stirring. The flask was cooled with lee and a solution of 12.9 g of oxalic acid in 250 ml of lor-exchanged water was added, followed by continued stirring. The reaction mixture was powered into a separating funnel to remove the water layer. 100 ml of ion-exchanged water was additionally added to wash the organic layer. After removing the water layer, the solvent was evaporated under vacuum to obtain polysiloxane (1). [0310] MMS spectrum (chemical shift of). Its spectrum, and Mw of the polysiloxane (1) were measured to confirm the

σ: 1.4 ppm (t-butyl group), 0.2 ppm (SiCH<sub>3</sub> group)

IR: 1730 cm<sup>-1</sup> (ester group), 1149 cm<sup>-1</sup> (siloxane group)
Mw: 5.900

following results.

## Evaluation Example 1

# 5 (Evaluation of radiation transmittance)

[0311] The radiation transmittance of the polysiloxanes obtained in Comparative Example 1, Example 2, and Example 4 at wavelengths of 157 nm and 193 nm was measured. In addition, the radiation transmittance at wavelengths of 157 nm and 193 nm was measured on a comparative polysiloxane consisting of 40 mol% of maleic anthydride, 40 mol% of 54-butoxycarbonylocyclo(2, 2,11-hept-2-ene, and 20 mol% of 3-hydroxy-1-adamantylacrylate, as Comparative Example 2. The evaluation results are shown in Table 1.

Table 1

Polysiloxane	Radiation transmittance (%)	
	157 nm	193 nm
Polysiloxane of Comparative Example 1	24	95

# Table 1 (continued)

Polysiloxane	Radiation transmittance (%)	
	157 nm	193 nm
Polysiloxane (1) of Example 2	32	99
Polysiloxane (1) of Example 4	31	97
Polysiloxane of Comparative Example 2	16	. 90

[0312] As a result, the polysiloxanes (1) of Examples 2 and 4 were confirmed to exhibit greater radiation transmittance than the comparative polysiloxane of Comparative Example 1 at both the wavelength 157 nm and wavelength 193 nm. These polysiloxanes (1) were also confirmed to exhibit remarkably high radiation transmittance at both the wavelength 157 nm and wavelength 193 nm as compared with the comparative polysiloxane of Comparative Example 2 which had been conventionally used as a chemically amplified resist.

## Example 5

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(Radiation-sensitive resin composition)

- [0313] A solution composition was prepared by homogeneously mixing 100 parts of the polysiloxane (1) obtained in Example 2.1 part of triphenylsulfonium trifluoromethane sulfonate, 0,02 part of tri-n-octylamine, and 1,088 parts of 2-hentanony.
  - [0314] The solution composition was applied onto a silicon water substrate by spin coating and pre-baked for 90 seconds on a hot plate maintained at a temperature of 140°C to form a resist film with a thickness of 200 nm.
- [0315] The resist film was exposed to an F2 excimer laser (wavelength: 157 nm) while changing the irradiation dose, post-baked for 90 seconds on a hot plate at 120°C, and then developed in a 2.38% aqueous solution of tetramethylammonium hydroxide.
  - [0316] As a result, the area on the resist film exposed to radiation at a dose of 70 J/m² has completely been removed by development. Comparative Example 3
- 30 (Comparative Radiation-sensitive resin composition)
  - [0317] A solution composition was prepared and a resist film was formed, exposed, and developed in the same manner as in Example 5, except for using the comparative polysiloxane of Comparative Example 2 instead of the polysiloxane (i) obtained in Example 2.
  - [0318] As a result, it was found that the area on the resist film exposed to radiation at a dose of 200 J/m<sup>2</sup> has not completely been removed by development.

#### Example 6

- (Synthesis of silicon-containing alicyclic compound (2))
- [0319] A three-necked flask equipped with a stirrer, a reflux condenser, and a thermometer was charged with 48.5 g of triethoxysilane and 42 g of 5-t-butoxycarborybiloyclog2.2.1jhepto-2-ene. The mixture was stirred at room temperature and 1.0 ml of a 0.2 mol chloroplatinic acid (H<sub>2</sub>PtCl<sub>2</sub>) solution in isopropyl alcohol was added to initiate the reaction. The reaction was continued for 24 hours at 140°C while refluxing. The reaction mixture was allowed to cool to room temperature, diluted with n-hexane, and filtered through celite by suction. The solvent was evaporated under vacuum to obtain a crude product. The crude product was purified by vacuum distillation at 0.4 mmHg and a temperature of 165°C to obtain 54 of the reaction product.
- [0320] This reaction product was identified to be the silicon containing alleyelic compound (2) shown by the formula (2-6) by the measurement of YH-NMR spectrum (chemical shift of H). <sup>15</sup>C-NMR spectrum (shemical shift of C), <sup>26</sup>Si-NMR spectrum (shemical shift of S), its pectrum, and mass spectrum (FASMS), of which the results are shown below.
  - σ H: 3.8 ppm (ethoxy group), 1.4 ppm (t-butyl group)
  - σ C: 175 ppm (carbonyl group), 80 ppm (t-butyl group), 59 ppm (ethoxy group), 28 ppm (t-butyl group), 19 ppm (methyl group).
    - σ Si: -48 ppm
    - IB: 2879 cm<sup>-1</sup> (ethoxy group), 1726 cm<sup>-1</sup> (ester group), 1155 cm<sup>-1</sup> (siloxane group), 1080 cm<sup>-1</sup> (siloxane group)

FABMS:  $m/z = 359 (M^+ + 1)$ 

# Example 7

5 (Synthesis of silicon-containing alicyclic compound (2))

[0321] A three-necked flask equipped with a stirrer, a reflux condenser, and a thermometer was charged with 49,0 of trimethoxysiane and 73.0 g of 8-t-butoxycarbonyltetracyclo [4.4.0.1.25,17.0] - dodeca-3-ene. The mixture was stirred at room temperature and 5.0 ml of a 0.2 mol chloroplatinic acid (H-pTClg) solution in isopropyl alcohol was added to initiate the reaction. The reaction mess continued for 100 hours at 150°C while refluxing. The reaction mixture was allowed to cool to room temperature, diluted with n-hexane, and filtered through cellite by suction. The solvent was evaporated by distillation under vacuum to obtain a crude product. The residue was purified by silice gel column chromatography to obtain 30 g of the compound as an-hexane fraction. This reaction product was identified to be the silicon containing alloyclic compound (2) shown by the formula (2-39) by the measurement of 1+NMR spectrum (chemical shift of C). <sup>285</sup>NMR spectrum (chemical shift of Si), IR spectrum, and mass spectrum (FARMS), of which the results are shown below.

σ H: 3.6 ppm (methoxy group), 1.4 ppm (t-butyl group)

σ C: 175 ppm (carbonyl group), 80 ppm (t-butyl group), 51 ppm (ethoxy group), 28 ppm (t-butyl group)

σ Si: -45 ppm

IR: 2847 cm<sup>-1</sup> (methoxy group), 1726 cm<sup>-1</sup> (ester group), 1153 cm<sup>-1</sup> (siloxane group), 1090 cm<sup>-1</sup> (siloxane group) FABMS: m/z = 383 (M<sup>+</sup> + 1)

# Example 8

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(Synthesis of silicon-containing alicyclic compound (2))

[0322] A three-necked flask equipped with a stirrer, a reflux condenser, and a thermometer was charged with 75.0 of triethoxystilene and 100 g of 81-butoxyscarbonylteracycle(4.6.1.28.17)-[91-dedeca-9-ene. The mixture was stirred at room temperature and 5.0 ml of a 0.2 mol chloroplatinic acid (H<sub>2</sub>PtCl<sub>6</sub>) solution in Isopropyl alcohol was added to initiate the reaction. The reaction was continued for 75 hours at 150°C while refluxing. The reaction mixture was allowed to cool to room temperature, diluted with n-twane, and filtered through celter by suction. The solvent was evaporated by distillation under vacuum to obtain a crude product. The residue was purified by silica gel column chromatography to obtain 53 g of the compound as a n-haysane fraction.

[0323] This reaction product was Identified to be the silicon containing alloydic compound (2) shown by the formula (2-42) by the measurement of ¹H-NMR spectrum (chemical shift σ H), ¹²Q-NMR spectrum (chemical shift σ C), ²<sup>Q</sup>SI-NMR spectrum (chemical shift σ SI), IR spectrum, and mass spectrum (FABMS), of which the results are shown below.

σ H: 3.8 ppm (ethoxy group), 1.2 ppm (ethoxy group), 1.4 ppm (t-butyl group)

σ C: 175 ppm (carbonyl group), 80 ppm (t-butyl group), 59 ppm (ethoxy group), 28 ppm (t-butyl group), 19 ppm (methyl group)

σ Si: -48 ppm

IR: 2885 cm $^{-1}$  (ethoxy group), 1726 cm $^{-1}$  (ester group), 1153 cm $^{-1}$  (siloxane group), 1080 cm $^{-1}$  (siloxane group) FABMS:  $m/z = 425 (M^4 + 1)$ 

# Example 9

(Synthesis of silicon-containing alicyclic compound (2))

59 [0324] A three-nocked flask equipped with a stirrer, a reflux condenser, and a thermometer was charged with 28 6. g of trimethylyslane and 50 0 g of 54-butoxycarbonylbicyclo(2.2.1)-hepto-2-ene. The mixture was stirred at room temperature and 1.0 ml of a 0.1 mol chloroplatinic acid (H<sub>2</sub>PtCl<sub>2</sub>) solution in isopropyl alcohol was added to initiate the reaction. The reaction was continued for 48 hours at 140°C while refluxing, reaction mixture was allowed to cool to room temperature, diluted with n-hexane, and filtered through colte by suction. The solvent was evaporated by distillation under vacuum to obtain a crude product. The crude product was purified by vacuum distillation at 0.2 mmHg and a temperature of 105°C to obtain 42 g of the siltoon containing allicyclic compound (2) having a methyl group for R1, a hydrogen atom for R, m-3, and n=0 in the formula (2-A).

# Example 10

(Synthesis of silicon-containing alicyclic compound (2))

[0325] A three-necked flask equipped with a stirrér, a reflux condenser, and a thermometer was charged with 53.2 g of trichlorosiliane and 50.0 g of 51-butoxycarbonylbicyclo[2.2.1]hepto-2-ene. The mixture was stirred at room temperature and 1.0 ml of a 0.1 mol chloroplatinic acid (H<sub>2</sub>PrCl<sub>6</sub>) solution in isopropyl alcohol was added to initiate the reaction. The reaction was continued for 48 hours at 140°C while refluxing. The reaction mixture was allowed to cool to room temperature, diluted with n-hexane, and filtered through celite by suction. The solvent was evaporated by distillation under vacuum to obtain a crude product. The crude product was purified by vacuum distillation at 0.2 mmHg and a temperature of 98°C to obtain 82 g of the silicon containing alloyolic compound (2) of the formula (2-12).

## Example 11

(Synthesis of sillcon-containing alicyclic compound (2))

[0326] A three-necked flask equipped with a stirrer, a reflux condenser, and a thermometer was charged with 51.8 g of methyldiethoxyslaine and 50.0 g of 5t-butoxycarbonybiocyclo(2.2.1)hepto-2-ene. The mixture was stirred at room temperature and 1.0 ml of a 0.1 mol chloroplatinic acid (H<sub>2</sub>PCL<sub>0</sub>) solution in isopropyl alcohol was added in hitlate the reaction. The reaction was continued for 48 hours at 140°C while refluxing. The reaction mixture was allowed to cool to room temperature, diluted with n-hexane, and filtered through celtie by suction. The solvent was evaporated by distillation under vacuum to obtain a crude product. The crude product was purified by vacuum distillation at 0.2 mmHg and a temperature of 112°C to obtain 60 g of the silicon containing alicyclic compound (2) of the formula (2-5).

# 25 Example 12

(Synthesis of silicon-containing alicyclic compound (2))

[0327] A three-necked flask equipped with a stirrer, a reflux condenser, and a thermometer was charged with 17.1
30 g of trimethylslane and 40 g of 81-butoxycarbonytletracyclo[4,4,0,12-5,17], oddeca-3-ene. The mixture was stifred at room temperature and 5.0 ml of a 0.2 ml ochloroplatinic acid (H<sub>e</sub>PCl<sub>6</sub>) solution in isopropyl alcohol was added to initiate the reaction. The reaction was continued for 100 hours at 150°C while refluxing. The reaction mixture was allowed to col to room temperature, diluted with n-hexane, and filtered through cellle by suction. The solvent was exportated by distillation under vacuum to obtain a crude product. The residue was purified by silica gel column chromatography to obtain 23 g of the silicon containing alleyclic compound (2) having a methl group for R1, a hydrogen atom for R, m=3, and m=1 of the formula (2-A) as a n-hexane fraction.

# Example 13

40 (Synthesis of silicon-containing alicyclic compound (2))

[0328] A three-necked flask equipped with a stirrer, a reflux condenser, and a thermometer was charged with 31.3 g of trichlorosilane and 40 g of 8-t-butoxycarbonyltetracyclo(4.4.0.126.17.10). dodeca-3-ene. The mixture was stirred at room temperature and 5.0 ml of a 0.2 mol chloroplatinic acid (1-gPCls) solution in isopropyl alcohol was added to initiate the reaction. The reaction was continued for 100 hours at 150°C while refluxing. The reaction mixture was allowed to cool to room temperature, diluted with n-hexane, and filtered through coelite by suction. The solvent was evaporated by distillation under vacuum to obtain a crude product. The residue was purified by silics agle column chromatography to obtain 37 g of the silicon containing alloyelic compound (2) of the formula (2-48) as a n-hexane fraction.

# 50 Example 14

(Synthesis of silicon-containing alicyclic compound (2))

[0329] A three-necked flask equipped with a stirrer, a reflux condenser, and a thermometer was charged with 30.9 g of methyldiethoxysilane and 40 g of 8-t-butoxycarbonyltetracyclof.4.0,12.5,17.10, - dodeca-3-ena. The mixture was stirred at room temperature and 5.0 ml of a 0.2 mol chloroplatinic acid (H<sub>2</sub>PiCl<sub>6</sub>) solution in isopropyl alcohol was added to initiate the reaction. The reaction was continued for 100 hours at 150°C while refluxing. The reaction mixture was allowed to cool to room temperature, diluted with n-hexane, and filtered through cellte by suction. The solvent was

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evaporated by distillation under vacuum to obtain a crude product. The residue was purified by silica gel column chromatography to obtain 24 g of the silicon containing alicyclic compound (2) of the formula (2-41) as a n-hexane fraction.

# Example 15

(Synthesis of silicon-containing alicyclic compound (2))

- [0330] A three-necked flask equipped with a stirrer, a reflux condenser, and a thermometer was charged with 12.0 g of methylridrocyclosiolyane (containing 3-5 El atoms per molecule) and 82.0 g of 8-thotoxycarbo-invited properties only letracyclo-[44.0,125-17-10] dodeca-3-ene. The mixture was stirred at room temperature and 5.0 ml of a 0.2 mol chieroplatinic acid (H<sub>2</sub>PrCl<sub>2</sub>) solution in isopropyl alcohol was added to initiate the reaction. The reaction was continued for 100 hours at 150°C while refluxing. The reaction mixture was allowed to cool to room temperature, diluted with n-hoxane, and filtered through cellite by suction. The solvent was evaporated by distillation under vacuum to obtain 59 g of the silicon containing alloyfolic compound (2) of the silicon containing alloyfolic compound (2) of the silicon mula (2-91).
- 5 [0331] 1H-NMR spectrum (chemical shift σ H) and IR spectrum of the compound were measured. The results were as follows.
  - σ H: 1.4 ppm (t-butyl group), 0.2 ppm (SiCH<sub>3</sub> group)
  - IR: 1730 cm<sup>-1</sup> (ester group), 1150 cm<sup>-1</sup> (siloxane group)

## Example 16

(Synthesis of silicon-containing alicyclic compound (2))

containing alicyclic compound (2) of the formula (2-91).

- 28 [0332] A throe-necked flask equipped with a stirrer, a reflux condenser, and a thermometer was charged with 3.0 g of the compound shown by the above formula (2-41) prepared in Synthesis Example 15, 9 g of 4-methyl-2-pentanon, and 0.56 g of 1.75 wf% oxalic acid aqueous solution. The mixture was reacted for two hours at 40°C while stirring. The reaction was terminated by cooling the flask with ice. The reaction mixture was poured into a separating funnel to remove the water layer. The organic layer was washed with ino-xchanged water until the reaction solution becomes neutral. The solvent was removed from the organic layer by distillation under vacuum to obtain 1.90 g of the silicon
  - [0333] <sup>1</sup>H-NMR spectrum (chemical shift or H) and IR spectrum of the compound were measured and confirmed to be identical to those of the compound of Example 16.

#### 35 Example 17

(Preparation of polysiloxane (3))

- [0334] A throe-necked flask equipped with a stirrer, a reflux condenser, and a thermometer was charged with 12.47
  g of the silicon containing alloyelic compound (2) of the above formule (2-2), 12.53 g of methyltrimethoxysilians, 1.07
  g of hexamethyldsiloxane (molecular weight adjusting agent), 75 g of 4-methyl-2-pentanone, 14.92 g of distilled water, and 20.93 g of thetyltamine. The mixture was reacted for eight hours at 75°C while stirring. The flask was cooled with ice and a solution of 18.2 g of oxalia caid in 500 ml of lon-exchanged water was added, followed by continued stirring. The reaction mixture was poured into a separating funnel to remove the water layer. 100 ml of lon-exchanged water was additionally added to wash the organic layer. The solvent was evaporated under vacuum to obtain polysiloxane (3).
  [0335] 1H-NMR spectrum (chemical shift of H), IR spectrum, and Mw of the polysiloxane (3) were measured. The results were as follows.
  - σ H: 1.4 ppm (t-butyl group), 0.2 ppm (SiCH<sub>2</sub> group)
  - IR: 1730 cm<sup>-1</sup> (ester group), 1149 cm<sup>-1</sup> (siloxane group)

Mw: 6,400

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#### Comparative Example 4

55 (Preparation of comparative polysiloxane)

[0336] A three-necked flask equipped with a stirrer, a reflux condenser, and a thermometer was charged with 9.7 g of 2-t-butoxycarbonylethyltrimethoxysilane, 5.3 g of methyltrimethoxysilane, 1.3 g of hexamethyldisiloxane (molecular

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weight adjusting aagent), 75 g of 4-meltryl-2-pentanone, 4.2 g of distilled water, and 4.2 g of triethylamine. The mixture was reacted for three hours at 62°C while stirring. The flask was cooled with ice and a solution of 11.1 g of oxalic acid in 200 ml of ion-exchanged water was added, followed by continued stirring. The reaction mixture was poured into a separating funnel to remove the waterlayer. 100 ml of ion-exchanged water was additionally added to wash the organic layer. The solvent was evaporated under vactum to obtain a comparative polyelioxane.

[0337] 1H-NMR spectrum (chemical shift of H), IR spectrum, and Mw of the comparative polysiloxane were measured. The results were as follows.

 $_{G}$  H: 2.4-2.0 ppm ( $\alpha$ -methylene group), 1.3-0.9 ppm ( $\beta$  - methylene group) , 1.4 ppm (t-butyl group) , 0.2 ppm (SiCH  $_{G}$ 

IR: 1730 cm<sup>-1</sup> (ester group), 1149 cm<sup>-1</sup> (siloxane group)

IR: 1730 cm<sup>-1</sup> (ester group), 1149 cm<sup>-1</sup> (slick)
Mw: 44,700

## Evaluation Example 2

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# (Evaluation of glass transition temperature)

[0338] Glass transition temperature of the polysiloxane obtained in Example 17 and the polysiloxane obtained Comparative Example 4 was measured to confirm the glass transition temperature of the later polysiloxane was less than 25°C, whereas the former polysiloxane had a glass transition temperature of 97°C, which is sufficiently high as a resist component.

## Evaluation Example 3

# 25 (Evaluation of radiation transmittance)

[0339] Radiation transmittance of coating films (thickness: 100 nm) formed from the polysiloxanes obtained in Example 17 and Comparative Example 4 was measured using radiation of a wavelength of 157 nm to contime the radiation transmittance of the coating film prepared from the polysiloxane (3) of Example 17 was 31%, whereas that of the coating film prepared from the comparative polysiloxane of Comparative Example 4 was 32%.

[0340] Conventionally, the radiation transmittance at a wavelength of 157 nm has been thought to decrease as the proportion of hydrocarbon structures in a polysiloxane increases. The results of the measurement, however, indicated that notwithstanding a comparatively large proportion of hydrocarbon structures the polysiloxane (3) exhibited almost the same radiation transmittance at a wavelength of 157 nm as that of the comparative polysiloxane of Comparative Example 4, confirming that the hydrocarbon structures did not result in the decrease of transmittance.

## Example 18

# (Radiation-sensitive resin composition)

[0341] A solution composition was prepared by homogeneously mixing 100 parts of the polysiloxane (3) obtained in Example 18, 1 part of triphenylphosphonium trifluoromethane sulfonate, 0.02 part of trin-octylemine, and 900 parts of

[0342] The solution composition was applied onto a silicon wafer substrate by spin coating and pre-baked for 90 seconds at 140°C to form a resist film with a thickness of 200 nm.

[0343] The resist film was exposed to an F2 excimer laser (wavelength: 157 nm) through a photo-mask, post-baked for 90 seconds on a hot plate at 120°C, and then developed in a 2.38 wt% aqueous solution of tetramethylammonium hydroxide.

[0344] As a result, a fine resist pattern confuguration with a line width of 0.5 µm was obtained.

## Example 19

# (Preparation of polysiloxane (1))

5 [0345] A three-necked flask equipped with a stirrer, a reflux condenser, and a thermometer was charged with 4.99 g of the silicon containing alleyelic compound (2) of the above formula (2-3), 5.01 g of trinethoxymethylslane, 0.43 g of hexamethyldislioxane, 30 g of 4-methyl-2-pentanone, and 2.91 g of a 2.37 wt% aqueous solution of oxalic acid. The mixture was reacted for four hours at 80°C while stirring. The reaction was terminated by cooling the flask with ice.

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The reaction mixture was poured into a separating funnel to remove the water layer. The organic layer was washed with inexchanged water until the reaction solution becomes neutral. The solvent was removed from the organic layer to obtain the polysiloxane (1).

[0346] NMR spectrum (chemical shift  $\sigma$ ), IR spectrum, and Mw of the polysiloxane (1) were measured to confirm the following results.

- σ: 1.4 ppm (t-butyl group), 0.2 ppm (SiCH<sub>3</sub> group)
   IR: 1730 cm<sup>-1</sup> (ester group), 1150 cm<sup>-1</sup> (siloxane group)
   Mw: 1.700
- [0347] No methoxy group peak originating from Si-OCH $_3$  which may present in the polymer was observed in the chemical shift  $\sigma$ .

## Example 20

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(Preparation of polysiloxane (1))

10348] A three-necked flask equipped with a stirrer, a reflux condenser, and a thermometer was charged with 4.99 g of the silicon containing alloyclic compound (2) of the above formula (2-3), 5.01 g of trimethoxymethylsilane, 0.43 g of hexamethyldisiloxane, 30 g of 4-methyl-2-pentanone, and 2.91 g a 2.37 wr% aqueous solution of oxalic acid. The mixture was reacted for four hours at 80°C while stirring. The reaction was terminated by cooling the flask with loc. The reaction mixture was power lot not a separating funnel to remove the water layer. The organic layer was washed with lon-exchanged water until the reaction solution becomes neutral. The solvent was removed from the organic layer to obtain 6.7 g of a polymer paving Mw of 1,700.

28 [0349] The polymer was dissolved in 30 g of 4-methyl-2-pentanone. After the addition of 5.7 g of idstilled water and 8.0 g of triethylamine, the mixture was heated to 40°C in a nitrogen stream. After two hours, the mixture was cooled with ice and stirred, then a solution of 3.5 g of oxalic acid in 150 g of distilled water was added, and stirring was continued. The reaction mixture was poured into a separating funnel to remove the water layer. The organic layer was washed with ion-exchanged water until the reaction solution becomes neutral. The solvent was removed from the organic layer to obtain the polysiloxane (1).

[0350] NMR spectrum (chemical shift o), IR spectrum, and Mw of the polysiloxane (1) were measured to confirm the following results.

- σ: 1.4 ppm (t-butyl group), 0.2 ppm (SiCH<sub>3</sub> group)
- IR: 1730 cm<sup>-1</sup> (ester group), 1150 cm<sup>-1</sup> (siloxane group)

Mw: 2,700

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[0351] No methoxy group peak originating from Si-OCH $_3$  which may present in the polymer was observed in the chemical shift  $\sigma$ .

#### Comparative Example 5

(Preparation of comparative polysiloxane)

[0352] A three-necked flask equipped with a stirrer, a reflux condenser, and a thermometer was charged with 4.99 g of the silicon containing alicyclic compound (2) of the above formula (2-3), 5.01 g of trimethoxymethylsilane, 0.43 g of hexamethyldisiloxane, 30 g of 4-methyl-zentanone, and 5.97 g of stillow dwater, and 8.37 g of trielylamine. The mixture was reacted for four hours at 80°C while stirring. The flask was cooled with ice and a solution of 7.31 g of oxalic acid in 250 ml of ion-exchanged water was added, followed by continued stirring. The reaction mixture was poured into a separating furnel to remove the water layer 100 ml of ion-exchanged water was further added to wash the organic layer, then the water layer was removed. The solvent was removed from the organic layer to obtain a polymer. NMR spectrum (chemical shift o), IR spectrum, and Mw of the polymer were measured. The results were as follows.

- 55 σ: 3.6 ppm (methoxy group), 1.4 ppm (t-butyl group), 0.2 ppm (SiCH<sub>2</sub> group)
  - IB: 1730 cm<sup>-1</sup> (ester group), 1149 cm<sup>-1</sup> (siloxane group)

Mw: 4,900

[0353] The 3.6 ppm peak of  $\sigma$  is due to the methoxy group originating from Si-OCH $_3$  remaining in the polymer.

## Example 21

## (Radiation-sensitive resin composition)

[0354] A solution composition was prepared by homogeneously mixing 100 parts of the polyalloxane obtained in Example 19, Example 20, or Comparative Example 5, 1 part of triphenyphosphonium nonafluoro-n-butenesulfonate, 0.02 part of th-nocylamine, and 900 parts of 2-heptanone.

[0355] The solution composition was applied onto a silicon wafer substrate by spin coating and pre-baked for 90 seconds at 130°C to form a resist film with a thickness of 100 nm.

[0356] The resist film was exposed to a KrF excimer laser (wavelength: 248 nm) while changing the irradiation dose, post-baked for 90 seconds on a hot plate at 100°C, and then developed in a 2.38 wt% aqueous solution of tetrameth-warmonium hydroxide.

[0357] Observation of the exposed area on the substrate by a scanning-type electron microscope confirmed that the limit resolution was 0.30 nm when the comparative polysiloxane of Comparative Example 5 was used, whereas the limit resolution was respectively 0.24 nm and 0.22 nm when the polysiloxanes (1) obtained in Example 19 and Example 20 was used.

[0358] In addition, the pattern shape obtained by using the polysiloxane (1) obtained in Example 19 or Example 20 exhibited more excellent rectangular configuration than that obtained using the comparative polysiloxane of Comparative Example 5.

# Evaluation Example 4

# 25 (Evaluation of radiation transmittance)

[0359] The radiation transmittance of coating films with a thickness of 100 nm prepared from the polysiloxane of Example 20 or Comparative Example 5 at wavelengths of 157 nm and 193 nm was measured. The results are shown in Table 2.

Table 2

Polysiloxane	Radiation transmittance (%)		
	. 157 nm	193 nm	
Polysiloxane (1) of Example 20 Polysiloxane of Comparative Example 5	38 31	. 96 96	

[0360] The results in the above table shows that the polyslloxane (1) polycondensed under acid conditions and the comparative polyslloxane polycondensed under basic conditions exhibited no substantial difference in the radiation transmittance at a wavelength of 193 mm, whereas the former polyslloxarie exhibited higher radiation transmittance at a wavelength of 157 than the latter polyslloxane. This indicates that the polyslloxane (1) polycondensed under acid conditions will be a more desirable material for microfabrication using radiation with a short wavelength.

## Example 22

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## (Preparation of polysiloxane (1))

[0361] A three-necked flask equipped with a stirrer, a reflux condenser, and a thermometer was charged with 3.84 g of the silicon containing alicyclic compound (2) of the above formula (2-42), 7.93 g of the silicon containing alicyclic compound (4) of the above formula (4-8) (wherein Bf is a trillucornethyl group), 3.22 g of methyleticoxyslane, 10.5 g of 4-methyl-2-pentanone, and 3.32 g of a 1.75 wf% aqueous solution of oxalic acid. The mixture was reacted for six hours at 80°C while stirring. The reaction was terminated by cooling the flask with ice. The reaction mixture was pourtin to a separating funnel to remove the water layer. The organic layer was washed with ion-exchanged water until the reaction solution becomes neutral. The solvent was removed from the organic layer to obtain the polysiloxane (1) [0362] NMR spectrum (chemical shift d), IR spectrum, and Mw of the polysiloxane (1) were measured to confirm the following results.

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- 2.3 ppm (-CH<sub>2</sub>C(CF<sub>3</sub>)<sub>2</sub> group), 1.4 ppm (t-butyl group), 0.2 ppm (SiCH<sub>3</sub> group)
- IR: 1700 cm<sup>-1</sup> (ester group), 1213 cm<sup>-1</sup> (C-F bond), 1151 cm<sup>-1</sup> (siloxane group)

Mw: 2.100

### Example.23

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(Preparation of polysiloxane (1))

[0363] A three-necked flask equipped with a stirrer, a reflux condenser, and a thermometer was charged with 0.84 g of the silicon containing alicyclic compound (2) of the above formula (2-42), 7.93 g of the silicon containing alicyclic compound (4) of the above formula (4-6) (wherein Rf is a trifluoromethyl group), 3.22 g of methylethoxysialne, 15 g of 4-methyl-2-pentanone, and 3.32 g of a 1.75 wt% aqueous solution of oxalic acid. The mixture was reacted for two hours at 80°C while stirring. The reaction was terminated by cooling the flask with ice. The reaction mixture was poured into a separating funnel to remove the water layer. The organic layer was washed with ion-exchanged water utill the reaction solution becomes neutral. The solvent was removed from the organic layer to obtain 10 g of a polymer having

[0364] The polymer was dissolved in 23 g of 4-methyl-2-pentanone. After the addition of 4.9 g of distilled water and 6.9 g of triethylamine, the mixture was heated to 40°C in a nitrogen stream. After two hours, the mixture was cooled with loe and stried, then a solution of 5.7 g of oxalic add in 200 g of distilled water was added, and string was continued. The reaction mixture was poured into a separating funnel to remove the water layer. The organic layer was washed with lon-exchanged water untill the reaction solution becomes neutral. The solvent was removed from the organic layer to obtain the polysiloxane (1).

[0365] NMR spectrum (chemical shift o), IR spectrum, and Mw of the polysiloxane (1) were measured to confirm the following results.

σ: 2.3 ppm (-CH<sub>2</sub>C(CF<sub>3</sub>)<sub>2</sub> group) , 1.4 ppm (t-butyl group), 0.2 ppm (SiCH<sub>3</sub> group) IB: 1700 cm<sup>-1</sup> (ester group), 1213 cm<sup>-1</sup> (C-F bond), 1151 cm<sup>-1</sup> (siloxane group)

Mw: 2,600

## 30 Comparative Example 6

(Preparation of comparative polysiloxane)

[0366] A three-necked flask equipped with a stirrer, a reflux condenser, and a thermometer was charged with a 3.4 g of the silloon containing alloyclic compound (2) of the above formula (2-42), 7.93 g of the silloon containing alloyclic compound (4) of the above formula (4-6) (wherein Ri Is a trifluoromethyl group), 3.22 g of methylethoxysillane, 15 g of 4-methyl-2-pentanone, 4.9 g of distilled water, and 6.9 g of triethylemine. The mixture was reacted for ten hours at 60°C while stirrig. After cooling the mixture with loe, a solution of 5.7 g of oxalic acid in 200 g of distilled water was added, followed by continued stirring. The reaction mixture was poured into a separating funnel to remove the water layer. The organic layer was washed with ion-exchanged water until the reaction solution becomes neutral. The solvent was removed from the organic layer to obtain a comparative polymer.

[0367] NMR spectrum (chemical shift o), IR spectrum, and Mw of the comparative polysiloxane were measured. The results were as follows.

45 g: 3.6 ppm (methoxy group), 2.3 ppm (-CH<sub>2</sub>C(CF<sub>3</sub>)<sub>2</sub> group), 1.4 ppm (t-butyl group), 0.2 ppm (SICH<sub>3</sub> group) IR: 1700 cm<sup>-1</sup> (ester group), 1213 cm<sup>-1</sup> (C-F bond), 1151 cm<sup>-1</sup> (siloxane group)

Mw: 3,900

[0368] The 3.6 ppm peak of  $\sigma$  is due to the methoxy group originating from Si-OCH<sub>3</sub> remaining in the polymer.

### Evaluation Example 5

(Evaluation of glass transition temperature)

[0369] The glass transition temperature of the polysiloxanes obtained in Example 22, Example 23, and Comparative Example 8 was measured.

[0370] As a result, the comparative polysiloxane obtained in Comparative Example 6 was found to have a glass transition temperature of 92°C, whereas the polysiloxanes (1) obtained in Example 22 and Example 23 was found to

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have a glass transition temperature respectively of 111°C or 122°C, confirming that the polysiloxanes (1) prepared by polycondensation under acidic conditions have a higher glass transition temperature than the comparative polysiloxane prepared by polycondensation under basic conditions.

[0371] As clear from the glass transition temperature of the polysiloxanes (1) obtained in Example 22 and Example 3 23, polysiloxanes synthesized by polycondensation under acidic conditions followed by basic conditions have been confirmed to have a glass transition temperature higher than polysiloxanes synthesized by polycondensation only under acidic conditions. This indicates that, the glass transition temperature of polysiloxane (1) can be increased by increasing the degrees of polymerization and crossinking by polycondensation of a raw material compound under acidic conditions, followed by basic conditions. Thus, the glass transition temperature of polysiloxane (1) can be controlled by selection of polymerization conditions. Increasing the glass transition temperature of a resin component used in a radiation-sensitive resin component used in a radiation-sensitive resin component used in a rediation-sensitive resin component used in this respect, the capability of controlling the glass transition temperature of the polysiloxane (1) is a feature supporting the usefulness of the présent Invention.

## 15 Example 24

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(Preparation of polysiloxane (1))

[0372] A three-necked flask equipped with a stirrer, a reflux condenser, and a thermometer was charged with 3.83 g of the sillicon containing alleyclic compound (4) of the above formula (4-6) (wherein Ri.s a trifluoromethyl group), 1.17 g of the sillicon containing alleyclic compound (4) of the above formula (4-6) (wherein Ri.s a trifluoromethyl group) by replacing the hydrogen atom of the hydroxyl group by a 1-butoxycarbonyl group, 2.5 g of 4-methyl-2-pentanone, and 0.80 g of a 1.75 w/5, aqueous solution of oxale acid. The mixture was reacted for ten hours at 40°C while stirring. The reaction was terminated by cooling the flask with ice. The reaction mixture was poured into a separating funnel to remove the water layer. The organic layer was washed with ion-exchanged water until the reaction solution becomes neutral. The solvent was removed from the organic layer to obtain the polysiloxane (1).

[0373] NMR spectrum (chemical shift o), IR spectrum, and Mw of the polysiloxane (1) were measured to confirm the following results.

σ: 2.3 ppm (-CH<sub>2</sub>C(CF<sub>3</sub>)<sub>2</sub> group), 1.5 ppm (t-butyl group)

IR: 1775 cm<sup>-1</sup> (ester group), 1219 cm<sup>-1</sup> (C-F bond), 1131 cm<sup>-1</sup> (siloxane group)

Mw: 1,700

Mw / Mn: 1.1

# 35 Example 25

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(Preparation of polysiloxane (1))

[0374] The polymer obtained in Example 24 was dissolved in 10.8 g of 4-methyl-2-pentanone. After the addition of 1,18 g of distilled water and 1.65 g of triethylamine, the mixture was observed to 40°C in a nitrogen stream. After five hours, themixture was cooled with ice and stirred, then a solution of 1.38 g of oxalic acid in 55 g of distilled water was added, and stirring was continued. The reaction mixture was poured into a separating funnel to remove the water layer. The organic layer was washed with ion-exchanged water until the reaction solution becomes neutral. The solvent was removed from the organic layer to obtain the polysiloxane (1).

45 [0375] NMR spectrum (chemical shift o), IR spectrum, and Mw of the polysiloxane (1) were measured to confirm the following results.

σ: 2.3 ppm (-CH<sub>2</sub>C(CF<sub>2</sub>)<sub>2</sub> group), 1.5 ppm (t-butyl group)

1775 cm<sup>-1</sup> (carbonic acid ester group), 1220 cm<sup>-1</sup> (C-F bond), 1133 cm<sup>-1</sup> (siloxane group)

50 Mw: 2,400

IB:

Mw/Mn: 1.1

## Example 26

#### 55 (Preparation of polysiloxane (1))

[0376] The polymer obtained in Example 24 was dissolved in 10.8 g of 4-methyl-2-pentanone. After the addition of 1.18 g of distilled water and 1.65 g of triethylamine, the mixture was heated to 60°C in a nitrogen stream. After five

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hours, the mixture was cooled with ice and stirred, then a solution of 1.38 g of oxalic acid in 50 g of distilled water was added, and stirring was continued. The reaction mixture was poured into a separating funnel to remove the water layer. The organic layer was washed with ion-exchanged water until the reaction solution becomes neutral. The solvent was removed from the organic layer to obtain the polysiloxane (1).

[0377] NMR spectrum (chemical shift o), IR spectrum, and Mw of the polysiloxane (1) were measured to confirm the following results.

σ: 2.3 ppm (-CH<sub>2</sub>C(CF<sub>3</sub>)<sub>2</sub> group), 1.5 ppm (t-butyl group)

1775 cm<sup>-1</sup> (carbonic acid ester group), 1221 cm<sup>-1</sup> (C-F bond), 1133 cm<sup>-1</sup> (siloxane group)

Mw: 2.700

Mw/Mn: 1.1

## Example 27

IB:

(Preparation of polysiloxane (1))

[0378] The polymer obtained in Example 24 was dissolved in 10.8 g of 4-methyl-2-pentanone. After the addition of 1.18 g of distilled water and 1.65 g of triethylarnine, the mixture was heated to 80°C in a nitrogen stream. After five hours, the mixture was colled with ice and stirred, then a solution of 1.38 g of oxalic acid in 50 g of distilled water was added, and stirring was continued. The reaction mixture was poured into a separating funnel to remove the water layer. The organic layer was washed with ine-exchanged water until the reaction solution becomes neutral. The solvent was removed from the organic layer to obtain the polysiloxane (1).

[0379]: NMR spectrum (chemical shift (o), IR spectrum, and Mw of the polysiloxane (1) were measured to confirm the following results.

σ: 2.3 ppm (-CH<sub>2</sub>C(CF<sub>3</sub>)<sub>2</sub> group), 1.5 ppm (t-butyl group)

1775 cm<sup>-1</sup> (carbonic acid ester group), 1220 cm<sup>-1</sup> (C-F bond), 1129 cm<sup>-1</sup> (siloxane group)

Mw: 3,500

Mw / Mn: 1.2

## Example 28

IR:

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(Preparation of polysiloxane (1))

35 [0380] A three-necked flask equipped with a stirrer, å reflux condenser, and a thermometer was charged with 1.50 g of the silicon containing alicyclic compound (2) of the above formula (2-42), 6.88 g of the silicon containing alicyclic compound (4) of the above formula (4-6) (wherein Rf is a trifluoromethyl group), 1.21 g of the silicon containing alicyclic compound (4) of the above formula (4-6) (wherein Rf is a trifluoromethyl group) by replacing the hydrogen atom of the hydroxyl group by a t-butoxycarbonyl group, 10 g of 4-methyl-2-pentanone, and 1.65 g of a 1.75 wf% aqueous solution of oxalic acid. The mixture was reacted for ten hours at 40°C while stirring. The reaction was terminated by cooling the flask with ice. The reaction mixture was poured into a separating funnel to remove the water layer. The organic layer was washed with ion-exchanged water until the reaction solution becomes neutral. The solvent was removed from the organic layer to obtain the polysiloxane (1).

[0381] NMR spectrum (chemical shift  $\sigma$ ), IR spectrum, and Mw of the polysiloxane (1) were measured to confirm the following results.

σ: 2.3 ppm (-CH<sub>2</sub>C (CF<sub>3</sub>)<sub>2</sub> group), 1.4 ppm (t-butyl group), 1.5 ppm (t-butoxycarbonyl group)

IR: 1775 cm<sup>-1</sup> (carbonic acid ester group), 1726 cm<sup>-1</sup> (ester group), 1221 cm<sup>-1</sup> (C-F bond), 1131 cm<sup>-1</sup> (siloxane

group) 2,300

Mw: 2,300 Mw/Mn: 1.1

# Example 29

(Preparation of polysiloxane (1))

[0382] A three-necked flask equipped with a stirrer, a reflux condenser, and a thermometer was charged with 1.86 g of the silicon containing alicyclic compound (2) of the above formula (2-42), 5.77 g of the silicon containing allcyclic

compound (4) of the above formula (4-6) (wherein Rf is a trifluoromethyl group), 2.36 g of the silicon containing alloyclic compound (4) of the above formula (4-6) (wherein Rf is a trifluoromethyl group) by replacing the hydrogen atom of the hydroxyl group by a t-butoxycarbonyl group, 10 g of 4-methyl-2-pentanone, and 1.61 g of a 1.75 wt% aqueous solution of oxalic acid. The mixture was reacted for ten hours at 40°C while stirring. The reaction was terminated by cooling the flask with ice. The reaction mixture was poured into a separating funnel to remove the water layer. The organic layer was washed with ion-exchanged water until the reaction solution becomes neutral. The solvent was removed from the organic layer to obtain 7.5 g of a polymer having Mw of 1,500 and Mw / Mn of 1.1.

[0383] The polymer was dissolved in 22.7 g of 4-methyl-2-pentanone. After the addition of 2.37 g of distilled water and 3.33 g of triethylamine, the mixture was heated to 60°C in a nitrogen stream. After five hours, the mixture was cooled with ice and stirred, then a solution of 2.77 g of oxalic acid in 70 g of distilled water was added, and stirring was continued. The reaction mixture was poured into a separating funnel to remove the water layer. The organic layer was washed with ion-exchanged water until the reaction solution becomes neutral. The solvent was removed from the organic layer to obtain the polysiloxane (1).

103841 NMR spectrum (chemical shift o), IR spectrum, and Mw of the polysiloxane (1) were measured to confirm the following results. 15

2.3 ppm (-CH<sub>2</sub>C(CF<sub>3</sub>)<sub>2</sub> group), 1.4 ppm (t-butyl group), 1.5 ppm  $\sigma$ :

(t-butoxycarbonyl group)

1775 cm<sup>-1</sup> (carbonic acid ester group), 1726 cm<sup>-1</sup> (ester group), 1220 cm<sup>-1</sup> (C-F bond), 1131 cm<sup>-1</sup> (siloxane IR:

aroup) 2.300

Mw: Mw / Mn: 1.1

# Example 30

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(Preparation of polysiloxane (1))

[0385] A three-necked flask equipped with a stirrer, a reflux condenser, and a thermometer was charged with 1.28 g of the silicon containing alicyclic compound (2) of the above formula (2-42), 3.30 g of the silicon containing alicyclic compound (4) of the above formula (4-6) (wherein Rf is a trifluoromethyl group), 2.43 g of the silicon containing alicyclic compound (4) of the above formula (4-6) (wherein Rf is a trifluoromethyl group) by replacing the hydrogen atom of the hydroxyl group by a t-butoxycarbonyl group, 7 g of 4-methyl-2-pentanone, and 1.10 g of a 1.75 wt% aqueous solution of oxalic acid. The mixture was reacted for ten hours at 40°C while stirring. The reaction was terminated by cooling the flask with ice. The reaction mixture was poured into a separating funnel to remove the water laver. The organic layer was washed with ion-exchanged water until the reaction solution becomes neutral. The solvent was removed from the organic layer to obtain 7.5 g of a polymer having Mw of 1,400 and Mw / Mn of 1.1.

[0386] The polymer was dissolved in 16.0 g of 4-methyl-2-pentanone. After the addition of 1.63 g of distilled water and 2.28 g of triethylamine, the mixture was heated to 60°C in a nitrogen stream. After five hours, the mixture was cooled with ice and stirred, then a solution of 1.90 g of oxalic acid in 50 g of distilled water was added, and stirring was continued. The reaction mixture was poured into a separating funnel to remove the water layer. The organic layer was washed with ion-exchanged water until the reaction solution becomes neutral. The solvent was removed from the organic layer to obtain the polysiloxane (1).

[0387] NMR spectrum (chemical shift o), IR spectrum, and Mw of the polysiloxane (1) were measured to confirm the following results.

2.3 ppm (-CH<sub>2</sub>C(CF<sub>3</sub>)<sub>2</sub> group), 1.4 ppm (t-butyl group), 1.5 ppm σ: (t-butoxycarbonyl group)

IR:

1776 cm<sup>-1</sup> (carbonic acid ester group), 1726 cm<sup>-1</sup> (ester group), 1220 cm<sup>-1</sup> (C-F bond), 1132 cm<sup>-1</sup> (siloxane group)

Mar 2.300

> Mw/Mn: 11

# Example 31

## (Preparation of polysiloxane (1))

[0388] A three-necked flask equipped with a stirrer, a reflux condenser, and a thermometer was charged with 2.79 g of the silicon containing alloyclic compound (4) of the above formula (4-6) (wherein Rf is a trifluoromethyl group), 1.14 g of the silicon containing alicyclic compound (4) of the above formula (4-6) (wherein Rf is a trifluoromethyl group) by replacing the hydrogen atom of the hydroxyl group by a t-butoxycarbonyl group, 1.07 g of the silicon containing alicyclic compound (4) of the above formula (4-42), 5 g of 4-methyl-2-pentanone, and 0.78 g of a 1.75 wt% agueous solution of oxalic acid. The mixture was reacted for ten hours at 40°C while stirring. The reaction was terminated by cooling the flask with ice. The reaction mixture was poured into a separating funnel to remove the water layer. The organic layer was washed with ion-exchanged water until the reaction solution becomes neutral. The solvent was removed from the organic layer to obtain 3.6 g of a polymer having Mw of 1,600 and Mw / Mn of 1.1.

[0389] The polymer was dissolved in 11.4 g of 4-methyl-2-pentanone. After the addition of 1.15 g of distilled water and 1.61 g of triethylamine, the mixture was heated to 60°C in a nitrogen stream. After five hours, the mixture was cooled with ice and stirred, then a solution of 1.34 g of oxalic acid in 50 g of distilled water was added, and stirring was continued. The reaction mixture was poured into a separating funnel to remove the water layer. The organic layer was washed with ion-exchanged water until the reaction solution becomes neutral. The solvent was removed from the organic layer to obtain the polysiloxane (1).

[0390] NMR spectrum (chemical shift o), IR spectrum, and Mw of the polysiloxane (1) were measured to confirm the following results.

2.3 ppm (-CH<sub>2</sub>C(CF<sub>3</sub>)<sub>2</sub> group), 1.5 ppm (t-butoxycarbonyl group)

ID: 1775 cm<sup>-1</sup> (carbonic acid ester group), 1221 cm<sup>-1</sup> (C-F bond), 1130 cm<sup>-1</sup> (siloxane group)

Mw: 2.500 Mw/Mn: 1.1

## Example 32

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(Preparation of polysiloxane (1))

[0391] A three-necked flask equipped with a stirrer, a reflux condenser, and a thermometer was charged with 3.19 g of the silicon containing alicyclic compound (4) of the above formula (4-6) (wherein Rf is a trifluoromethyl group), 2.35 g of the sillcon containing alicyclic compound (4) of the above formula (4-6) (wherein Rf is a trifluoromethyl group) by replacing the hydrogen atom of the hydroxyl group by a t-butoxycarbonyl group, 1.47 g of the silicon containing alicyclic compound (4) of the above formula (4-42), 7 g of 4-methyl-2-pentanone, and 1.07 g of a 1.75 wt% aqueous solution of oxalic acid. The mixture was reacted for ten hours at 40°C while stirring. The reaction was terminated by cooling the flask with ice. The reaction mixture was poured into a separating funnel to remove the water layer. The organic layer was washed with lon-exchanged water until the reaction solution becomes neutral. The solvent was removed from the organic layer to obtain 5.3 g of a polymer having Mw of 1,500 and Mw / Mn of 1.1.

[0392] The polymer was dissolved in 16.1 g of 4-methyl-2-pentanone, After the addition of 1.57 g of distilled water and 2.20 g of triethylamine, the mixture was heated to 60°C in a nitrogen stream. After five hours, the mixture was cooled with ice and stirred, then a solution of 1,83 g of oxalic acid in 50 g of distilled water was added, and stirring was continued. The reaction mixture was poured into a separating funnel to remove the water layer. The organic layer was washed with ion-exchanged water until the reaction solution becomes neutral. The solvent was removed from the organic layer to obtain the polysiloxane (1).

[0393] NMR spectrum (chemical shift σ ), IR spectrum, and Mw of the polysiloxane (1) were measured to confirm the following results.

2.3 ppm (-CH<sub>2</sub>C(CF<sub>3</sub>)<sub>2</sub> group), 1.5 ppm (t-butoxycarbonyl group) σ: IR:

1774 cm<sup>-1</sup> (carbonic acid ester group), 1220 cm<sup>-1</sup> (C-F bond), 1132 cm<sup>-1</sup> (siloxane group)

Mw: 2.500 1.1

Mw / Mn:

## Example 33

## (Preparation of polysiloxane (1))

[0394] A three-necked flask equipped with a stirrer, a reflux condenser, and a thermometer was charged with 0.45 g of the silicon containing alloyolic compound (2) of the above formula (2-42), 2.33 g of the silicon containing alloyolic compound (4) of the above formula (4-6) (wherein Rf is a trifluoromethyl group), 1.15 g of the silicon containing alicyclic compound (4) of the above formula (4-6) (wherein Rf is a trifluoromethyl group) by replacing the hydrogen atom of the hydroxyl group by a t-butoxycarbonyl group, 1.07 g of the silicon containing alicyclic compound (4) of the above formula (4-42). 5 g of 4-methyl-2-pentanone, and 0.78 g of a 1.75 wt% aqueous solution of oxalic acid. The mixture was reacted for ten hours at 40°C while stirring. The reaction was terminated by cooling the flask with ice. The reaction mixture was poured into a separating funnel to remove the water layer. The organic layer was washed with ion-exchanged water until the reaction solution becomes neutral. The solvent was removed from the organic layer to obtain 3.7 g of a polymer having Mw of 1,500 and Mw / Mn of 1.1.

a purpose liability with 1,000 and 1,115 g of 4-methyl-2-pentanone. After the addition of 1,15 g of distilled water and 1,61 g of triethylamine, the mixture was heated to 60°C in a nitrogen stream. After five hours, the mixture was cooled with ice and stirred, then a solution of 1,34 g of oxalic acid in 50 g of distilled water was added, and stirring was continued. The reaction mixture was poured into a separating funnel to remove the water layer. The organic layer was washed with ion-exchanged water until the reaction solution becomes neutral. The solvent was removed from the organic layer to obtain the polysilovane (1).

organic rayer to outside the polysiloxane (1) were measured to confirm the [0396] MMR spectrum (chemical shift o), IR spectrum, and Mw of the polysiloxane (1) were measured to confirm the following results.

2.3 ppm (-CH<sub>2</sub>C(CF<sub>3</sub>)<sub>2</sub> group), 1.4 ppm (t-butyl group), 1.5 ppm (t-butoxycarbonyl group)

IR: 1776 cm<sup>-1</sup> (carbonic acid ester group), 1725 cm<sup>-1</sup> (ester group), 1220 cm<sup>-1</sup> (C-F bond), 1130 cm<sup>-1</sup> (siloxane

group) Mw: 2,500

Mw/Mn: 1.1

# Example 34

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(Preparation of polysiloxane (1))

[0397] A three-necked flask equipped with a stirrer, a reflux condenser, and a thermometer was charged with 0.92 g of the sillcon containing alicyclic compound (2) of the above formula (2-42), 2.99 g of the sillcon containing alicyclic compound (4) of the above formula (4-6) (wherein Rf is a trifluoromethyl group), 0.59 g of the sillcon containing alicyclic compound (4) of the above formula (4-6) (wherein Rf is a trifluoromethyl group) by replacing the hydrogen atom of the hydroxyl group by a 1-butoxycethonyl group, 1.10 g of the sillcon containing alicyclic compound (4) of the above formula (4-42), 5 g of 4-methyl-2-pentanone, and 0.80 g of a 1.75 wt% aqueous solution of oxalic acid. The mixture was reacted for ten hours at 40°C while stirring. The reaction was terminated by cooling the flask with ice. The reaction mixture was poured into a separating funnel to remove the water layer. The organic layer was washed with ion-exchanged water until the reaction solution becomes neutral. The solvent was removed from the organic layer to obtain 3.7 g of a polymer having Mw of 1.50 and Mw / Mn of 1.1.

[0398] The polymer was disolved in 11.4 g of 4-methyl-2-pentanone. After the addition of 1.18 g of distilled water and 1.65 g of triethylamine, the mixture was heated to 60°C in a nitrogen stream. After five hours, the mixture was cooled with loe and stirred, then a solution of 1.37 g of oxalic acid in 50 g of distilled water was eadded, and stirring was continued. The reaction mixture was poured into a separating funnel to remove the water layer. The organic layer was washed with ion-exchanged water until the reaction solution becomes neutral. The solvent was removed from the organic layer to obtain the polysiloxane (1).

[0399] NMR spectrum (chemical shift o), IR spectrum, and Mw of the polysiloxane (1) were measured to confirm
the following results.

σ: 2.3 ppm (-CH<sub>2</sub>C (CF<sub>3</sub>)<sub>2</sub> group), 1.4 ppm (t-butyl group), 1.5 ppm (t-butoxycarbonyl group)

IR: 1775 cm<sup>-1</sup> (carbonic acid ester group), 1726 cm<sup>-1</sup> (ester group), 1221 cm<sup>-1</sup> (C-F bond), 1132 cm<sup>-1</sup> (slloxane

group)

Mw: 2.400

Mw / Mn: 1.1

## Example 35

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(Preparation of polysiloxane (1))

[0400] A three-necked flask equipped with a stirrer, a reflux condenser, and a thermometer was charged with 0.91 g of the silicon containing allcyclic compound (2) of the above formula (2-42), 1.87 g of the silicon containing allcyclic compound (4) of the above formula (4-6) (wherein Rf is a trifluoromethyl group), 1.15 g of the silicon containing allcyclic compound (4) of the above formula (4-6) (wherein Rf is a trifluoromethyl group) by replacing the hydrogen atom of the hydroxyl group by a t-butoxycarbornyl group, 1.08 g of the silicon containing allcyclic compound (4) of the above formula (4-42, 5 g of 4-methyl-2-pentianone, and 0.78 g of a 1.75 wf% aqueous solution of oxalic acid. The mixture was reacted

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for ten hours at 40°C while stirring. The reaction was terminated by cooling the flask with ice. The reaction mixture was poured into a separating funnel to remove the water layer. The organic layer was washed with ion-exchanged water until the reaction solution becomes neutral. The solvent was removed from the organic layer to obtain 3.6 g of a polymer having Mw of 1,500 and Mw / Mn of 1.1.

[0401] The polymer was dissolved in 11.4 g of 4-methyl-2-pentanone. After the addition of 1.15 g of distilled water and 1.62 g of triethylamine, the mixture was heated to 60°C in a nitrogen stream. After five hours, the mixture was cooled with ice and stirred, then a solution of 1.35 g of oxalic acid in 50 g of distilled water was added, and stirring was continued. The reaction mixture was poured into a separating funnel to remove the water layer. The organic layer was washed with ion-exchanged water until the reaction solution becomes neutral. The solvent was removed from the organic layer to obtain the polysiloxane (1).

[0402] NMR spectrum (chemical shift σ), IR spectrum, and Mw of the polysiloxane (1) were measured to confirm the following results.

2.3 ppm (-CH<sub>2</sub>C (CF<sub>3</sub>)<sub>2</sub> group), 1.4 ppm (t-butyl group), 1.5 ppm (t-butoxycarbonyl group)

15 1774 cm<sup>-1</sup> (carbonic acid ester group), 1726 cm<sup>-1</sup> (ester group), 1226 cm<sup>-1</sup> (C-F bond), 1130 cm<sup>-1</sup> (siloxane

group) Mw: 2.400

Mw/Mn 11

# Evaluation Example 6

# (Evaluation of radiation transmittance)

[0403] The radiation transmittance of coating films with a thickness of 100 nm prepared from the polysiloxane of 25 Example 25-32 at wavelengths of 157 nm and 193 nm was measured. The results are shown in Table 3.

# Table 3

Polysiloxane	Radiation transmittance (%)		
	157 nm	193 nm	
Polysiloxane (1) of Example 25	67	97	
Polysiloxane (1) of Example 26	67	97	
Polysiloxane (1) of Example 27	66	97	
Polysiloxane (1) of Example 28	56	95 -	
Polysiloxane (1) of Example 29	. 54	95	
Polysiloxane (1) of Example 30	52	94	
Polysiloxane (1) of Example 31	61	94	
Polysiloxane (1) of Example 32	60 "	94 .	

## Example 36

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## (Radiation-sensitive resin composition)

[0404] A solution composition was prepared by homogeneously mixing 100 parts of the polysiloxane obtained in Example 22, Example 23, Example 25-29, Example 31, Example 32 or Comparative Example 6, 1 part of triphenylphosphonium nonafluoro-n-butenesulfonate, 0.02 part of tri-n-octylamine, and 900 parts of 2-heptanone.

[0405] The solution composition was applied onto a silicon wafer substrate by spin coating and pre-baked for 90 seconds at 140°C to form a resist film with a thickness of 100 nm.

[0406] The resist film was exposed to an ArF excimer laser (wavelength: 193 nm) or F2 excimer laser (wavelength: 157 nm) while changing the irradiation dose, post-baked for 90 seconds on a hot plate at 110°C, and then developed in a 2.38 wt% acueous solution of tetramethylammonium hydroxide.

[0407] Observation of the exposed area on the substrate by a scanning-type electron microscope confirmed that the limit resolution are shown in Table 4.

Table 4

Polysiloxane	limit resolution (µm)		
*	ArF	F2	
Polysiloxane (1) of Example 22	0.15	0.07	
Polysiloxane (1) of Example 23	0.14	0.07	
Polysiloxane (1) of Example 25	0.16	_	
Polysiloxane (1) of Example 26	0.15	0.11	
Polysiloxane (1) of Example 27	0.15	_	
Polysiloxane (1) of Example 28	0.14	l	
Polysiloxane (1) of Example 29	0.13	0.08	
Polysiloxane (1) of Example 31	0.14	-	
Polysiloxane (1) of Example 32	0.13	0.08	
Polysiloxane of Comparative Example 6	0.30	0.30 -	

#### Example 37

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# (Preparation of polysiloxane (3)) .

[0408] A three-necked flask equipped with a stirrer, a reflux condensor, and a thermometer was charged with 2.06 g of the silicon containing alicyclic compound (2) of the above formula (2-39), 2.94 g of methytrimethoxysilane, 15 g of 4-methyl-2-pentanner, and 1.49 g of a 1.75 wt% aqueous solution of oxalic acid. The mixture was reacted for five hours at 80°C while stirring, followed by cooling with loe to terminate the reaction. The reaction mixture was poured into a separating funnel to remove the water layer. The organic layer was weated with ino-acchanged water until the reaction solution becomes neutral. The solvent was removed from the organic layer to obtain the polysiloxane (3).
[0409] NMR spectrum (chemical shift o), IR spectrum, and Mw of the polysiloxane (3) were measured to confirm the following results.

σ: 1.4 ppm (t-butyl group), 0.2 ppm (SiCH<sub>3</sub> group)

: 1705 cm<sup>-1</sup> (ester group), 1116 cm<sup>-1</sup> (siloxane group)

Mw: 2.600

# 5 Example 38

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## (Preparation of polysiloxane (3))

[0410] A three-necked flask is quipped with a stirrer, a reflux condenser, and a thermometer was charged with 1.48 g of the silicon containing alicyclic compound (2) of the above formula (24-2), 1.52 g of the silicon containing alicyclic compound (4) of the above formula (4-6) (wherein Rf is a trifluoromethyl group), 9 g of 4-methyl-2-pentanone, and 0.51 g of a 1.75 wt% aqueous solution of oxalic acid. The mixture was receited for six hours at 80°C while stirring, followed by cooling to terminate the reaction. The reaction mixture was poured into a separating funnel to remove the water layer. The organic layer was washed with lon-exchanged water until the reaction solution becomes neutral. The solvent was removed from the organic layer to obtain the polysiloxane (3).

[0411] NMR spectrum (chemical shift  $\sigma$ ), IR spectrum, and Mw of the polysiloxane (3) were measured to confirm the following results.

σ: 2.3 ppm (two CF<sub>3</sub> groups bonded to a CH<sub>2</sub>C group), 1.4 ppm (t-butyl group)

IR: 1703 cm<sup>-1</sup> (ester group), 1213 cm<sup>-1</sup> (C-F bond), 1151 cm<sup>-1</sup> (siloxane group)

Mw: 1,900

## Example 39

## (Preparation of polysiloxane (3))

[0412] A three-necked flask equipped with a stirrer, a reflux condenser, and a thermometer was charged with 0.58

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g of the silicon containing alicyclic compound (2) of the above formula (2-42), 2.42 g of the silicon containing alicyclic compound (4) of the above formula (4-6) (wherein Ri is a trifluoromethyl group), 9 g of 4-methyl-2-perhanone, and 0.15 g of a 1.75 wt% aqueous solution of oxalic add. The mixture was reacted for six hours at 80°C while stirring, followed by cooling to terminate the reaction. The reaction mixture was poured into a separating funnel to remove the water layer. The organic layer was washed with ion-exchanged water until the reaction solution becomes neutral. The solvent was removed from the organic layer to washing the polysiloxane (3).

[0413] NMR spectrum (chemical shift o), IR spectrum, and Mw of the polysiloxane (3) were measured to confirm the following results.

- σ: 2.3 ppm (two CF<sub>a</sub> groups bonded to a CH<sub>a</sub>C group), 1.4 ppm (t-butyl group)
  - IR: 1703 cm<sup>-1</sup> (ester group), 1213 cm<sup>-1</sup> (C-F bond), 1143 cm<sup>-1</sup> (siloxane group)
  - Mw: 2,400

# Example 40

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(Preparation of polysiloxane (3))

- [0414] A three-necked flask equipped with a sitrre, a reflux condenser, and a thermometer was charged with 1.52 g of the silicon containing alicyclic compound (2) of the elbove formula (2-42), 1.57 g of the silicon containing alicyclic compound (4) of the above formula (4-6) (wherein Ri is a trifluoromethyl group), 1.91 g of methyltriethoxysilane, 15 g of 4-methyl-2-pentanone, and 1.31 g of a 1.75 wt% aqueous solution of oxalic acid. The mixture was poured into a separating funnel to remove the water layer. The organic layer was washed with ion-exchanged water until the reaction solution becomes neutral. The solvent was removed from the organic layer to obtain the polysiloxane (3).
- 25 [0415] NMR spectrum (chemical shift σ), IR spectrum, and Mw of the polysiloxane (3) were measured to confirm the following results.
  - σ: 2.3 ppm (two CF<sub>3</sub> groups bonded to a CH<sub>2</sub>C group), 1.4 ppm (t-butyl group), 0.2 ppm (SiCH<sub>3</sub> group)
  - IR: 1699 cm<sup>-1</sup> (ester group), 1213 cm<sup>-1</sup> (C-F bond), 1124 cm<sup>-1</sup> (siloxane group)
- 0 Mw: 1,900

## Example 41

(Preparation of polysiloxane (3)) .

- [0416] A three-necked flask equipped with a sitirer, a reflux condenser, and a thermometer was charged with 1.26 g of the silicon containing alicyclic compound (4) of the silicon containing alicyclic compound (4) of the above formula (4-6) (wherein Ri is a trilluoromethyl group), 1.07 g of methyltisehoxysiane, 15 g of 4-methyl-2-pentanone, and 1.11 g of a 1.76 wt% aqueous solution of oxalic acid. The mixture was reacted for six hours at 80°C while attring, followed by cooling to terminate the reaction. The reaction mixture was poured into a separating funnel to remove the water layer. The organic layer was washed with ion-exchanged water until the reaction solution becomes neutral. The solvent was removed from the organic layer to obtain the polysiloxane (3).

  [0417] NMR spectrum (chemical shift of, 18 spectrum, and Mw of the polysiloxane (3) were measured to confirm the
  - following results.
  - c: 2.3 ppm (two CF<sub>3</sub> groups bonded to a CH<sub>2</sub>C group), 1.4 ppm (t-butyl group), 0.2 ppm (SiCH<sub>3</sub> group)
     f: 1703 cm<sup>-1</sup> (ester group), 1213 cm<sup>-1</sup> (C-F bond), 1140 cm<sup>-1</sup> (siloxane group)
     Mw: 2, 900

#### 50 Example 42

(Preparation of polysiloxane (3))

[0418] A three-necked flask equipped with a stirrer, a reflux condenser, and a I hermometer was charged with 1.44 g of the silicon containing alloyclic compound (2) of the above formula (2-42), 1.60 g of the silicon containing alloyclic compound (4) of the above formula (4-6) (wherein RI is a trifluoromethyl group), 1.95 g of methyltiethoxysilane, 15 g of 4-methyl-2-perlianone, and 1.34 g of a 1.75 wt% aqueous solution of oxalic acid. The mixture was pround into a hours at 80°C while stirring, followed by cooling to terminate the reaction. The reaction mixture was poured into a

separating funnel to remove the water layer. The organic layer was washed with ion-exchanged water until the reaction solution becomes neutral. The solvent was removed from the organic layer to obtain the polysiloxane (3). [0419] MRS spectrum (chemical shift of), IR spectrum, and Mw of the polysiloxane (3) were measured to confirm the following results.

5: 2.3 ppm (two CF<sub>3</sub> groups bonded to a CH<sub>2</sub>C group), 1.4 ppm (t-butyl group), 0.2 ppm (SiCH<sub>3</sub> group)

1699 cm<sup>-1</sup> (ester group), 1213 cm<sup>-1</sup> (C-F bond), 1124 cm<sup>-1</sup> (siloxane group)

Mw: 1,300 ·

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# Evaluation Example 7

(Evaluation of radiation transmittance)

[0420] The radiation transmittance of coating films with a thickness of 100 nm prepared from the polysiloxanes (3) of Examples 39-42 at wavelengths of 157 nm and 193 nm was measured. For results are shown in Table 5.

Table 5

Polysiloxane	Radiation transmittance (%	
	157 nm	193 nm
Polysiloxane (3) of Example 39	52	. 98
Polysiloxane (3) of Example 40	42	96
Polysiloxane (3) of Example 41	: 48	97 -
Polysiloxane (3) of Example 42	42	96

[0422] The results show that the polysiloxanes (3) exhibit superior transmittance at a wavelength less than 193 nm, particularly at 157 nm. This indicates that the polysiloxane (3) is a very useful resin in a lithography process using a short wavelength radiation such as an ArF excimer laser (wavelength: 193 nm) or F2 excimer laser (wavelength: 157 nm).

# Comparative Example 7

# (Preparation of comparative polysiloxane)

[0423] A three-necked flask equipped with a stirrer, a reflux condenser, and a thermometer was charged with 1.62 g of the siliane compound (III) of the formula (3), wherein R is a hydrogen atom, R is an ethyl group, and n is 0, 1.98 g of the silicno containing alloyalco compound (4) shown by the formula (4-6), 2.41 g of methyltriethoxysilane, 6.0 g of 4-methyl-2-pentanone, and 1.65 g of a 1.75 wt% aqueous solution of oxalic acid. The mixture was reacted for sk hours at 80°C while stirring, followed by cooling with ice to terminate the reaction. The reaction mixture was poured into a separating funnel to remove the water layer. The organic layer was washed with ion-exchanged water until the reaction solution becomes neutral. The solvent was removed from the organic layer to obtain a comparative polymer.

[0424] NMR spectrum (chemical shift o) and IR spectrum of the comparative polysiloxane were measured. The results were as follows.

g: 2.3 ppm (two CF<sub>3</sub> groups bonded to a CH<sub>2</sub>C group), 1.5 ppm (t-butoxy group), 0.2 ppm (SiCH<sub>3</sub> group)

IR: 3400 cm<sup>-1</sup> (hydroxyl group), 1703 cm<sup>-1</sup> (carbonyl group), 1213 cm<sup>-1</sup> (C-F bond), 1130 cm<sup>-1</sup> (siloxane group), 1080 cm<sup>-1</sup> (siloxane group)

#### Evaluation Example 8

#### (Evaluation of glass transition temperature)

[0425] Glass transition temperature of the polysiloxanes obtained in Example 40, Example 41, and Comparative Example 7 was measured to confirm that the glass transition temperature of these polysiloxanes was respective 118°C, 116°C, and 94°C. These results show that the polysiloxane (3) of the formula (3) in which n'-1 has a thigher glass transition temperature than the polysiloxane of the formula (3) in which n'-1 and is more useful as a material

for forming fine rectangular resist patterns by a conventional lithography process.

## Example 43

- (Radiation-sensitive resin composition)
  - [0426] A solution composition was prepared by homogeneously mixing 100 parts of the polysiloxane (3) obtained in Example 40, 1 part of triphenylsulfonium trifluoromethane sulfonate, 0.02 part of tri-n-octylamine, 900 parts of 2-heptanone
- 0 [0427] The solution composition was applied onto a silicon wafer substrate by spin coating and pre-baked for 90 seconds at 130°C to form a resist film with a thickness of 100 nm.
  - [0428] The resist film was exposed to a KrF excimer laser through a photo mask while changing the irradiation dose, post-based for 95 esconds on a hot plate at 110°C, and then developed in a 2.38 wt% aqueous solution of tetramethylammonium hydroxide to form a resist pattern.
- [9429] The exposed area on the substrate was observed by an electronic microscope to confirm that the patterns were resolved to a line size as fine as 0.24 µm and maintained a rectangular configuration.
  - [0430] Resist patterns were prepared and evaluated in the same manner as above except for using the polysiloxane (3) obtained in Example 41 instead of the polysiloxane (3) obtained in Example 40, to confirm that the patterns were resolved to a line size as fine as 0.24 µm, with the pattern configuration maintaining a rectangle.

## Comparative Example 8

(Comparative Radiation-sensitive resin composition)

[0431] Resist patterns were formed and evaluated in the same manner as above except for using the polysiloxane of Comparative Example 7 in place of the polysiloxane (3) of Example 40, to confirm that the patterns were resolved to a line width as fine as 0.9 µm, but did not maintain a rectangular configuration.

## Example 44

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(Radiation-sensitive resin composition)

- [0432] A solution composition was prepared by homogeneously mixing 100 parts of the polysloxane (3) obtained in Example 40, 1 part of triphenylsulfonium trifluoromethane sulfonate, 0.02 part of tri-n-octylamine, 900 parts of 2-heptanone.
- [0433] The solution composition was applied onto a silicon wafer substrate by spin coating and pre-baked for 90 seconds at 130°C to form a resist film with a thickness of 100 nm.
- [0434] The resist film was exposed to an F2 exclimer laser through a photo mask while changing the irradiation dose, post-baked for 80 seconds on a hot plate at 110°C, and then developed in a 2.38 wt% aqueous solution of tetrameth-learmonium hydroxide to form a resist pattern.
- [0435] The exposed area on the substrate was observed by an electronic microscope to confirm that the patterns were resolved to a line size as fine as 0.10 µm and maintained a rectangular configuration.
- [0436] Resist patterns were formed and evaluated in the same manner as above except for using the polysiloxane (3) obtained in of Comparative Example 7 in place of the polysiloxane (3) of Example 40, to confirm that the patterns were resolved to a line width as fine as 0.10 µm and maintained a rectangular configuration.

## Example 45

(Synthesis of silicon-containing alicyclic compound (4))

- [0437] A three-necked flask equipped with a stirrer, a reflux condenser, and a thermorneter was charged with 15.4 of trimethoxysilane and 20.9 of 5-[24-brotyo-y.2-24] diffusioromethyl) bisyologic 2.1 hperio-2-ene. The mixture was stirred at room temperature and 0.2 ml of a 0.2 mol chloroplatinic acid (H<sub>2</sub>PiCl<sub>6</sub>) solution in isopropyl alcohol was added to initiate the reaction. The reaction was continued for 48 hours at 100°C while refluxing. The reaction mixture was allowed to cool to room temperature, diluted with n-hexane, and filtered through cellite by suction. The solvent was evaporated by distillation under vacuum to obtain a crude product. The crude product was purified by vacuum distillation at 2 mmHq and a temperature of 110°C to obtain 12.2 g of the reaction product.
  - [0438] This reaction product was identified to be the silicon containing alicyclic compound (4) of the formula (4-3)

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(in which Rf is a trifluoromethyl group) by the measurement of <sup>1</sup>H-NMR spectrum (chemical shift σ H), <sup>13</sup>C-NMR spectrum (chemical shift σ C), <sup>29</sup>Si-NMR spectrum (chemical shift σ Si), <sup>19</sup>F-NMR spectrum (chemical shift σ F), IR spectrum, and mass spectrum (FABMS).

- σ H: 3.6 ppm (methoxy group)
  - 123 ppm (trifluoromethyl group), 51 ppm (methoxy group) σC:
  - σSi -45 ppm
  - σF: -76 to -79 ppm
  - 3400 cm<sup>-1</sup> (hydroxyl group), 2847 cm<sup>-1</sup> (methoxy group), 1217 cm<sup>-1</sup> (C-F bond), 1097 cm<sup>-1</sup> (siloxane group) IR-
- FABMS:  $m/z = 397 (M^+ + 1)$

## Example 46

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(Synthesis of silicon-containing alicyclic compound (4))

[0439] A three-necked flask equipped with a stirrer, a reflux condenser, and a thermometer was charged with 38.8 g of triethoxysillane and 43.2 g of 5-[2-hydroxy-2,2-di(trifluoromethyl)]-bicyclo[2,2.1]hepto-2-ene. The mixture was stirred at room temperature and 0.1 ml of a 0.2 mol chloroplatinic acid (H<sub>2</sub>PtCl<sub>6</sub>) solution in isopropyl alcohol was added to initiate the reaction. The reaction was continued for 30 hours at 100°C while refluxing. The reaction mixture was allowed to cool to room temperature, diluted with n-hexane, and filtered through celite by suction. The solvent was evaporated by distillation under vacuum to obtain a crude product. The crude product was punfied by vacuum distillation at 3 mmHg and a temperature of 105°C to obtain 59.8 g of the reaction product.

[0440]. As the result shown below, this reaction product was identified to be the silicon containing alloyclic compound (4) of the formula (4-6) (in which Rf is a trifluoromethyl group) by the measurement of 1H-NMR spectrum (chemical shift σ H), <sup>13</sup>C-NMR spectrum (chemical shift σ C), <sup>29</sup>Si-NMR spectrum (chemical shift σ Si), <sup>19</sup>F-NMR spectrum (chemical shift σ F), IR spectrum, and mass spectrum (FABMS).

- 3.8 ppm (ethoxy group), 1.2 ppm (ethoxy group) σH:
- 123 ppm (trifluoromethyl group), 59 ppm (ethoxy group), 18 ppm (methyl group) σC:
- σSi: -48 ppm
  - -76 to -79 ppm σF:
  - 3400 cm<sup>-1</sup> (hydroxyl group), 2878 cm<sup>-1</sup> (methoxy group), 1215 cm<sup>-1</sup> (C-F bond), 1082 cm<sup>-1</sup> (siloxane group) IR: FABMS:,  $m/z = 439 (M^+ + 1)$

#### 35 Example 47

(Synthesis of silicon-containing alicyclic compound (4))

- [0441] A three-necked flask equipped with a stirrer, a reflux condenser, and a thermometer was charged with 3.0 g of the silicon containing alloyclic compound (4) obtained in Example 44, and 10 ml of tetrahydrofuran. The mixture was stirred in a nitrogen stream while cooling with ice. When the mixture was cooled to 5°C, 16.7 mg of 4-dimethylaminopyridine was added and a solution of 1.64 g of di-t-butyldicarbonate in 5 ml of tetrahydrofuran was added dropwise over 15 minutes. After the addition, the mixture was stirred for one hour, allowed to cool to room temperature, and stirred for a further five hours. After the addition of 50 ml of n-hexane, the reaction mixture was poured into a separating funnel. The organic layer was washed three times with ice-cooled water. The reaction mixture was charged into a beaker and dried over anhydrous magnesium sulfate, then the solvent was evaporated under vacuum to obtain a crude product. The crude product was purified by silica gel column chromatography to obtain 3.5 g of the compound from the n-hexage fraction.
- [0442] As shown by the following results of measurement of <sup>1</sup>H-NMR spectrum (chemical shift  $\sigma$  H). <sup>13</sup>C-NMR spectrum (chemical shift  $\sigma$  C), <sup>29</sup>Si-NMR spectrum (chemical shift  $\sigma$  Si), <sup>19</sup>F-NMR spectrum (chemical shift  $\sigma$  F), IR spectrum (chemica trum, and mass spectrum (FABMS), this reaction product was identified to be the silicon containing alloyclic compound (4) derived from the compound of the formula (4-6) (in which Rf is a trifluoromethyl group) by replacing the hydrogen atom of the hydroxyl group with a t-butoxycarbonyl group.
- 3.8 ppm (ethoxy group), 1.2 ppm (ethoxy group), 1.5 ppm (t-butyl group) σ H:
  - 149 ppm (carbonate group), 122 ppm (trifluoromethyl group), 85 ppm (t-butoxy group), 59 ppm (ethoxy σC: group), 28 ppm (t-butyl group), 18 ppm (methyl group)
  - σSi: -48 ppm

- σ F: -72.7 to -73.3 ppm
- IR: 3400 cm<sup>-1</sup> (hydroxyl group), 2879 cm<sup>-1</sup> (methoxy group), 1774 cm<sup>-1</sup> (carbonate group), 1221 cm<sup>-1</sup> (C-F bond), 1082 cm<sup>-1</sup> (siloxane group)

FABMS: m/z = 539 (M+ + 1)

## Example 48

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(Synthesis of silicon-containing alicyclic compound (4))

[0443] A three-necked flask equipped with a sittre, a dropping funnel, and a thermometer was charged with 10 g of the silicon containing alloycic compound (4) obtained in Example 45 and 50 ml of tetrahydrofuran. The mixture was stirred in a nitrogen stream while cooling with ice. When the mixture was cooled to 5°C, 48.4 mg of 4-dimethylaminopyridine was added and a solution of 4.75 g of di-t-butyldicarbonate in 10 ml of tetrahydrofuran was added dropwise over 20 minutes. After the addition, the mixture was stirred for one hour, allowed to cool to room temperature, and stirred for a further five hours. After the addition of 100 ml of n-hexane, the reaction mixture was poured into a separating funnel. The organic layer was washed three times with ice-cooled water. The reaction mixture was charged into a beaker and dried over anhydrous magnesium sulfate, then the solvent was evaporated under vácuum to obtain 10.3 g of the product.

[0444] As shown by the following results of <sup>1</sup>H-NMR spectrum (chemical shift o H) and IR spectrum measurement, this reaction product was identified to be the ellicon containing alicyclic compound (4) derived from the compound of the formula (4-3) (in which Rf is a trifluoromethyl group) by replacing the hydrogen atom of the hydroxyl group with a t-butoxycarbonyl group.

- σ H: 3.6 ppm (methoxy group), 1.5ppm (t-butoxycarbonyl group)
- IR: 1770 cm<sup>-1</sup> (carbonate group), 1220 cm<sup>-1</sup> (C-F bond), 1098 cm<sup>-1</sup> (siloxane group)

## Example 49

(Synthesis of silicon-containing alicyclic compound (4))

[0445] A. three-necked flask equipped with a stirrer, a reflux condenser, and a thermometer was charged with 18.1 gof trienty/sliene and 25.0 g of 8-12-hydroxy-2,2-d(infilioromethy/l)terracyolo(4.0.,124-7,170]dodeca-3-ene. The mixture was stirred at room temperature and 0.2 mil of a 0.2 mol chloroplatine acid (Hg-PCQ) solution in lisopropyl alond was added to initiate the reaction. The reaction was continued for 70 hours at 150°C while refluxing. The reaction mixture was allowed to cool to room temperature, diluted with n-hexane, and filtered through ceille by suction. The solvent was removed from the filtrate by evaporation under vacuum to obtain a crude product. The crude product was purified by silicin gel column chromatography to obtain 19.4 g of the compound from the n-hexane fraction.

[0446] As shown by the following results of <sup>1</sup>H-NMR spectrum (chemical shift σ H) and IR spectrum measurement, this reaction product was identified to be the silicon containing alicyclic compound (4) of the formula (4-42) (in which Rf is a trifluoromethyl group).

- H: 3.8 ppm (ethoxy group), 1.2 ppm (ethoxy group)
- R: -3400 cm<sup>-1</sup> (hydroxyl group), 1220 cm<sup>-1</sup> (C-F bond), 1098 cm<sup>-1</sup> (siloxane group)

## 5 Example 50

(Synthesis of silicon-containing alicyclic compound (4))

[0447] A three-necked flack equipped with a stirrer, a dropping funnel, and a thermometer was charged with 3 g of the silicon containing alloyclic compound (4) obtained in Example 47 and 10 ml of tetrahydroturan. The mixture was stirred in a nitrogen stream while cooling with ice. When the mixture was cooled to 5°C, 4.6 mg of 4-dimethylaminopyridine was added and a solution of 1.43 g of di-t-butyldicarbonate in 5 ml of tetrahydroturan was added dropwise over 15 minutes. After the addition, the mixture was stirred for one hour, allowed to cool to room temperature, and stirred for a further five hours. After the addition of 50 ml of n-hexane, the reaction mixture was poured into a separating funnel. The organic layer was washed three times with ice-cooled water. The reaction mixture was charged into a beaker and dried over anhydrous magnesium sulfate, then the solvent was evaporated under vacuum to obtain a crude product. The crude product was purified by silica gel column chromatography to obtain 3.2 g of the compound from the n-hexane fraction.

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[0448] As shown by the following results of <sup>1</sup>H-NMR spectrum (chemical shift or H) and IR spectrum measurement; this reaction product was identified to be the silicon containing alloyolic compound (4) derived from the compound of the formula (4-42) (in which Rf is a trifluoromethyl group) by replacing the hydrogen atom of the hydroxyl group with a 1-butoxycarbonyl group.

σ H: 3.8 ppm (ethoxy group), 1.5ppm (t-butoxycarbonyl group), 1.2 ppm (ethoxy group)
 1771 cm<sup>-1</sup> (carbonate group), 1218 cm<sup>-1</sup> (C-F bond), 1098 cm<sup>-1</sup> (siloxane group)

## Example 51

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(Synthesis of silicon-containing alicyclic compound (4))

[0449] A three-necked flask equipped with a stirrer, a reflux condenser, and a thermometer was charged with 13.8 got diethoxymethylsiane and 40.0 got 51-5(2.2-Liffluor-1-ethyl-1-tydroxysythylbicydo(2.2-Liflpab-2-eth-1-flaver) high pickydologo and the properties and 0.2 ml of a 0.2 mol chloroplatinic acid (H<sub>2</sub>PrCl<sub>2</sub>) solution in isopropyl alcohol was added to initiate the reaction. After heating at 100°C for 48 hours while refluxing, the reaction mixture was allowed copi to room temperature, diluted with n-havane, and filtered through ceitle by suction. The solvent was removed from the strate by evaporation under vacuum to obtain a crude product. The crude product was purified by vacuum distillation at 3 mmHz and a temperature of \$8°C to obtain 41 g of the reaction product.

[0450] As shown by the following results of 1H-NMR spectrum (chemical shift of H) and IR spectrum measurement, this reaction product was identified to be the silicon containing alleyclic compound (4) of the formula (4-5) (in which Rf is a triflucoremetryl group).

σ H: : 3.8 ppm (ethoxy group), 1.2 ppm (ethoxy group), 0.2 ppm (SiCH<sub>3</sub> group) |R: : 3400 cm<sup>-1</sup> (hydroxyl group), 1218 cm<sup>-1</sup> (C-F bond), 1098 cm<sup>-1</sup> (siloxane group)

# Example 52

(Synthesis of silicon-containing alicyclic compound (4))

[0451] A three-necked flask equipped with a stirrer, a reflux condenser, and a thermometer was charged with 12.0 g of methylhydrocyclosiloxane and 54.8 g of 5/2-hydroxy-2,2-dit(tfliutomethyll)bloyclo2.2.1)hepto-2-ene. The mix-ture was stirred at room temperature and 5.0 ml of a 0.2 ml of chorpolatine acid (fl-ghCl<sub>0</sub>) solution in lospropryl alcohol was added to initiate the reaction. The reaction was continued for 100 hours at 150°C while refluxing. The reaction mixture was allowed to cool to room temperature, diluted with n-hexane, and filtered through cellic by suction. The solvient was removed from the filtrate by evaporation under vacuum to obtain 66.0 g of the product.

[0452] As shown by the following results of 1H-NMR spectrum (chemical shift or H) and IR spectrum measurement, this reaction product was identified to be the silicon containing alloyalic compound (4) of the formula (4-91) (in which the unit number of -SICH4,0)-is 4).

σ H: 0.2 ppm (SiCH<sub>2</sub> group)

IR: 3400 cm<sup>-1</sup> (hydroxyl group), 2847 cm<sup>-1</sup> (methoxy group), 1218 cm<sup>-1</sup> (C-F bond), 1098 cm<sup>-1</sup> (siloxane group)

# Example 53

(Synthesis of silicon-containing alicyclic compound (4))

[0453] A three-necked flask equipped with a stirrer, a dropping funnel, and a thermometer was charged with 5 g of the compound obtained in Example 52 and 15 ml of tetrahydrofuran. The mixture was stirred in a nitrogen stream while cooling with iee. When the mixture was cooled to 5°C, 36.6 mg of 4-dimethylaminopyridine was added and a solution of 3.6 g of dit-butylidicarbonate in 5 ml of tetrahydrofuran was added dropwise over 15 minutes. After the addition, 6 mixture was stirred for one hour, allowed to cool to room temperature, and stred for a further five hours. After the addition of 70 ml of n-hexane, the reaction mixture was poured into a separating funnel. The organic layer was washed three times with ice-cooled water. The reaction mixture was charged into a beaker and dried over anhydrous magnesium sulfate, then the solvent was removed by distillation under vacuum to obtain 5.5 g of a product.

[0454] As shown by the following results of \*IH-NMR spectrum (chemical shift of I) measurement, this reaction product was identified to be the silicon containing alloyelic compound (4) derived from the compound of the formula (4-91) (in which the unit number of -\$\$(CH<sub>2</sub>O)-is 4) by replacing the hydrogen atom of the hydroxyl group in the compound

with a t-butoxycarbonyl group.

σ: 1.5 ppm (t-butoxycarbonyl group), 0.2 ppm (SiCH<sub>3</sub> group)

#### 5 Example 54

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[0455] A three-necked flask equipped with a stirrer, a reflux condenser, and a thermometer was charged with 10 g of methyhydrocyclosiloxane and 56.7 g of 8-[2-hydroxy-2,2-dit/fiffluor-methyi)[letracyclof4,4.0.12-5],71.0 [dodeca-5-ene. The mixture was stirred at room temperature and 5.0 ml of a 0.2 ml of choroplatinic acid ( $\frac{1}{1}$ - $\frac{1}{2}$ -

σ H: 0.2 ppm (SiCH<sub>3</sub> group)

IR: 3400 cm<sup>-1</sup> (hydroxyl group), 2849 cm<sup>-1</sup> (methoxy group), 1220 cm<sup>-1</sup> (C-F bond), 1100 cm<sup>-1</sup> (siloxane group)

## 20 Example 55

(Synthesis of silicon-containing alicyclic compound (4))

[0457] A three-necked flask equipped with a stirrer, a dropping funnel, and a thermometer was charged with 5.0 g of the sillion containing alloyelic compound (4) obtained in Example 54 and 15 mil of testarytorfuran. The mixture was stirred in a nitrogen stream while cooling with ice. When the mixture was cooled to 5°C, 30.5 m g of 4-dimethylaminopyridine was added and a solution of 3.0 g of di-t-butyldicarbonate in 5 mil of tetrahydrofuran was added dropwise over 15 minutes. After the addition, the mixture was stirred for one hour; allowed to cool to room temperature, and stirred for a further five hours. After the addition of 7ml of n-hexane, the reaction mixture was poured into a separating funnel. The croganic layer was washed three times with ice-cooled water. The reaction mixture was charged into a beaker and dried over anhydrous magnesium sulfate, then the solvent was removed by distillation under vacuum to obtain 5.3 g of a product.

[0458] As shown by the following results of <sup>1</sup>H-NMR spectrum (chemical shift of H) measurement, this reaction product was identified to be the silicon containing alicyclic compound (4) derived from the compound of the formula (4-97) (in which the unit number of -Si(CH<sub>3</sub>)O- is 4) by replacing the hydrogen atom of the hydroxyl group in the compound with a t-butoxycarbomyl group.

σ: 1.5 ppm (t-butoxycarbonyl group), 0.2 ppm (SiCH<sub>o</sub> group)

## Example 56

(Preparation of polysiloxane (5))

[0459] A three-necked flask equipped with a stirrer, a reflux condenser, and a thermometer was charged with 2.5 g of the silicon containing alloyclic compound (4) shown by the above formula (4-6) (wherein Rf is a triflurormethyl group), 2.5 g of 4-methyl-2-pentanone, and 0.42 g of 1.75 wt% oxalic acid aqueous solution. The mixture was reacted for six hours at 80°C while stirring. The reaction was terminated by cooling the flask with loc. The reaction mixture was poured into a separating funnel to remove the water layer. The organic layer was washed with water until the reaction solution becomes neutral and the solvent was removed by distillation under vacuum to obtain polysiloxane (5).

[0460] <sup>1</sup>H-NMR spectrum (chemical shift σ H), IR spectrum, and Mw of the polysiloxane (5) were measured. The results were as follows.

σ H: 2.3 ppm (CH<sub>2</sub>C(CF<sub>3</sub>)<sub>2</sub> group)

IR: 3400 cm<sup>-1</sup> (hydroxyl group), 1221 cm<sup>-1</sup> (C-F bond), 1130 cm<sup>-1</sup> (siloxane group), 1080 cm<sup>-1</sup> (siloxane group)

Mw: 3,300

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## Example 57

(Preparation of polysiloxane (5))

- god61] A three-necked flask equipped with a stirrer, a reflux condenser, and a thermometer was charged with 1.5 g of the silicon containing alloyclic compound (4) derived from the compound of the above formula (4-6) (wherein Rf is a trillucornethyl group) by replacing the hydrogen atom of the hydroxyl group by a t-butoxycarbonyl group, 1.5 g of 4-methyl-2-pentanone, and 0.20 g of 1.75 wt% oxalic acid aqueous solution. The mixture was reacted for five hours at 8°C while stirring. The reaction was terminated by cooling the flask with ice. The reaction mixture was poured into a separating funnel, to remove the water layer. The organic layer was washed with water until the reaction solution becomes neutral and the solvent was removed by distillation under vacuum to obtain polysioxane (5).
  - Decomines neutral tries solvent was removed by distinction and the polysiloxane (5) were measured. The results were as follows.
- 15 G: 2.3 ppm (CH<sub>2</sub>C(CF<sub>3</sub>)<sub>2</sub> group), 1.5 ppm (t-butoxycarbonyl group)
  - IR: 1774 cm<sup>-1</sup> (carbonate group), 1217 cm<sup>-1</sup> (C-F bond), 1132 cm<sup>-1</sup> (siloxane group), 1082 cm<sup>-1</sup> (siloxane group)
  - Mw: 7,500

# Example 58

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(Preparation of polysiloxane (5))

- [0463] A three-necked flask equipped with a stirrer, a reflux condenser, and a thermometer was charged with 1.98 g of the silicon containing alicyclic compound (4) shown by the above formula (4-6) (wherein Rf is a triflucrometry) group), 1.82 g of 2-t-butoxycarbonylethytriethoxysilane, 2.41 g of methytriethoxysilane, 6.0 g of 4-methyl-2-pentanone, and 1.85 g of 1.75 wt% oxalic acid aquesous solution. The mixture was reacted for six hours at 80°C while stirring. The reaction was terminated by cooling the flask with ice. The reaction mixture was poured into a separating funnel to remove the water layer. The organic layer was washed with water until the reaction solution becomes neutral and the solvient was removed by distillation under vacuum to obtain polysiloxane (5).
- 30 [0464] 1H-NMR spectrum (chemical shift σ H), IR spectrum, and Mw of the polysiloxane (5) were measured. The results were as follows.
  - σ: 2.3 ppm (CH<sub>2</sub>C(CF<sub>3</sub>)<sub>2</sub> group), 1.5 ppm (t-butoxy group), 0.2 ppm (SICH<sub>3</sub> group)
  - IR: 3400 cm<sup>-1</sup> (hydroxyl group), 1703 cm<sup>-1</sup> (carbonyl group), 1213 cm<sup>-1</sup> (C-F bond), 1130 cm<sup>-1</sup> (slloxane group), 1080 cm<sup>-1</sup> (slloxane group)

Mw: 2,500

## Example 59

(Preparation of polysiloxane (5))

[0465] A three-necked flask equipped with a sthrer, a reflux condenser, and a thermometer was charged with 4.0 g of the silicon containing allcyclic compound (4) shown by the above formula (4-42) (wherein Rf is a trifluoromethyl group), 4.0 g of 4-methyl-2-perianone, and 0.55 g of 1.75 wt% oxalic acid aqueous solution. The mixture was reacted for six hours at 80°C while stirring. The reaction was terminated by cooling the flask with ice. The reaction mixture was poured into a separating funnel to remove the water siyer. The organic layer was washed with water until the reaction solution becomes neutral and the solvent was removed by distillation under vacuum to obtain polysiloxane (5) [0466] 11-NMR spectrum (chemical shift of H), IR spectrum, and Mw of the polysiloxane (6) were measured. The results were as follows.

- σ H: 2.3 ppm (CH<sub>2</sub>C(CF<sub>3</sub>)<sub>2</sub> group)
- IR: 3400 cm<sup>-1</sup> (hydroxyl group), 1220 cm<sup>-1</sup> (C-F bond), 1130 cm<sup>-1</sup> (siloxane group), 1080 cm<sup>-1</sup> (siloxane group)
- Mw: 2.200

## Example 60

(Preparation of polysiloxane (5))

- 5 [0467] A three-necked flask equipped with a stirrer, a reflux condenser, and a thermometer was charged with 5.0 g of the silicon containing allegyleic compound (d) derived from the compound of the above formals (4-42) (wherein RI is a trifluoromethyl group) by replacing the hydrogen atom of the hydroxyl group by a t-butoxycarbonyl group, 5.0 g of 4-methyl-2-pentanone, and 0.61 g of 1.75 wt% oxalic acid aqueous solution. The mixture was reacted for six hours at 80°C while string. The reaction was terminated by cooling the flask with ice. The reaction mixture was poured into a separating funnel to remove the water layer. The organic layer was washed with water until the reaction solution becomes neutral and the solvent was removed by distillation under vacuum to obtain lovels/locane (5).
  - [0468]  $\,^{1}$ H-NMR spectrum (chemical shift  $\sigma$  H), IR spectrum, and Mw of the polysiloxane (5) were measured. The results were as follows.
  - σ: 2.3 ppm (CH<sub>2</sub>C(CF<sub>3</sub>)<sub>2</sub> group), 1.5 ppm (t-butoxycarbonyl group)
    - IR 1775 cm<sup>-1</sup> (carbonate group), 1220 cm<sup>-1</sup> (C-F bond), 1130 cm<sup>-1</sup> (siloxane group), 1130 cm<sup>-1</sup> (siloxane group)
      Mw: 2.400

## Example 61

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(Preparation of polysiloxane (5))

[0469] A three-necked flask equipped with a stirre, a reflux condenser, and a thermometer was charged with 4.0 g of the silicon containing allcyclic compound (4) shown by the above formula (4-5) (wherein Rf is a trifluoromethyl group), 15.0 g of 4-methyl-2-pentanone, and 0.72 g of 1.75 wt% oxalic acid aqueous solution. The mixture was reacted for six hours at 80°C while stirring. The reaction was terminated by cooling the flask with loc. The reaction mixture was poured into a separating funnel to remove the water layer. The organic layer was washed with water until the reaction solution becomes neutral and the solvent was removed by distillation under vacuum to obtain polysiloxane (5).

[0470] <sup>1</sup>H-NMR spectrum (chemical shift σ H), IR spectrum, and Mw of the polysiloxane (5) were measured. The results were as follows.

σ H: 2.3 ppm (CH<sub>2</sub>C(CF<sub>3</sub>)<sub>2</sub> group), 0.2 ppm (SiCH<sub>3</sub> group)

IR: 3400 cm<sup>-1</sup> (hydroxyl group), 1220 cm<sup>-1</sup> (C-F bond), 1130 cm<sup>-1</sup> (slloxane group), 1080 cm<sup>-1</sup> (slloxane group)
Mw: 2.200

## Example 62

(Preparation of polysiloxane (5))

- 0 [0471] A three-necked flask equipped with a stirrer, a reflux condenser, and a thermometer was charged with 2.2 g of the silicon containing alicyclic compound shown by the above formule (4-91) (in which the unit number of -5i(CH<sub>2</sub>) C- is 4), 2.78 g of methyltriethoxysilane, 5.0 g of 4-methyl-2-pentanone, and 1.41 g of 1.75 wt% oxalic acid aqueous solution. The mixture was reacted for six hours at 80°C while stirring. The reaction was terministed by cooling the flask with ice. The reaction mixture was power dit not a separariling funnel to remove the water layer. The organic layer was sweeted who was the control of the second of the second organic layer was the washed with water until the reaction solution becomes neutral and the solvent was removed by distillation under vacuum to obtain obvisiloxane (6).
  - [0472]  $^{-1}$ H-NMR spectrum (chemical shift  $\sigma$  H), IR spectrum, and Mw of the polysiloxane (5) were measured. The results were as follows.
- 50 σ H: 2.3 ppm (CH<sub>2</sub>C(CF<sub>2</sub>)<sub>2</sub> group), 0.2 ppm (SiCH<sub>2</sub> group)
  - IR: 3400 cm<sup>-1</sup> (hydroxyl group), 1221 cm<sup>-1</sup> (C-F bond), 1131 cm<sup>-1</sup> (siloxane group), 1078 cm<sup>-1</sup> (siloxane group)
     Mw: 3.300

## Example 63

(Preparation of polysiloxane (5))

[0473] A three-necked flask equipped with a stirrer, a reflux condenser, and a thermometer was charged with 2.48

g of the compound derived from the compound shown by the above formula (4-91) (in which the unit number of -SI (CH<sub>3</sub>)O - is 4) by replacing the hydrogen atom of the hydroxyl group by a t-butoxycarbonyl group, 2.52 g of mehythroxysilane, 5.0 g of 4-mehyth-2-pentanone, and 1.28 g of 1.75 wt% oxalic acid aqueous solution. The mixture was reacted for six hours at 80°C while stirring. The reaction was terminated by cooling the flask with ice. The reaction mixture was poured into a separating funnel to remove the water layer. The organic layer was weaken with whater until the reaction solution becomes neutral and the solvent was removed by distillation under vacuum to obtain a resin. [0474] "H-NMR spectrum (chemical shift of H), IR spectrum, and Mw of the resin were measured. The results were as follows.

σ: 2.3 ppm (CH<sub>2</sub>C(CF<sub>3</sub>)<sub>2</sub> group), 1.5 ppm (t-butoxy group), 0.2 ppm (SiCH<sub>3</sub> group)

R: 1775 cm<sup>-1</sup> (carbonate group), 1221 cm<sup>-1</sup> (C-F bond), 1131 cm<sup>-1</sup> (siloxane group), 1078 cm<sup>-1</sup> (siloxane group)

Mw: 3,500

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## Comparative Example 9

(Preparation of comparative polysiloxane)

[0475] A three-necked flask equipped with a stirrer, a reflux condenser, and a thermometer was charged with 20 g of 2-t-butoxycarbonylethyltriethoxysilane, 60 g of 4-methyl-2-pentanone, and 4.0 g of 1.75 wt% oxalic acid aqueous solution. The mixture was reacted for sk hours at 80°C while stirring. The reaction was terminated by cooling the flask with ice. The reaction mixture was poured into a separating funnel to remove the water layer. The organic layer was washed with water until the reaction solution becomes neutral and the solvent was removed by distillation under vacuum to obtain a comparative polyelistoxane.

[0476] 1H-NMR spectrum (chemical shift of H), IR spectrum, and Mw of the comparative polysiloxane were measured. The results were as follows.

σ: 1.5 ppm (t-butoxycarbonyl group)

IR: 3400 cm<sup>-1</sup> (hydroxyl group), 1703 cm<sup>-1</sup> (carbonyl bond), 1130 cm<sup>-1</sup> (siloxane group), 1080 cm<sup>-1</sup> (siloxane group)

#### Evaluation Example 9

(Evaluation of radiation transmittance)

5 [0477] The radiation transmittance of coating films with a thickness of 100 nm prepared from the polysiloxanes (5) of Examples 56-59, Example 61, and Comparative Example 9 at wavelengths of 157 nm and 193 nm was measured. The results are shown in Table 6.

Table 6

Polysiloxane	Radiation transmittance (%)		
	157 nm	193 nm	
Polysiloxane (5) of Example 56	69	98	
Polysiloxane (5) of Example 57	61	96	
Polysiloxane (5) of Example 58	46	97	
Polysiloxane (5) of Example 59	66	97	
Polysiloxane (5) of Example 61	67	97	
Polysiloxane of Comparative Example 9	30	95	

[0478] The results in the above table shows that the polysiloxanes (5) having a polysiloxane structure for the basic skeleton exhibited radiation transmittance at a wavelength of 193 nm equivalent to or higher than the comparative polysiloxane obtained in Comparative Example 9.

[0479] With regard to radiation transmittance at a wavelength of 157 nm, the comparative polysiloxane obtained in Comparative Example 9 exhibited 30% radiation transmittance, whereas the polysiloxanes (5) obtained in Examples 56-89, and Example 61 was found to exhibit radiation transmittance higher than that of the comparative polysiloxane obtained in Comparative Example 9. Conventionally, the radiation transmittance at a wavelength of 157 nm has been thought to decrease as the proportion of hydrocarbon structures in a polysiloxane increases. The results of the measurement, however, indicated that notwithstanding a comparatively large proportion of hydrocarbon structures and varied partial structures in the polymer the polysiloxane (5) exhibited high radiation transmittance at a wavelength of 157 nm.

## Evaluation Examples 10

(Evaluation of alkali solubility)

[O480] A solution of each polysiloxane (5) obtained in Example 56, example 59, or Example 61 in 2-heptanone was applied onto a silicon water substrate by spin coating and treated with heat on a hot plate maintained at a temperature of 130°C for 90 seconds to form a coating film with a thickness of 100 mm.

[0481] Each film was soaked in ion-exchanged water for 60 seconds to confirm that there was almost no change in the film thickness. On the other hand, a test of soaking the films in a 2.38 wt% tetramethylammonium hydroxide aqueous solution for 60 seconds revealed that the coating films were dissolved in the solution and completely removed from the substrate

[0482] As a result, the polyeiloxane (5) was confirmed to exhibit no solubility or low solubility in ion-exchanged water, but exhibit high solubility in a common alkaline developer, demonstrating its sufficient usefulness as a resin component in chemically amplified resistant.

# Example 64

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(Radiation-sensitive resin composition)

[0483] A solution composition was prepared by homogeneously mixing 100 parts of the polysiloxane (5) obtained in Example 57 or Example 58, 1 part of triphenylsulfonium trifluoromethanesulfonate, 0.02 part of tri-n-octylamine, and 900 parts of 2-heatanone.

[0484] The solution composition was applied onto a silicon wafer substrate by spin coating and treated with heat on a hot plate maintained at a temperature of 130°C for 90 seconds a resist film with a thickness of 100 nm.

[0.485] The resist film was exposed to an ARF excimer laser (wavelength: 193 nm) while changing the irradiation dose, heat-treated for 90 seconds on a hot plate maintained at a temperature of 110°C, and then developed in a 2.38 wt% acueous solution of termently amonum mydroxide, thereby forming resist patterns.

[0486] As a result observation of the resist patterns using a scanning electron microscope, polysiloxane (5) obtained in Example 57 oxhibited resolution to a degree of a line width of as small as 0.30 µm, and the polysiloxane (6) obtained in Example 58 as small as 0.15 µm.

## 35 Synthetic Example 2

(Synthesis of silicon-containing alloyclic compound)

[0487] A three-necked flask equipped with a stirrer, a reflux condenser, and a thermometer was charged with 365 g of triethoxysilane and 200 g of bioxylot(2.2 lhpeto-2-ene. The mixture was stirred at room temperature and 4.0 ml of a 0.2 mol chloroplatinic acid (H<sub>2</sub>PtCl<sub>6</sub>) solution in isopropyl alcohol was added to initiate the reaction. The reaction was continued for 90 hours at 160°C while refluxing. The reaction mixture was allowed to cool to room temperature, diluted with n-hexans, and filtered through ceitite by suction. The solvent was evaporated by distillation under vacuum to obtain a crude product. The crude product was purified by vacuum distillation at 3.0 mmHg and a temperature of 82°C to obtain 258 g of the silicon containing allevicine compound of the formula (12-1).

# Synthetic Example 3

(Synthesis of silicon-containing alicyclic compound)

[0488] A three-necked flask equipped with a stirrer, a reflux condenser, and a thermometer was charged with 118 g of triethoxysiliane and 100 g of tetracyclo [4.4.0,12-5,17:0] docaca-3-ene. The mixture was stirred at room temperature and 4.0 ml of a 0.2 mlo thioroplatific acid (HgPClg) solution in isopropyl alcohol was added to initiate the reaction. The reaction was continued for 90 hours at 100°C while refluxing. The reaction mixture was allowed to cool to room temperature, diluted with rh-exame, and filtered through ceitie by suction. The solvent was evaporated by distillation or under vacuum to obtain a crude product. The crude product was purified by vacuum distillation at 1.5 mmHg and a temperature of 130°C to obtain 88 g of the silicon containing alloydic compound of the formula (12-2).

## Example 65

(Preparation of polysiloxane (1))

[0489] A three-necked flask equipped with a stirrer, a reflux condenser, and a thermometer was charged with 7.00 g of the silicon containing allcyclic compound (4) of the above formula (2-42), 14.47 g of the silicon containing allcyclic compound of the above formula (4-6), (wherein Rf is a triflurformethyl group), 8.52 g of the silicon containing allcyclic compound of the above formula (12-1), 30 g of 4-methyl-2-pentanone, and 8.05 g of a 1.75 wt% aqueous solution of oxalic acid. The mixture was reacted for six hours at 80°C while string. The reaction was terminated by cooling the flask with lee. The reaction mixture was poured into a separating funnel to remove the water layer. The organic layer was washed with ion-exchanged water until the reaction solution becomes neutral. The solvent was removed from the organic layer to obtain the polysiloxane (1).

25 [0490] NMR spectrum (chemical shift σ) and Mw of the polysiloxane (1) were measured to confirm the following results.

σ: 2.3 ppm (-CH<sub>2</sub>C(CF<sub>3</sub>)<sub>2</sub> group), 1.4 ppm (t-butyl group)
 Mw: 1.400

## Example 66

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(Preparation of polysiloxane (1))

39 [0491] A three-necked flask equipped with a stirrer, a reflux condenser, and a thermometer was charged with 1.28 g of the silicon containing alicyclic compound (2) of the above formula (2-42), 2.20 g of the silicon containing alicyclic compound (4) of the above formula (4-6), (wherein Fil is at influoromethyl group), 0.52 g of the silicon containing alicyclic compound of the above formula (12-1), 4.0 g of 4-methyl-2-pentanone, and 0.74 g of a 1.75 w/% aqueous solution valid exid. The mixture was reacted for six hours at 80°C while stirring. The reaction was terminated-by cooling the flask with ice. The reaction mixture was poured into a separating funnel to remove the water layer. The organic layer was washed with ion-exchanged water until the reaction solution becomes neutral. The solvent was removed from the organic layer to obtain the polysiloxed in the polysiloxed

[0492] NMR spectrum (chemical shift o) and Mw of the polysiloxane (1) were measured to confirm the following results.

σ: 2.3 ppm (-CH<sub>2</sub>C(CF<sub>3</sub>)<sub>2</sub> group), 1.4 ppm (t-butyl group) Mw: 1.400

## Example 67

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(Preparation of polysiloxane (1))

[0483] A three-necked flask equipped with a stirrer, a reflux condenser, and a thermometer was charged with 3.34 g of the silicon containing alloyclic compound (2) of the above formula (2-42), 8.62 g of the silicon containing alloyclic compound (4) of the above formula (4-5), wherein Ris is artiflucromethyl group), 3.05 g of the silicon containing alloyclic compound of the above formula (12-1), 15 g of 4-methyl-2-pentanone, and 2.88 g of a 1.75 w% aqueous solution of oxalic acid. The mixture was reacted for six hours at 80°C while stirring. The reaction was terminated by cooling the flask with ice. The reaction mixture was poured into a separating funnel to remove the water layer. The organic layer

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was washed with ion-exchanged water until the reaction solution becomes neutral. The solvent was removed from the organic layer to obtain the polysiloxane (1).

[0494] NMR spectrum (chemical shift o) and Mw of the polysiloxane (1) were measured to confirm the following results.

σ: 2.3 ppm (-CH<sub>2</sub>C(CF<sub>3</sub>)<sub>2</sub> group), 1.4 ppm (t-butyl group)
 Mw: 1,200

# Example 68

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(Preparation of polysiloxane (1))

[0495] A three-necked flask equipped with a stirre, a reflux condenser, and a thermometer was charged with 0.85 g of the silicon containing alloyalic compound (2) of the above formula (2-42), 2.85 g of the silicon containing alloyalic compound (4) of the above formula (4-5), (wherein Rf is a trifluroromethyl group), 0.52 g of the silicon containing alloyalic compound of the above formula (12-1), 4.0 g of 4-methyl-2-pentanone, and 0.73 g of a 1.75 w% aqueous solution of oxalic acid. The mixture was reacted for six hours at 80°C while stirring. The reaction was terminated by cooling the flask with Ice. The reaction mixture was poured into a separating funnel to remove the water layer. The organic layer was washed with ion-exchanged water until the reaction solution becomes neutral. The solvent was removed from the organic layer to obtain the polyslioxane (1).

[0496] NMR spectrum (chemical shift  $\sigma$  ) and Mw of the polysiloxane (1) were measured to confirm the following results.

σ: 2.3 ppm (-CH<sub>2</sub>C(CF<sub>3</sub>)<sub>2</sub> group), 1.4 ppm (t-butyl group)
 Mw: 1.500

## Example 69

(Preparation of polysiloxane (1))

[0497] A three-necked flask equipped with a stirrer, a reflux condenser, and a thermometer was charged with 0.85 g of the silicon containing alloyclic compound (2) of the above formula (2-42), 2.18 g of the silicon containing alloyclic compound (4) of the above formula (4-6), (wherein RI is a trifluoromethyl group), 0.97 g of the silicon containing alloyclic compound of the above formula (12-2), 4.0 g of 4-methyl-2-pentanone, and 0.73 g of a 1.75 wt% aqueous solution of coalle acid. The mixture was reacted for six hours at 80°C while string. The reaction was terminated by cooling the flask with ice. The reaction mixture was poured into a separating funnel to remove the water layer. The organic layer was washed with ion-exchanged water until the reaction solution becomes neutral. The solvent was removed from the organic layer to obtain the polysikozane (1).

[0498] NMR spectrum (chemical shift σ) and Mw of the polysiloxane (1) were measured to confirm the following results.

σ: 2.3 ppm (-CH<sub>2</sub>C(CF<sub>3</sub>)<sub>2</sub> group), 1.4 ppm (t-butyl group) Mw: 1.300

#### Example 70

(Preparation of polysiloxane (1))

[0499] A three-necked flask equipped with a stirrer, a reflux condenser, and a thermometer was charged with 0.82 g of the silicon containing alicyclic compound (2) of the above formula (2-42), 2.5 g of the silicon containing alicyclic compound (4) of the above formula (4-2), there is a trifluoromethyl group), 0.83 g of the silicon containing alicyclic compound of the above formula (4-2), 4.0 g of 4-methyl-2-pentanone, and 0.71 g of a 1.75 wt% aqueous solution of oxalic acid. The mixture was reacted for six hours at 80°C white stirring. The reaction was terminated by cooling the flask with ice. The reaction mixture was poured into a separating funnel to remove the water layer. The organic layer was washed with ion-exchanged water until the reaction solution becomes neutral. The solvent was removed from the organic layer to obtain the polysiloxane (1).

[0500] NMR spectrum (chemical shift  $\sigma$ ) and Mw of the polysiloxane (1) were measured to confirm the following results.

σ: 2.3 ppm (-CH<sub>2</sub>C(CF<sub>3</sub>)<sub>2</sub> group), 1.4 ppm (t-butyl group)

Mw: 1,500

## Example 71

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(Preparation of polysiloxane (1))

[0501] A three-necked flask equipped with a stirrer, a reflux condenser, and a thermometer was charged with 0.85 g of the sillicon containing alloyalic compound (4) of the above formula (2-6), 1.58 g of the sillicon containing alloyalic compound (4) of the above formula (4-6), (wherein Rf is a trifluoromethyl group), 1.55 g of the sillicon containing alloyalic compound of the above formula (12-1), 4.0 g of 4-methyl-2-pentanone, and 0.88 g of a 1.75 w% aqueous solution of oxalic acid. The mixture was reacted for six hours at 80°C while string. The reaction was terminated by cooling the flask with ice. The reaction mixture was poured into a separating funnel to remove the water layer. The organic layer was washed with ion-exchanged water until the reaction solution becomes neutral. The solvent was removed from the organic layer to obtain the polysiloxane (1).

[0502] NMR spectrum (chemical shift  $\sigma$ ) and Mw of the polysiloxane (1) were measured to confirm the following results.

 $\sigma$  : . 2.3 ppm (-CH<sub>2</sub>C(CF<sub>3</sub>)<sub>2</sub> group), 1.4 ppm (t-butyl group) Mw: 1,000

## Evaluation Example 11

(Evaluation of radiation transmittance)

[0503] The radiation transmittance of coating films with a thickness of 100 nm prepared from the polysiloxanes (1) of Examples 65-71 at wavelengths of 157 nm and 193 nm was measured. The results are shown in Table 7.

Table 7

Polysiloxane .	Radiation transmittance (%)		
	157 nm	193 nm	
Polysiloxane (1) of Example 65	47	93	
Polysiloxane (1) of Example 66	45 .	94	
Polysiloxane (1) of Example 67	48	95	
Polysiloxane (1) of Example 68	49	93	
Polysiloxane (1) of Example 69	44	96	
Polysiloxane (1) of Example 70	46	94	
Polysiloxane (1) of Example 71	43	97	
Polysiloxane of Comparative Example 9	30	95	

[0504] The results in the above table shows that the polysiloxanes (1) having a polysiloxane structure for the basic skeleton exhibited radiation transmittance at a wavelength of 193 nm equivalent to or higher than the comparative bavelength of the polysiloxane obtained in Comparative Exemple 8.

[0505] With regard to radiation transmittance at a wavelength of 157 nm, the comparative polysiloxane obtained in Comparative Example 9 exhibited 30% radiation transmittance, whereas the polysiloxane; (1) obtained in Examples 65-71 was found to exhibit radiation transmittance higher than that of the comparative polysiloxane obtained in Comparative Example 9. Conventionally, the radiation transmittance at a wavelength of 157 nm has been thought to decrease as the proportion of hydrocarbon structures in a polysiloxane increases. The results of the measurement, however, indicated that notwithstanding a comparatively large proportion of hydrocarbon structures and varied partial structures in the polyment the polysiloxane (1) exhibited high radiation transmittance at a wavelength of 157 nm.

## Evaluation Examples 12

(Evaluation of the dry etching resistance)

[0506] A solution composition was prepared by homogeneously mixing 100 parts of the polysiloxane (1) obtained in

Example 65 or polystyrene (Mw=16,000), 1 part of triphenylsulfonium nonafluoro-n-butanesulfonate, 0.04 part of tri-n-octylamine, and 900 parts of 2-heptanone.

[0507] The solution composition was applied onto a silicon wafer substrate by spin coating and treated with heat on a hot plate maintained at a temperature of 140°C for 90 seconds a resist film with a thickness of 100 nm.

[0508] The resist films obtained were subjected to the etching test using the etching gases shown in Table 8. The results are shown in Table 8.

Table 8

Etching gase	Etching rate (nm/min)		B/A
	. 1		
	A B		
, , , , , , , , , , , , , , , , , , , ,	Polystyrene Polysiloxane (1)		
CF3/CF4/N2/C4F6/Ar	161	178	1.1
CF4	194	222	1.1
CHF3/CF4/Ar	118	138	1.2
C4F6/O2/Ar	19	22	1.2

[0509] The results of Table 8 show that the radiation-sensitive resin composition of the present invention exhibit high dry etching resistance almost equivalent to polystyrene under all etching conditions employed in the evaluation test.

# 25 Example 72

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(Radiation-sensitive resin composition)

[0510] A solution composition was prepared by homogeneously mixing 100 parts of the polysiloxane (1) obtained in Example 65-70, 1 part of triphenylsultonium nonafluoro-n-butanesultonate, 0.04 part of trin-n-octylamine, and 900 parts of 2-heatrance.

[0511] The solution composition was applied onto a silicon wafer substrate by spin coating and treated with heat on a hot plate maintained at a temperature of 130°C for 90 seconds a resist film with a thickness of 100 nm.

[0512] The resist film was exposed to an ArF excimer laser (wavelength: 193 nm) or F2 excimer laser (wavelength: 157 nm) while changing the irradiation dose, heat-treated for 90 seconds on a hot plate maintained at a temperature of 100°C, and then developed in a 2.38 wt% aqueous solution of tetramethylammonium hydroxide, thereby forming resist patterns.

[0513] Observation of the exposed area on the substrate by a scannning-type electron microscope confirmed that the limit resolution shown in Table 9.

Table 9

Polysiloxane	limit resolution (μm)	
	ArF	F2
Polysiloxane (1) of Example 65	0.14	0.10
Polysiloxane (1) of Example 66	0.15	_
Polysiloxane (1) of Example 67	0.15	0.10
Polysiloxane (1) of Example 68	0.16	
Polysiloxane (1) of Example 69	0.18	_
Polysiloxane (1) of Example 70	0.18	_

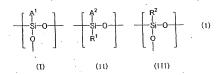
[0514] The polysiloxane (1), polysiloxane (3), and polysiloxane (5) of the present invention exhibit high transparency to radiation of a wavelength of 193 nm or less, particularly to radiation of a wavelength of 157 nm, and exhibits superior dry etching resistance, resolution properties, and developability. Therefore, the radiation-sensitive resin composition containing these polysiloxanes exhibit a high sensitivity to short wavelength radiation and can form fine resist patterns at high precision. The resin composition can be extremely useful for fabricating semiconductor devices, which will become more and more minute in the future. The polysiloxane (1), polysiloxane (3), and polysiloxane (5) are also useful

as a material for fabricating formed articles and films, and as laminating materials, components for coating compositions, and the like.

[0515] The silicon-containing alicyclic compound (2) and silicon-containing alicyclic compound (4) are useful as raw materials not only for producing the polysiloxane (3) and polysiloxane (5), respectively, but also as raw materials for producing common polysiloxane resins and other silicon-containing alicyclic compounds having similar norbornanetype cyclic structure. Furthermore, the methods of preparation of the polysiloxane (1), polysiloxane (3), and polysiloxane (5) of the present invention ensure a rapid and homogeneous condensation reaction accompanying hydrolysis, effectively reducing the amount of hydrolysable groups in the raw material left unreacted in the resulting polymer, thereby minimizing absorption of radiation by the hydrolysable groups. Because of this, the resulting polysiloxanes exhibit high radiation tansmittance at a wavelength of 193 nm and less, particularly at 157 nm, exhibit high sensitivity, and have a narrow molecular weight distribution. The radiation-sensitive resin composition prepared from such a polysiloxane is less susceptible to a negative-tone reaction when exposed to radiation with a short wavelength, producing resist patterns exhibiting improved adhesion to substrates and excellent developability. Thus, resist patterns with a fine line width and excellent configuration can be obtained using such a resin composition, particularly when exposed to radiation with a wavelength of 193 nm or less. The polycondensation of a raw material compound under acidic conditions, followed by basic conditions, produces a polysiloxane with increased degrees of polymerization and crosslinking. As a result, the polysiloxane with a high glass transition temperature can be obtained. Fine resist patterns can be formed with extreme advantage using such a polysiloxane.

[0516] Obviously, numerous modifications and variations of the present invention are possible in light of the above teachings, it is therefore to be understood that, within the scope of the appended claims, the invention may be practiced otherwise than as specifically described herein.

[0517] A novel polysiloxane having the following structural units (I) and/or (II) and the structural unit (III),



wherein A¹ and A² are an acid-dissociable monovalent organic group, R¹ is hydrogen, monovalent (halogenated) hydrocarbon, halogen, or amino, R² is monovalent (halogenated) hydrocarbon group, or halogen. A method of preparing such a polysiloxane, a silicon-containing alicyclic compound providing this polysiloxane, and a radiation-sensitive resin composition comprising this polysiloxane are also provided. The polysiloxane is useful as a resin component for a resist material, effectively senses radiation with a short wavelength, exhibits high transparency to radiation and superior dry etching properties, and excels in basic resist properties required for resist materials such as high sensitivity, resolution, developability, sensitivity,

# Claims

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 A polysiloxane having the following structural unit (I) and/or the following structural unit (II), and the following structural unit (III).

$$\begin{bmatrix}
A^{1} \\
Si-O
\end{bmatrix}$$

$$\begin{bmatrix}
A^{2} \\
Si-O
\end{bmatrix}$$

$$\begin{bmatrix}
R^{2} \\
Si-O
\end{bmatrix}$$

$$O$$

wherfein A¹ and A² individually represent a monovalent organic group having an acid-dissociable group which dissociates by the action of an acid, R¹ represents a hydrogen atom, a monovalent hydrocarbon group having 1-20 carbon atoms, a monovalent halogenated hydrocarbon group having 1-20 carbon atoms, a halogen atom, or a primary, secondary, or tertilary amino group, and R² represents a monovalent hydrocarbon group having 1-20 carbon atoms, a halogen atom, or a primary, secondary, or tertilary amino group, and primary, secondary, or tertilary amino group, the polysiloxane having a polystyrene-reduced weight average molecular weight determined by deligementation

the polysiloxane having a polystyrene-reduced weight average molecular weight determined by gel permeation chromatography (GPC) in the range of 500-1,000,000.

A radiation-sensitive resin composition comprising:

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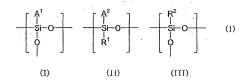
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(a) a resin which comprises a polysiloxane insoluble or scarcely soluble in alkali and having the following structural unit (I) and/or the following structural unit (II), and the following structural unit (III).



wherein A¹ and A² Individually represent a monovalent organic group having an acid-dissociable group which dissociates by an action of an acid, R¹ represents a hydrogen atom, a monovalent hydrocarbon group having 1-20 carbon atoms, a monovalent halogenated hydrocarbon group having 1-20 carbon atoms, a halogen atom, or a primary, secondary, or tertiary arriing group, and R² represents a monovalent hydrocarbon group, having 1-20 carbon atoms, a monovalent halogenated hydrocarbon group having 1-20 carbon atoms, a halogen atom, or a primary, secondary, or tertiary arriing group; the polysiloxane having a polystyrene-reduced weight average molecular weight determined by gel permeation chromatography (GPC) in the range of 500-1,000,000 and becoming soluble in alkali when an acid-dissociable group dissociates, and (0) a photosoid generator.

A silicon-containing alicyclic compound represented by the following formula (2-A) or (2-B).

wherein R individually represents a hydrogen atom or a methyl group; R1 individually represents a hydrogen atom, a monovalent hydrocarbon group having 1-20 carbon atoms, a monovalent halogenated hydrocarbon group having 1-20 carbon atoms, a halogen atom, or a primary, secondary, or tertiary amino group; R1 individually represents a monovalent hydrocarbon group having 1-20 carbon atoms, a monovalent halogenated hydrocarbon group having 1-20 carbon atoms, or the group of the following formula (i),

$$-\left(\frac{X}{Si}\right)_{a}X$$
 (i)

wherein X individually represents a hydrogen atom, a monovalent hydrocarbon group having 1-20 carbon atoms, a monovalent halogenated hydrocarbon group having 1-20 carbon atoms, or a linear, branched, or royclic alkxyll group having 1-20 carbon atoms, and a indicates an integer of 1-10, or, when m is 0 or 1, two 8P may form aring together with two oxygen atoms and the silicon atom; Y individually represents a hydrogen atom, a monovalent hydrocarbon group having 1-20 carbon atoms, a monovalent halogenated hydrocarbon group having 1-20 carbon atoms, a monovalent halogenated hydrocarbon group having 1-20 carbon atoms, a halogen atom, a primary, secondary, or tertilary amino group, or a group =OR<sup>3</sup> (wherein R<sup>3</sup> is the same as defined above); mis an integer of 0-3; pis an integer of 3-10, and n is an integer of 0-3; the silicon atom binding with the 2 of 3 position of the uppermost biocyclog 2.1 [heptane ring.

A polysiloxane comprising the following structural unit (I-1) and/or the following structural unit (II-1).

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wherein R individually represents a hydrogen atom or a methyl group, R¹ represents a hydrogen atom, a monovalent hydrocarbon group having 1-20 carbon atoms, a monovalent halogenated hydrocarbon group having 1-20 carbon atoms, a halogen atom, or a primary, secondary, or tertiary amino group, and n¹ is an integer from 1-3, the silicon atom binding with the 2 or 3 position of the uppermost bicyclo[2.2.1]heptiane ring;

the polysiloxane having a polystyrene-reduced weight average molecular weight determined by gel permeation chromatography (GPC) in the range of 500-1,000,000.

5. A silicon-containing alicyclic compound represented by the following formula (4-A) or formula (4-B),

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wherein R individually represents a hydrogen atom or a methyl group; R¹ individually represents a hydrogen atom, a monovalent hydrocarbon group having 1-20 carbon atoms, a monovalent halogenated hydrocarbon group having 1-20 carbon atoms, a halogen atom, or a primary, secondary, or terflary amino group; R³ individually represents a monovalent hydrocarbon group having 1-20 carbon atoms, a monovalent halogenated hydrocarbon group having 1-20 carbon atoms, or the croup of the following formula (0).

$$-\left(\begin{matrix}X\\Si\\Y\end{matrix}\right)_{a}X\qquad (i)$$

wherein X individually represents a hydrogen atom, a monovalient hydrocerbon group having 1-20 carbon atoms, a monovalent halogenated hydrocerbon group having 1-20 carbon atoms, and a indicates an integer of 1-10, or, when m is 0 or 1, two R<sup>3</sup> may form a ring together with two oxygen atoms and the silicon atom; Y individually represents a hydrogen atom, a monovalent hydrocerbon group having 1-20 carbon atoms, a monovalent halogenated hydrocerbon group having 1-20 carbon atoms, a monovalent halogenated hydrocerbon group having 1-20 carbon atoms, a halogen atom, a primary, secondary, or tertiary amino group, or a group =0R<sup>3</sup> (wherein R<sup>3</sup> is the same as defined above); m is an integer of 0-3; p is an integer of 3-10; Rf represents a hydrogen atom, methyl group, or trifluoromethyl group; Z represents a hydrogen atom or a monovalent organic group dissociating hydrogen atoms with the action of an acid, and n is an integer of 0-3; the silicon atom binding with the 2 or 3 position of the uppermost bizyclo (2.2 Hippetane ring.

6. A polysiloxane comprising the following structural unit (I-2) and/or structural unit (II-2),

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wherein R individually represents a hydrogen atom or a methyl group; R1 represents a hydrogen atom, a monovalent hydrocarbon group having 1-20 carbon atoms, a monovalent halogenated hydrocarbon group having 1-20 carbon atoms, a halogen atom, or a primary, secondary, or terliary amino group, and

RI represents a hydrogen atom, methyl group, or trifluoromethyl group; Z represents a hydrogen atom or a monovalent organic group dissociating hydrogen atoms with an action of an acid; and n is an integer of 0-3; the silicon atom binding with the 2 or 3 position of the uppermost bicyclof(2.2.1 hepitane ring:

The polysiloxane having a polystyrene-reduced weight average molecular weight determined by gel permeation chromatography (GPC) in the range of 500-1,000,000.

- 7. The polysiloxane according to claim 1, satisfying the following conditions (1) or (2), or both:
  - (1) has the structural unit (I-1) of claim 4 and the structural unit (I-2) of claim 6, as the structural unit (I), or
  - (2) has the structural unit (II-1) of claim 4 and the structural unit (II-2) of claim 6, as the structural unit (II).
- 8. The radiation-sensitive resin composition according to claim 2, satisfying the following conditions (3) or (4), or both:
  - (3) has the component (a) which has the following structural unit (I-1') and the structural unit (I-2) of claim 6.
  - as the structural unit (I), or (4) has the component (a) which has the following structural unit (II-1') and the structural unit (II-2) of claim 6, as the structural unit (II).

wherein R individually represents a hydrogen atom or a methyl group; R¹ represents a hydrogen atom, a monovalent hydrocarbon group having 1-20 carbon atoms, a monovalent halogenated hydrocarbon group having 1-20 carbon atoms, a halogen atom, or a primary, secondary, or tertilary amino group; Z¹ represents a monovalent organic group dissociating hydrogen atoms by the action of oxygen; and n¹ is an integer from 1-3; the sillion atom binding with the 2 or 3 position of the uppermest bicycle [22.1]heptane find.

# 9. A radiation-sensitive resin composition comprising:

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(a) polysiloxane comprising at least one structural unit selected from the structural unit (I-1') and the structural unit (I-1') described in claim 8, having apolystyrene-reduced weight average molecular weight determined by gal permeation chromatography (GPC) in the range of 500-1, 000, 000, and insoluble or scarcely soluble in alkali, and a polysiloxane comprising at least one structural unit selected from the structural unit (I-2) described in claim 6, having a polystyrene-reduced weight average molecular weight determined by gel permeation chromatography (GPC) in the range of 500-1,000,000, and insoluble or scarcely soluble in alkali, the resin becoming soluble in alkali when the acid-dissociable group dissociates, and (b) a photoacid generator.

10. A method of preparing the polysiloxane of Claim 1 comprising a step of polycondensing the following compounds in the presence of an acidic catalyst:

(a) at least one compound selected from the group consisting of a compound shown by the following formula (6) or a linear or cyclic oligomer prepared by partial condensation of this compound or (b) at least one compound selected from the group consisting of a compound shown by the following formula (7) or a linear or cyclic oligomer prepared by partial condensation of this compound, or both (a) and (b), and

(c) at least one compound selected from the group consisting of a compound shown by the following formula (8) or a linear or cyclic oligomer prepared by partial condensation of this compound.

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wherein A¹ and A² Individually represent a monovalent organic group having an acid-dissociable group which dissociates by the action of an acid; R¹ represents a hydrogen atom, a monovalent hydrocarbon group having 1-20 carbon atoms, a monovalent halogenated hydrocarbon group having 1-20 carbon atoms, a halogen atom, or a primary, secondary, or tertiary amino group; R² represents a monovalent hydrocarbon group having 1-20 carbon atoms, a halogen atom, or a primary, secondary, or tertiary amino group; R² represents a monovalent hydrocarbon group having 1-20 carbon atoms, a halogen atom, or a primary, secondary, or tertiary amino group; and R³ individually represents a monovalent hydrocarbon group having 1-20 carbon atoms, or the group of the following formula (i),

$$\frac{X}{\left(\begin{array}{c} X \\ Si \\ \end{array}\right)_{a}} X \qquad (i)$$

wherein X Individually represents a hydrogen atom, a monovalent hydrocarbon group having 1-20 carbon atoms, a monovalent halogenated hydrocarbon group having 1-20 carbon atoms, or a linear, branched, or cyclic alkoxyl group having 1-20 carbon atoms, and a indicates an integer of 1-10.

- 11. A method of preparing the polysiloxane of Claim 4 comprising a step of polycondensing at least one compound selected from the group consisting of the silicon-containing alicyclic compound described in claim 3 and a linear or cyclic oligomer prepared by partial condensation of this silicon-containing alicyclic compound in the presence of an acidic catalyst.
- 12. A method of preparing the polysiloxane of Claim 6 comprising a step of polycondensing at least one component selected from the group consisting of the silicon-containing alloyelic compound described in claim 5 or a linear or cyclic oligomer prepared by partial condensation of this silicon-containing alloyelic compound in the presence of an acidic catalyst.



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EP 01 10 8625

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in For more details about this annex; see Official Journal of the European Patent Office, No. 12/82